

**LA-1811**

# Compal confidential

## Schematics Document

**DT TRANSPORT or Prescott uFCPGA  
with ATI-RC300M+SB200 core logic**

**2003-09-01**

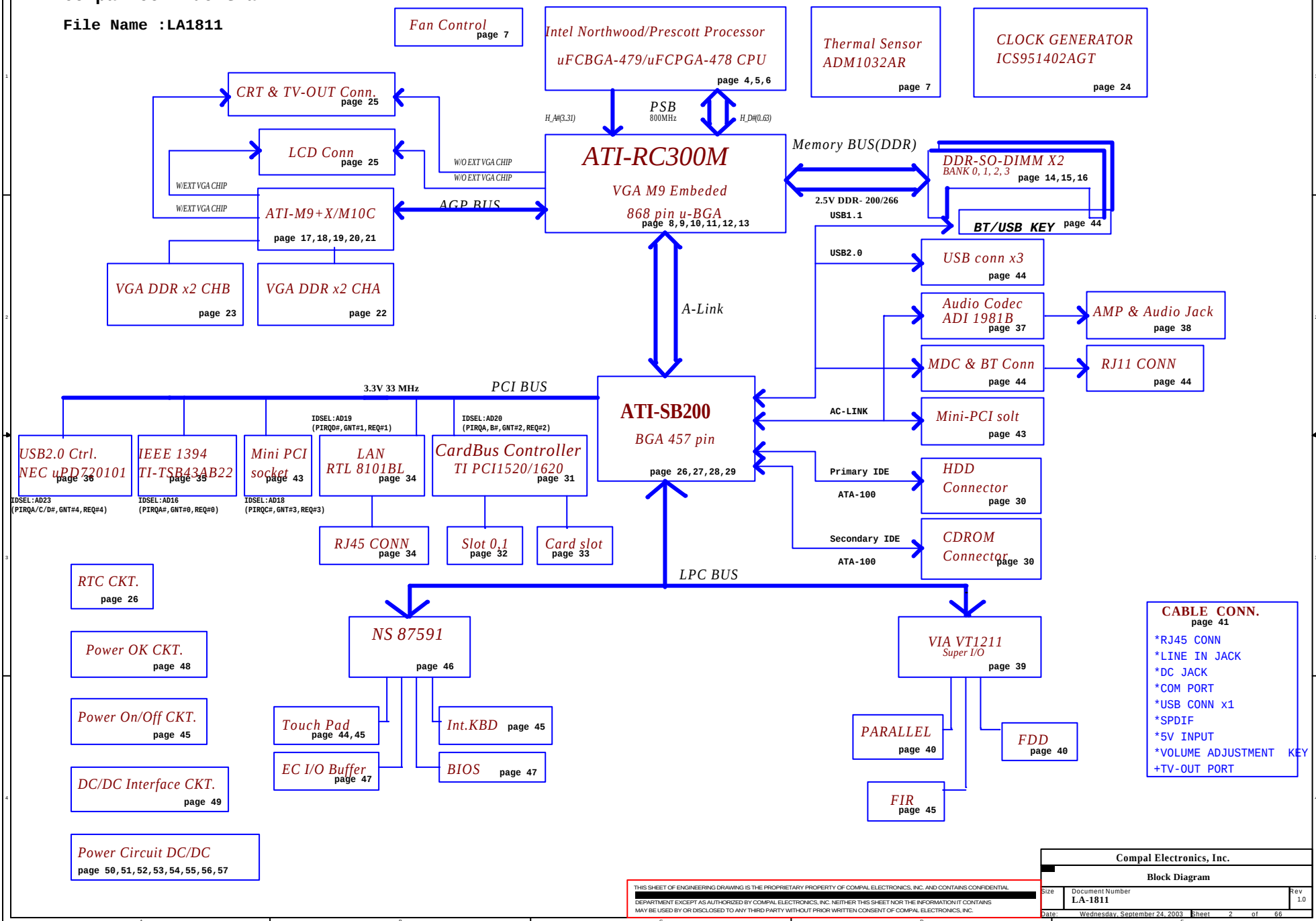
**REV:1.0**

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| Cover Sheet              |                               |
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| Block Diagram            |                               |       |
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Voltage Rails

| Power Plane | Description                                           | S0-S1 | S3  | S5  |
|-------------|-------------------------------------------------------|-------|-----|-----|
| VIN         | Adapter power supply (19V)                            | N/A   | N/A | N/A |
| B+          | AC or battery power rail for power circuit.           | N/A   | N/A | N/A |
| +VCC_CORE   | Core voltage for CPU                                  | ON    | OFF | OFF |
| +VCCVID     | The voltage for Processor VID select                  | ON    | OFF | OFF |
| +1.25VS     | 1.25V switched power rail for DDR Vtt                 | ON    | OFF | OFF |
| +1.2VS_VGA  | 1.2V I/O power rail for ATI-VGA M9+X/M10P.            | ON    | OFF | OFF |
| +1.5VS      | 1.5V I/O power rail for ATI-RS300M/RC300M NB AGP.     | ON    | OFF | OFF |
| +1.8VS      | 1.8V switched power rail for ATI-RS300M/RC300M NB.    | ON    | OFF | OFF |
| +2.5VALW    | 2.5V always on power rail                             | ON    | ON  | ON* |
| +2.5V       | 2.5V system power rail for DDR                        | ON    | ON  | OFF |
| +2.5VS      | 2.5V switched power rail                              | ON    | OFF | OFF |
| +3VALW      | 3.3V always on power rail                             | ON    | ON  | ON* |
| +3V         | 3.3V system power rail for SB,LAN,CardReader and HUB. | ON    | ON  | OFF |
| +3VS        | 3.3V switched power rail                              | ON    | OFF | OFF |
| +5VALW      | 5V always on power rail                               | ON    | ON  | ON* |
| +5V         | 5V system power rail .                                | ON    | ON  | OFF |
| +5VS        | 5V switched power rail                                | ON    | OFF | OFF |
| +12VALW     | 12V always on power rail                              | ON    | ON  | ON* |
| RTCVCC      | RTC power                                             | ON    | ON  | ON  |

Note : ON\* means that this power plane is ON only with AC power available, otherwise it is OFF.

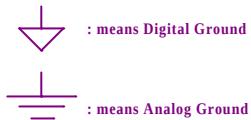
External PCI Devices

| DEVICE                 | IDSEL #     | REQ/GNT # | PIRQ  |
|------------------------|-------------|-----------|-------|
| NB Internal VGA        | N/A         | N/A       | A     |
| AGP BUS                | AGP_DEVSEL  | N/A       | A     |
| SOUTHBRIDGE            | AD31 (INT.) | N/A       | N/A   |
| USB                    | AD30 (INT.) | N/A       | D     |
| AC97                   | AD31 (INT.) | N/A       | B     |
| ATA 100                | AD31 (INT.) | N/A       | A     |
| ETHERNET               | AD24(INT.)  | N/A       | C     |
| 1394                   | AD16        | 0         | A     |
| LAN                    | AD19        | 1         | D     |
| CARD BUS               | AD20        | 2         | A,B   |
| Wireless LAN(MINI PCI) | AD18        | 3         | C     |
| EXT USB                | AD23(EXT.)  | 4         | A,C,D |

I2C / SMBUS ADDRESSING

| DEVICE                 | HEX | ADDRESS         |
|------------------------|-----|-----------------|
| DDR SO-DIMM 0          | A0  | 1 0 1 0 0 0 0 X |
| DDR SO-DIMM 1          | A2  | 1 0 1 0 0 0 1 X |
| CLOCK GENERATOR (EXT.) | D2  | 1 1 0 1 0 0 1 X |

Symbol Note :



@ : means just reserve , no build

NAGP@ : means just build when no external AGP VGA chip build in (UMA).

M10@ : means build VGA M10

M9@ : means build VGA M9+X

M9-M10@ : means build VGA M9 or M10

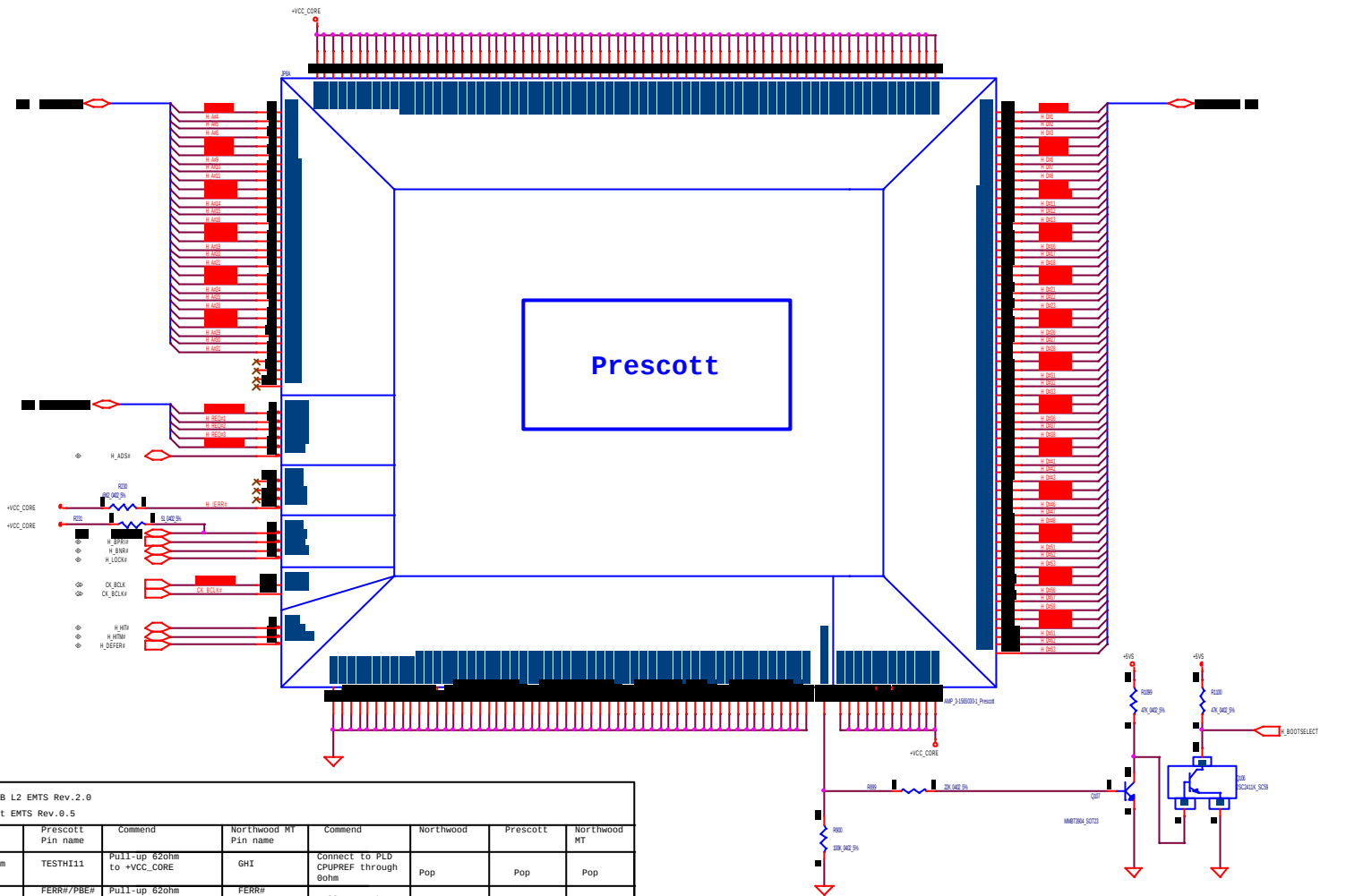
1520@ : means build Cardbus PCI1520

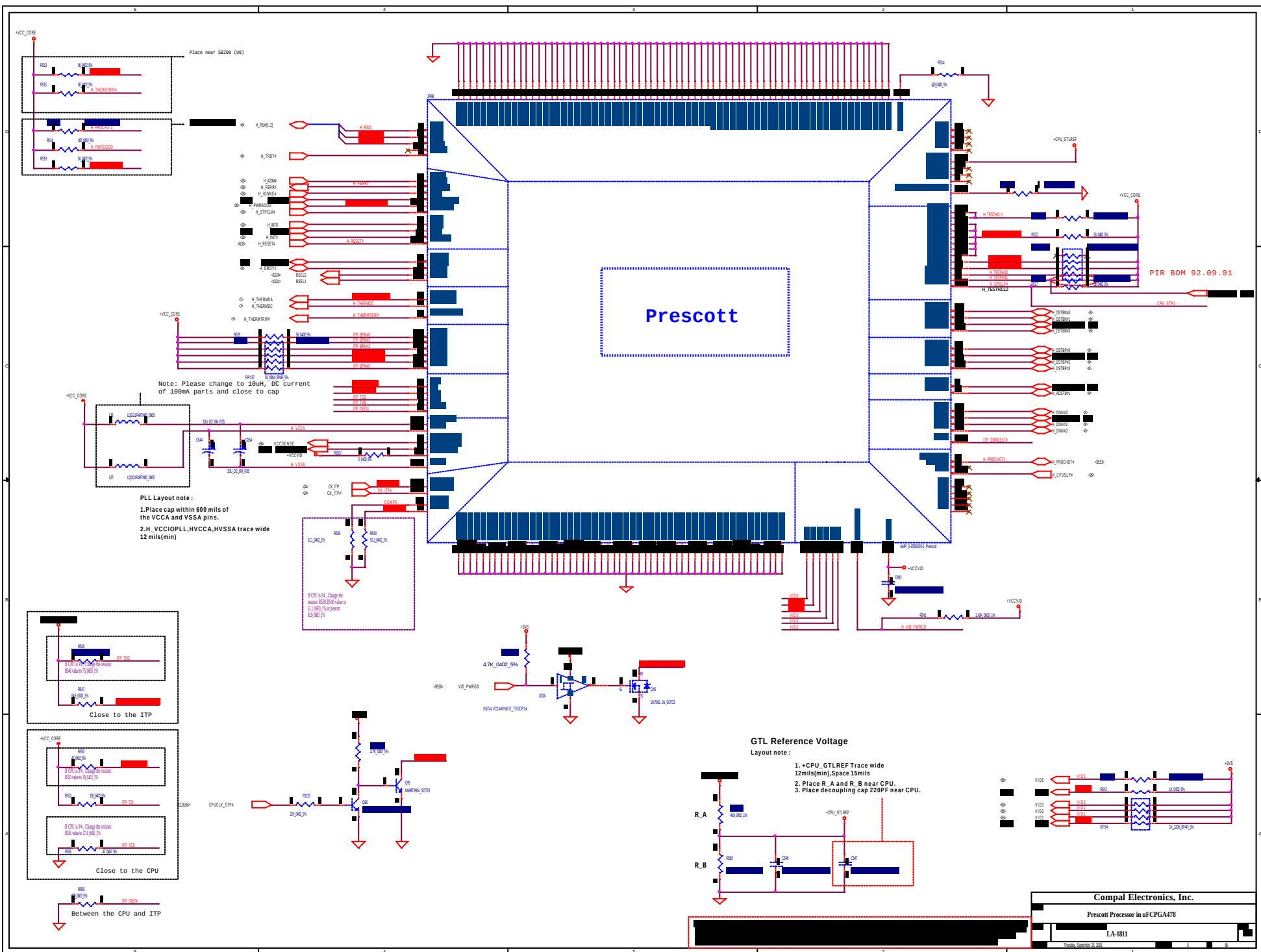
1620@ : means build Cardbus PCI1620

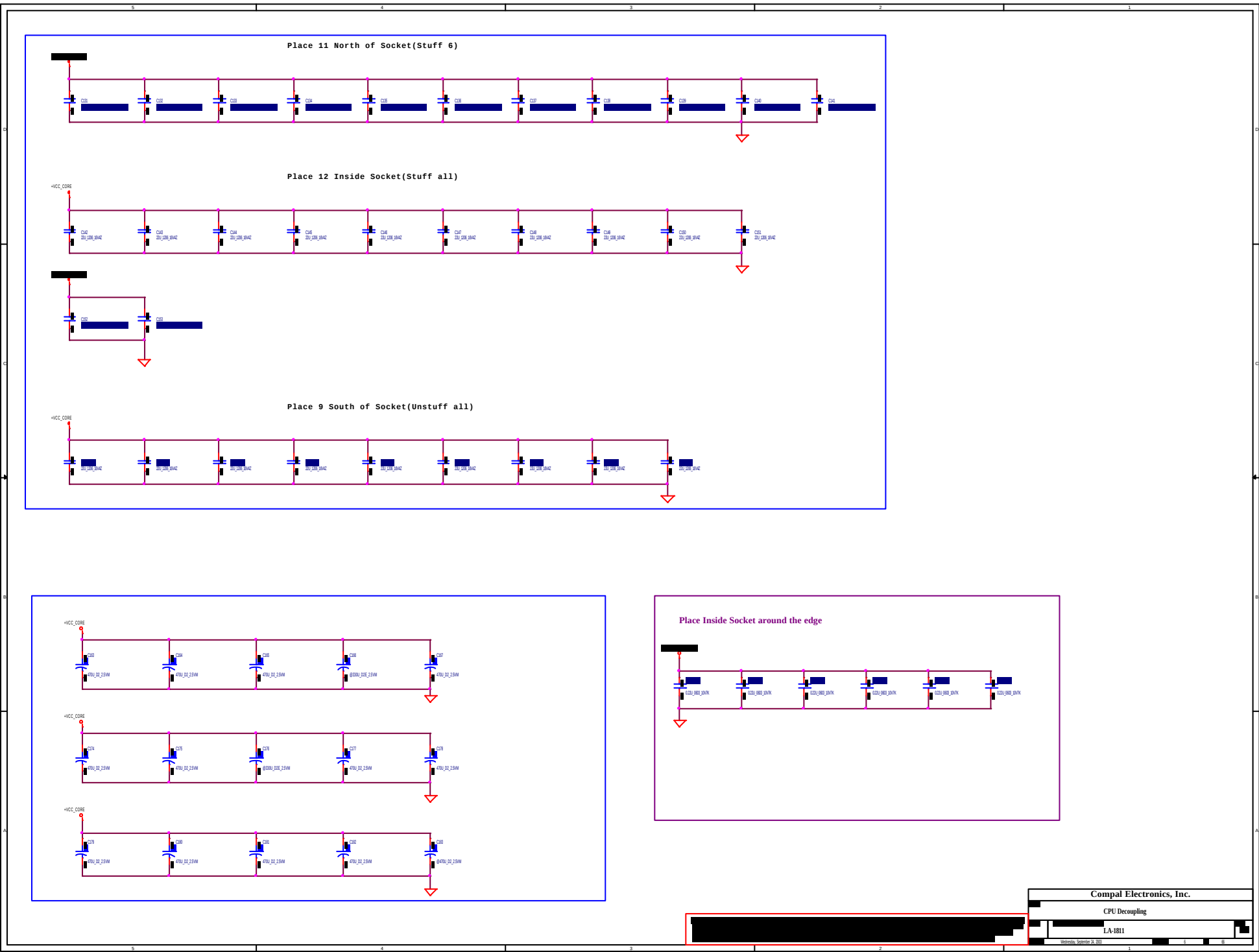
ATI@ : means build ATI SB USB2.0 related to turn on the function .

NEC@ : means build NEC USB2.0 related to turn on the function .

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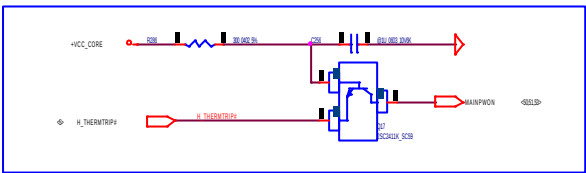






**Thermal Sensor ADM1032AR**

The diagram illustrates the internal circuitry of the Thermal Sensor ADM1032AR. Key components include a 100k pull-up resistor on the CS pin, a 100nF capacitor on the CS pin, and a 100k pull-down resistor on the SDA pin. The sensor is connected to a 3.3V supply and ground. The output pins are labeled CS\_SMC\_2, CS\_SMC\_1, and CS\_SMC\_0. The address is 1001\_100X.

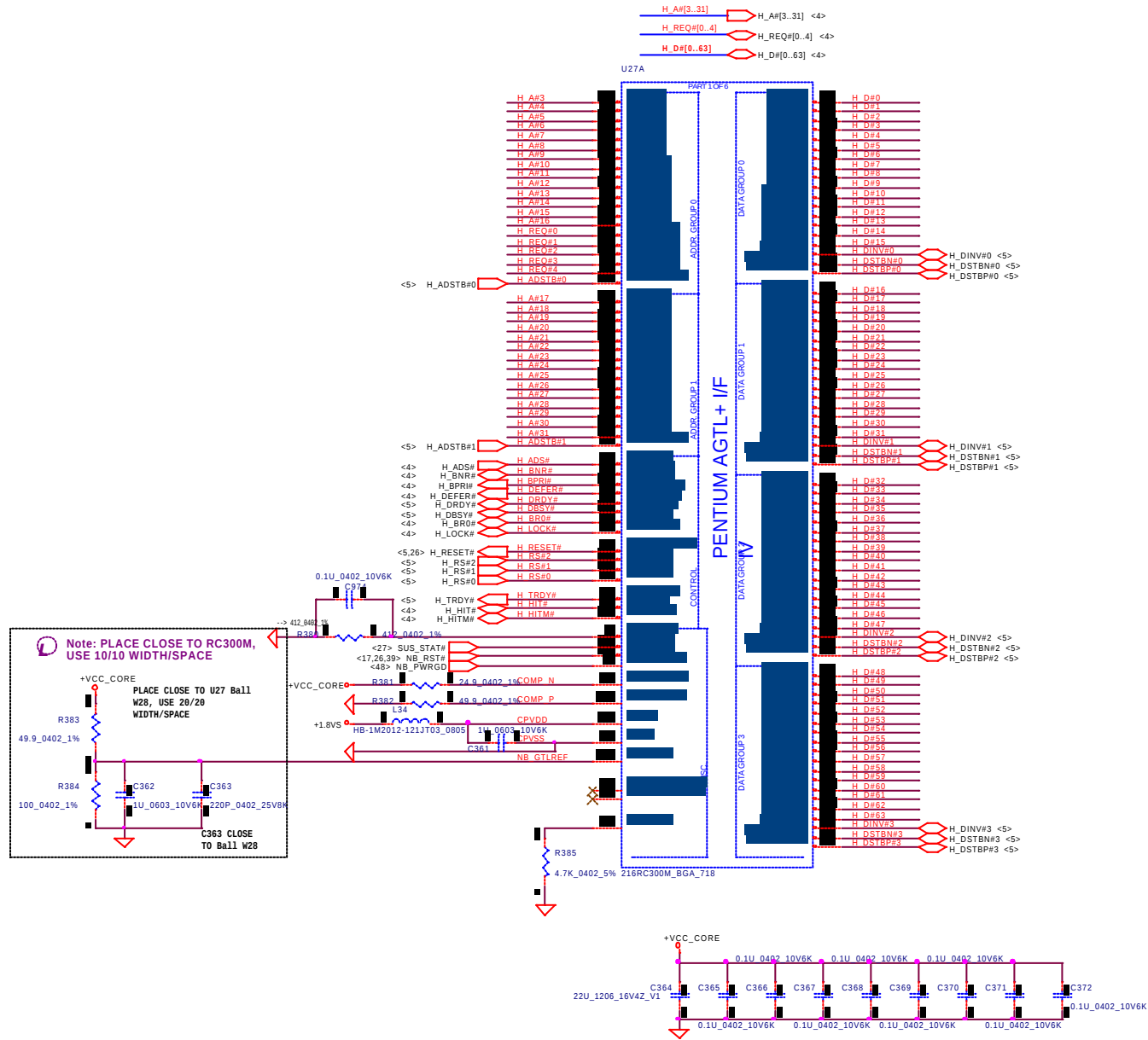


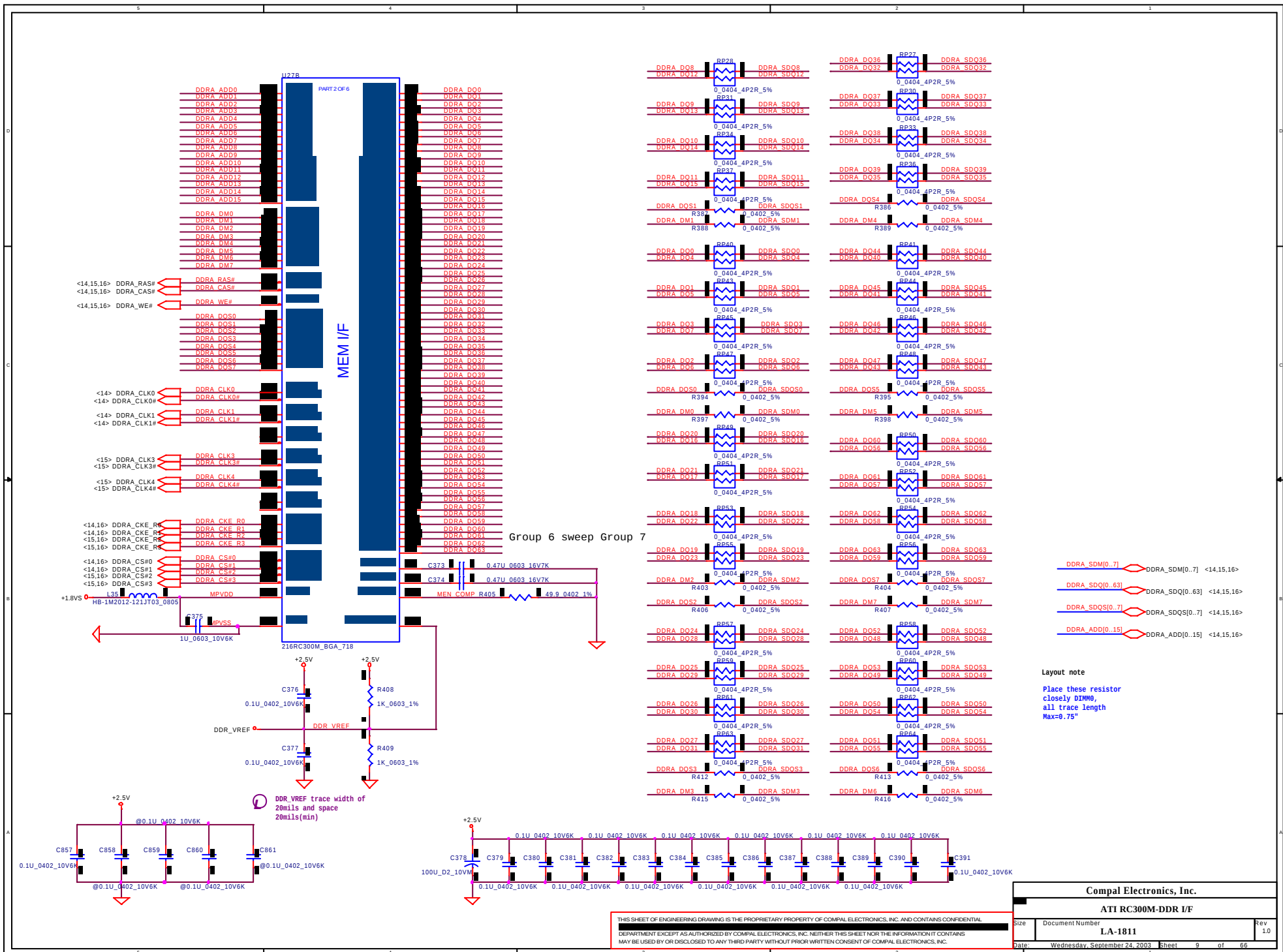
**FAN CONN.1**

The schematic shows the electrical connections for a fan system. Key components include:

- Power Supply:** +5V and -5V rails are connected to the fan's power pins.
- Fan Motor:** Labeled "FAN1", it is connected to the +5V rail through a 0.1µF capacitor and to ground through a 1kΩ resistor.
- Control Circuitry:** Includes a MOSFET driver stage (IRF540) controlled by a microcontroller pin (PWR\_FAN). The MOSFET is connected to the fan's speed control pin (FANSPD1).
- Other Components:** Various capacitors (e.g., 10µF, 100nF) and resistors (e.g., 1kΩ, 10kΩ) are used for filtering and signal conditioning.

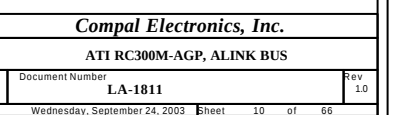
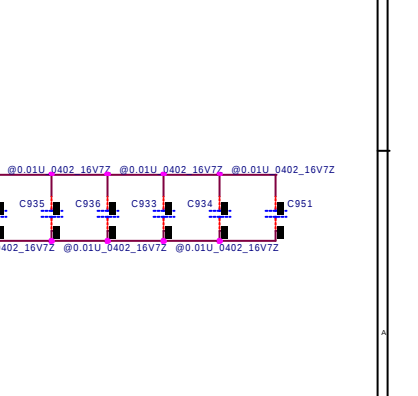
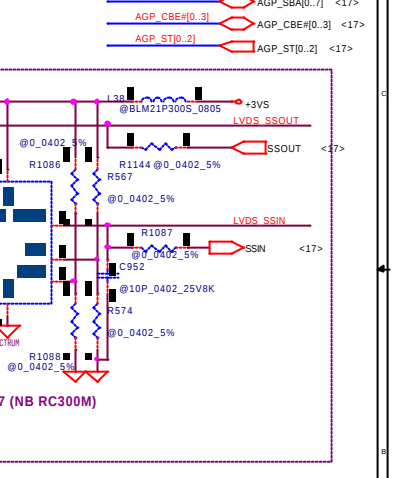
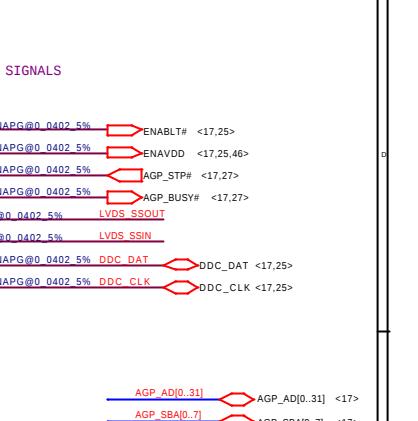
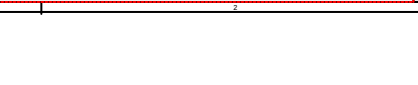
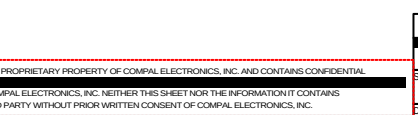
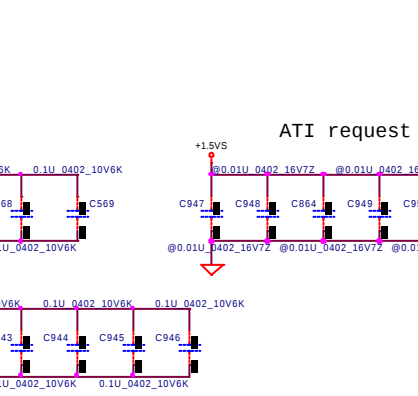
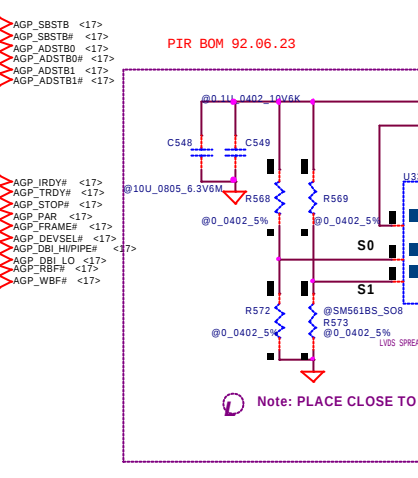
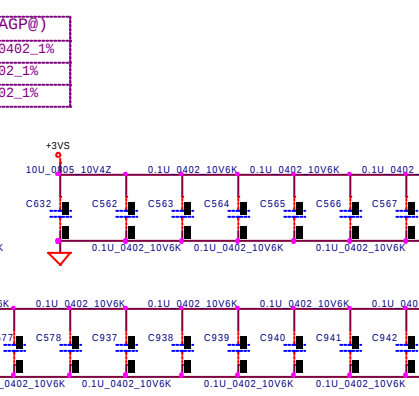
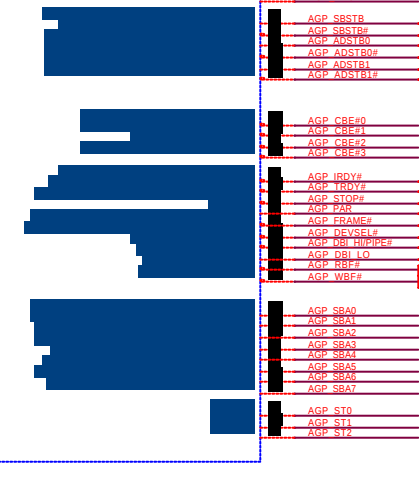
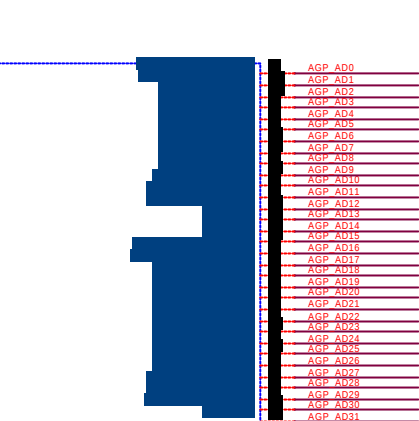
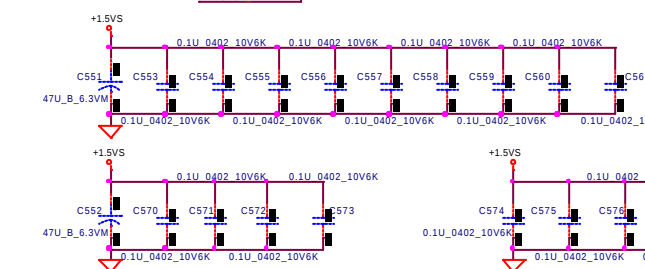
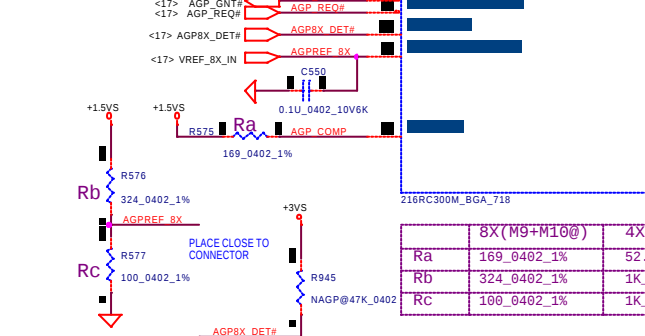
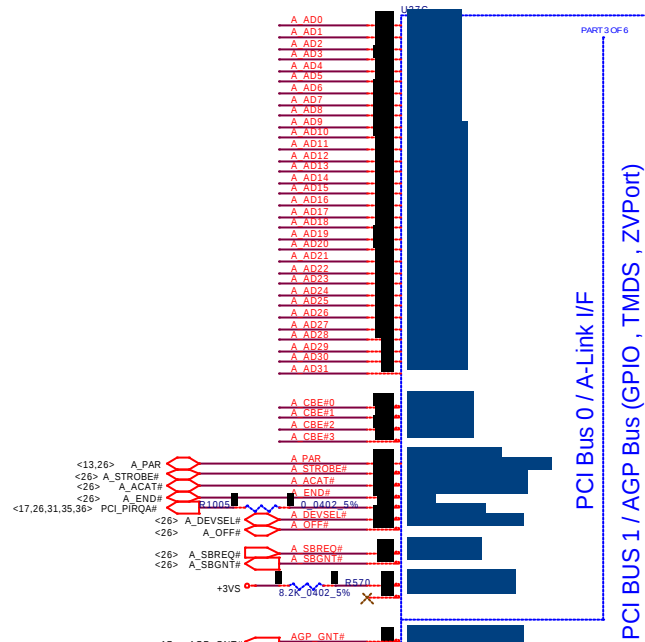
[illegible]



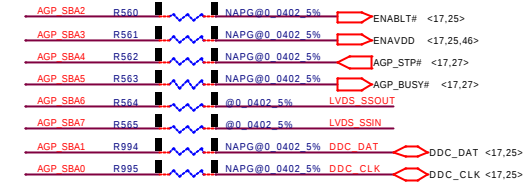


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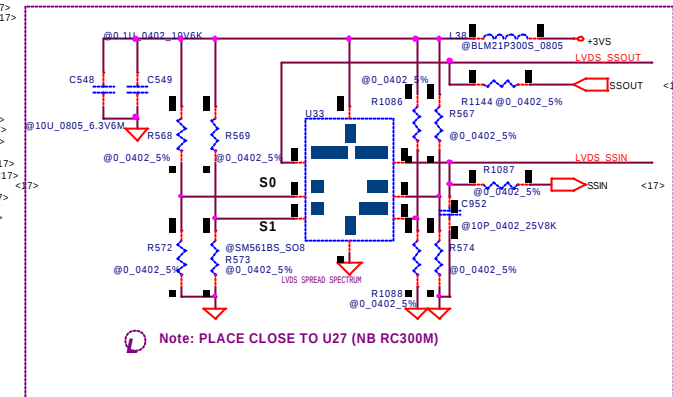
<13,26> A\_AD[0..31] A\_AD[0..31]  
<13,26> A\_CBE#[0..3] A\_CBE#[0..3]



#### AGPAND LVDS MUXED SIGNALS

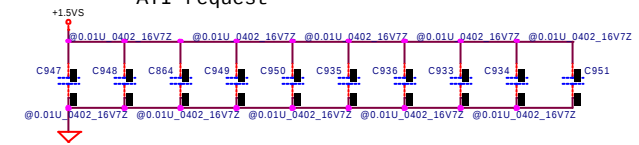


PIR BOM 92.06.23



Note: PLACE CLOSE TO U27 (NB RC300M)

#### ATI request

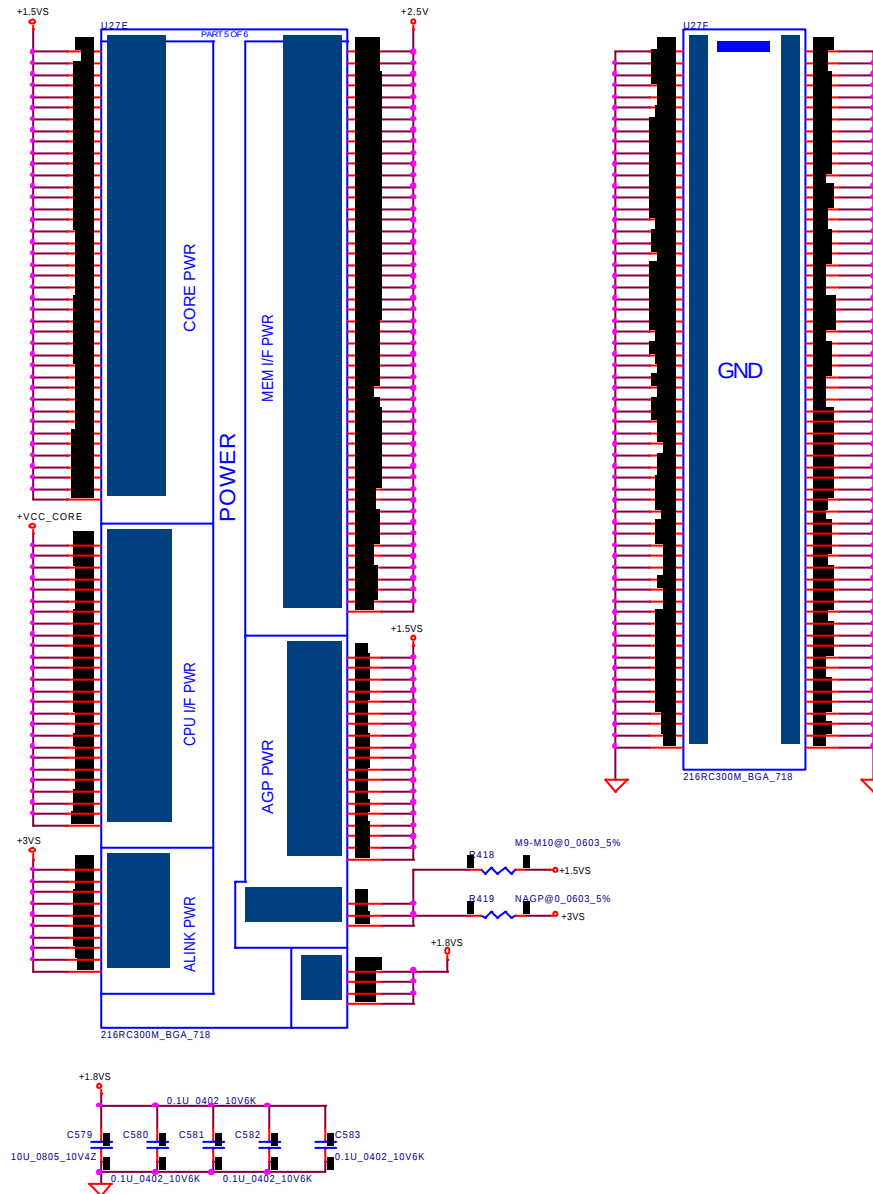


Note: PLACE CLOSE TO U27 (NB RC300M)

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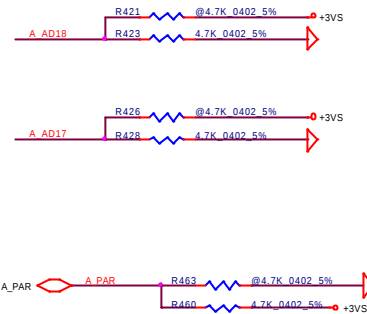
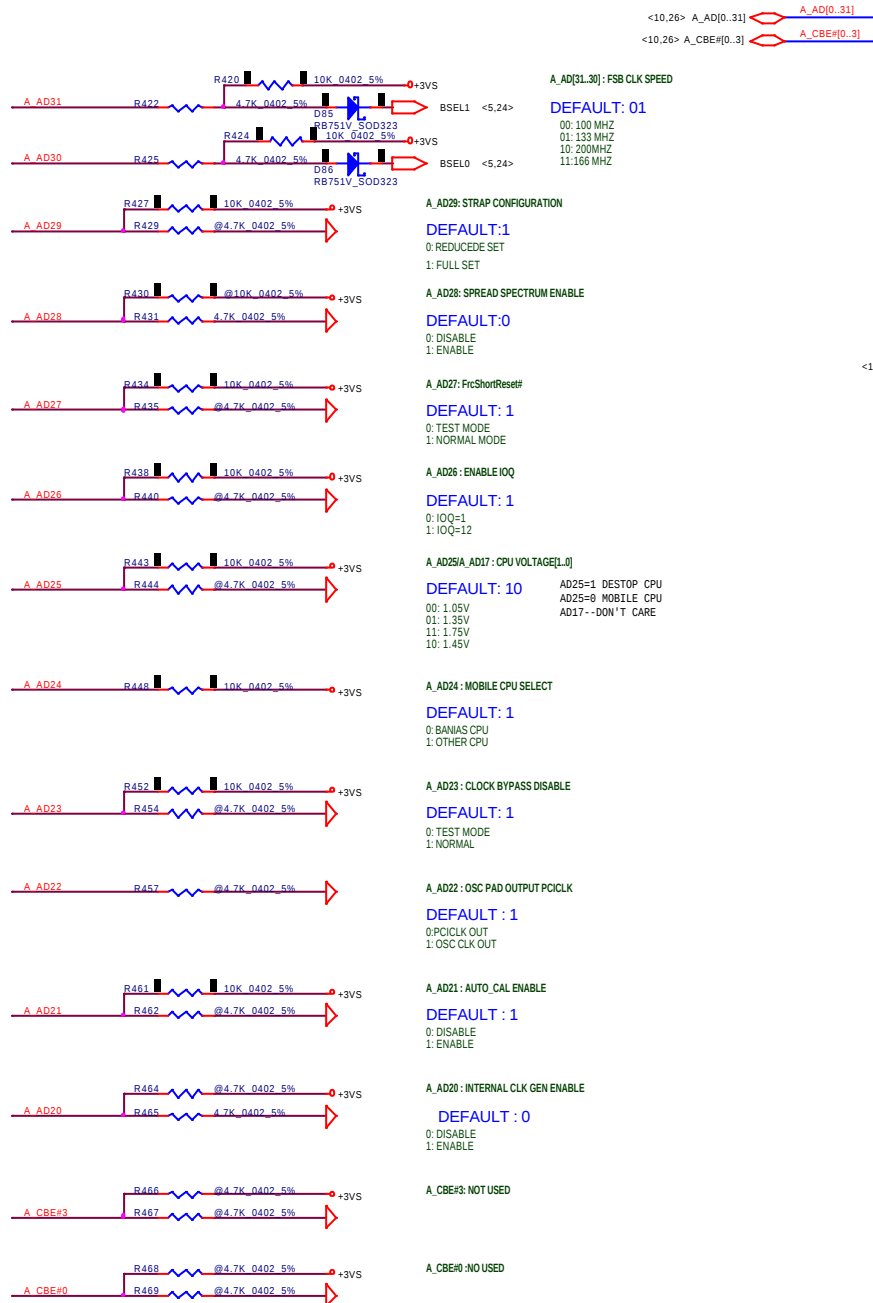
|                           |                               |                |
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| ATI RC300M-AGP, ALINK BUS |                               |                |
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| ATI RC300M-POWER         |                               |                |
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A\_AD18: ENABLE PHASE CALIBRATION

DEFAULT: 0

0: DISABLE

1: ENABLE

A\_AD25/A\_AD17: CPU VOLTAGE[L0]

DEFAULT: 0

00: 1.05V

01: 1.35V

11: 1.75V

10: 1.45V

PAR: EXTENDED DEBUG MODE

DEFAULT: 1

0: DEBUG MODE

1: NORMAL

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| ATI RC300M-SYSTEM STRAP  |                               |                |
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<LSB>    DDR4\_SQ[0:6]    <LSB>    DDR4\_SQ[0:6]    <LSB>    DDR4\_SQ[0:6]    <LSB>    DDR4\_SQ[0:6]  
 <LSB>    DDR4\_SQ[0:7]    <LSB>    DDR4\_SQ[0:7]    <LSB>    DDR4\_SQ[0:7]    <LSB>    DDR4\_SQ[0:7]  
 <LSB>    DDR4\_SQ[0:15]    <LSB>    DDR4\_SQ[0:15]    <LSB>    DDR4\_SQ[0:15]    <LSB>    DDR4\_SQ[0:15]  
 <LSB>    DDR4\_SQ[0:31]    <LSB>    DDR4\_SQ[0:31]    <LSB>    DDR4\_SQ[0:31]    <LSB>    DDR4\_SQ[0:31]

Group 0 sweep Group 1

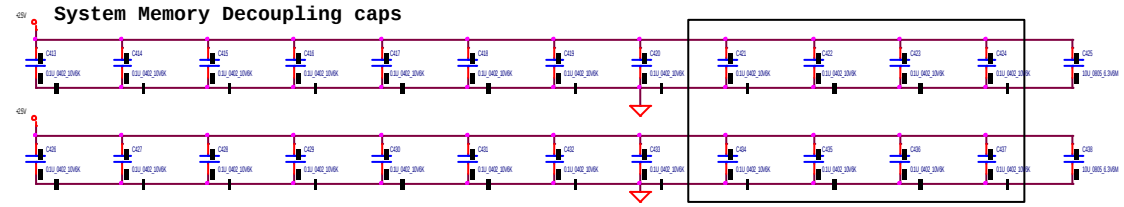
Group 0 sweep Group 1

Group 6 sweep Group 7

Group 6 sweep Group 7

DIMM0  
REVERSE

### System Memory Decoupling caps



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DDR-SODIMM SLOT1

LA-1811

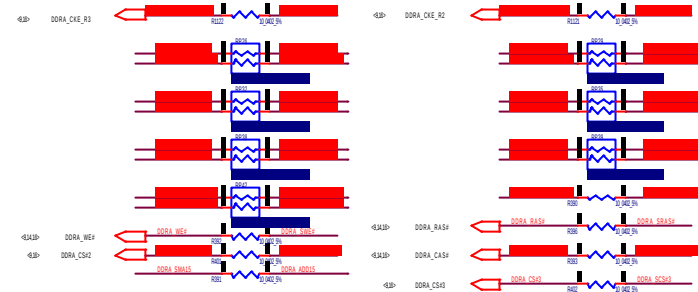
<LA3P> DDR4\_SQ[0..15]    DDR4\_SQ[0..15]  
 <LA3P> DDR4\_SQ[0..15]    DDR4\_SQ[0..15]  
 <LA3P> DDR4\_AD[0..15]    DDR4\_AD[0..15]

Group 0 sweep Group 1

◇ DDR4\_CLK3  
 ◇ DDR4\_CLK9

Group 0 sweep Group 1

DDR4\_VREF trace width of  
 20mils and space  
 20mils(min)

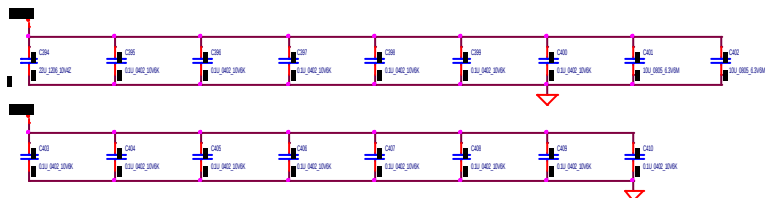


Group 6 sweep Group 7

<LA3P>    SMB\_CLK [0..15]  
 <LA3P>    SMB\_CLK [0..15]

**DIMM1  
STANDARD**

**System Memory Decoupling caps**



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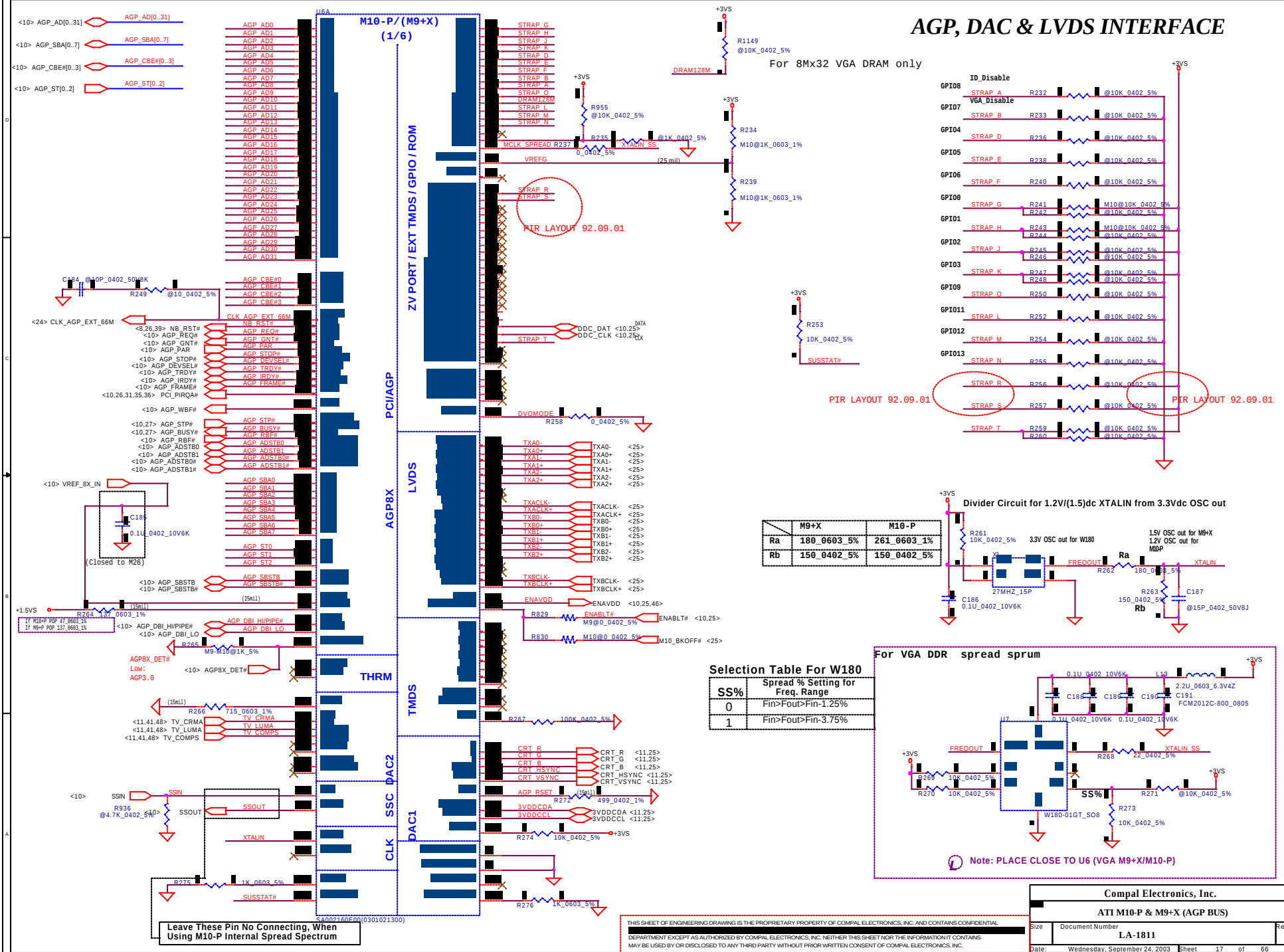
DDR-SODIMM SLOT2

LA-1811



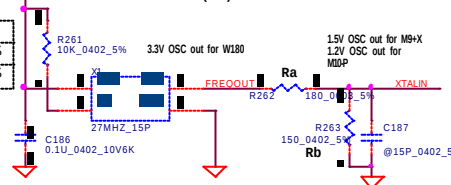
# AGP, DAC & LVDS INTERFACE

For 8Mx32 VGA DRAM only



|    | M9+X        | M10-P       |
|----|-------------|-------------|
| Ra | 180_0603_5% | 261_0603_1% |
| Rb | 150_0402_5% | 150_0402_5% |

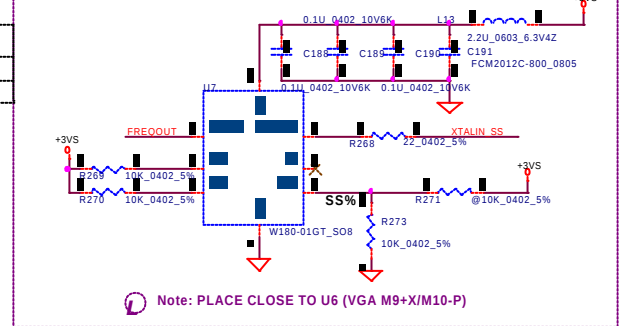
Divider Circuit for 1.2V/(1.5)dc XTALIN from 3.3Vdc OSC out



**Selection Table For W180**

| SS% | Spread % Setting for Freq. Range |
|-----|----------------------------------|
| 0   | Fin>Fout>Fin-1.25%               |
| 1   | Fin>Fout>Fin-3.75%               |

For VGA DDR spread sprum



Note: PLACE CLOSE TO U6 (VGA M9+X/M10-P)

Leave These Pin No Connecting, When Using M10-P Internal Spread Spectrum

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| ATI M10-P & M9+X (AGP BUS) |                               |
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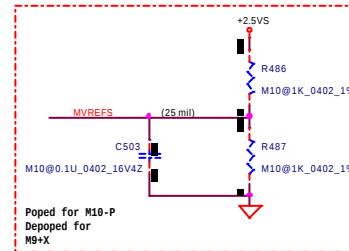
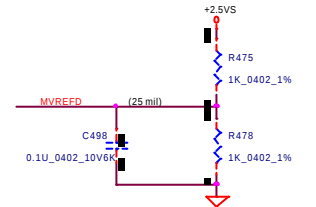
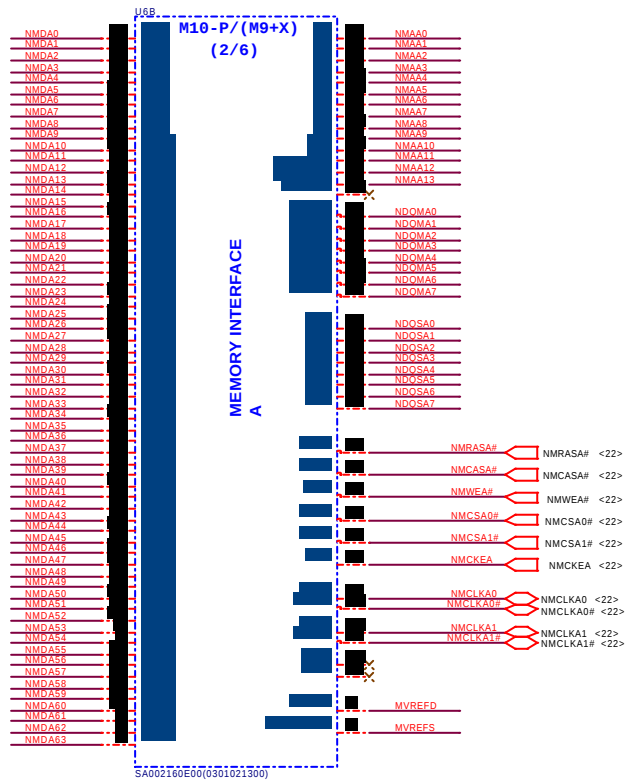
# MEMORY INTERFACE A

<22> NMDA[0..63]  NMDA[0..63]

<22> NMAA[0..13]  NMAA[0..13]

<22> NDQMA[0..7]  NDQMA[0..7]

<22> NDQSA[0..7]  NDQSA[0..7]

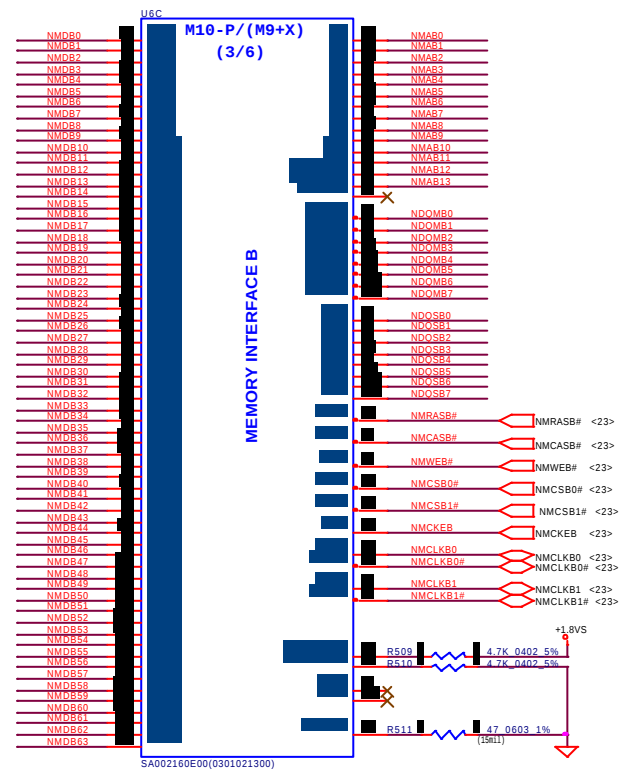


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| ATI M10-P/M9+X DDR-A     |                               |                |
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# MEMORY INTERFACE B

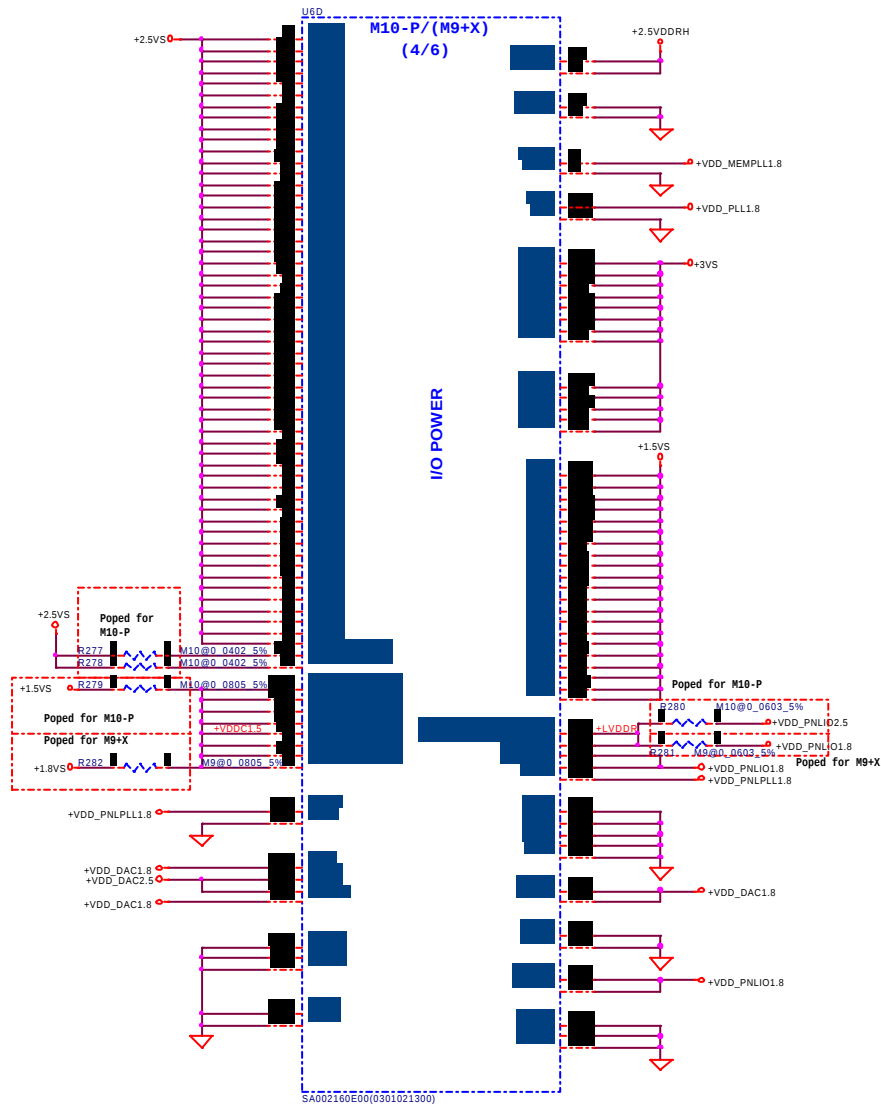
<23> NMDB[0..63] NMAB[0..63]  
 <23> NMAB[0..13] NMAB[0..13]  
 <23> NDQMB[0..7] NDQMB[0..7]  
 <23> NDQSB[0..7] NDQSB[0..7]



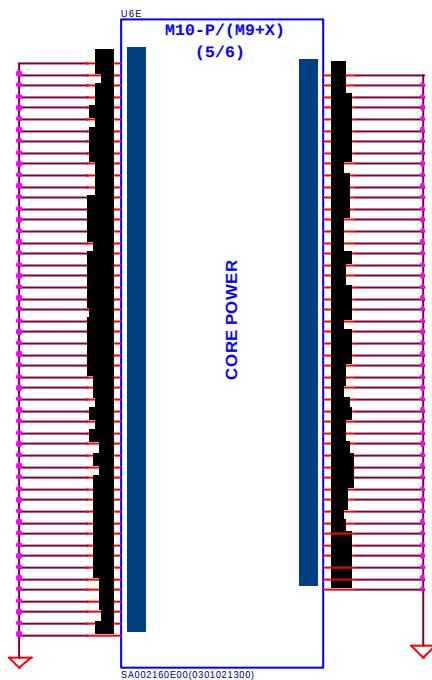
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| ATI M10-P/M9+X DDR-B     |                               |                |
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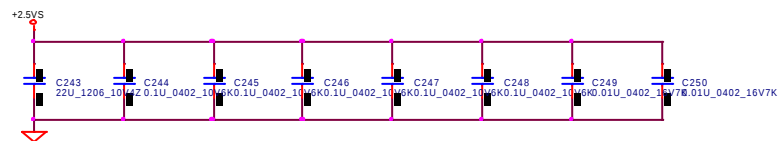
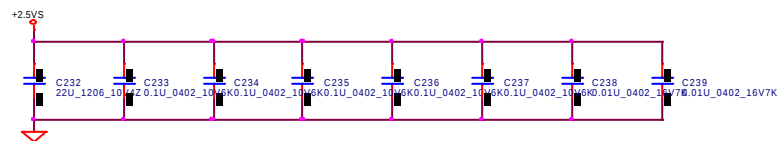
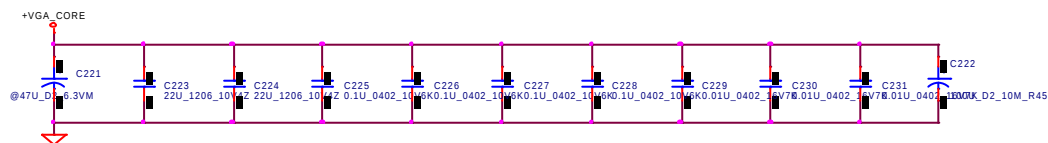
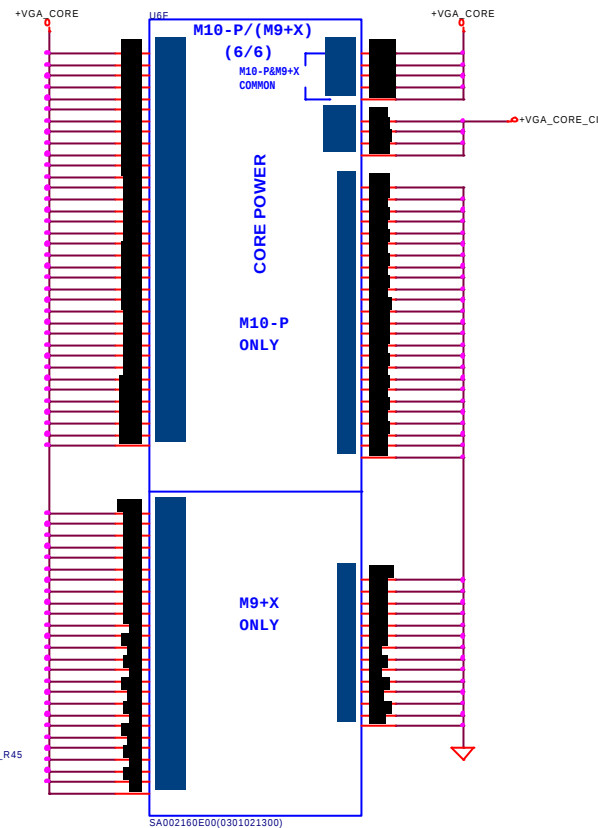
## POWER INTERFACE



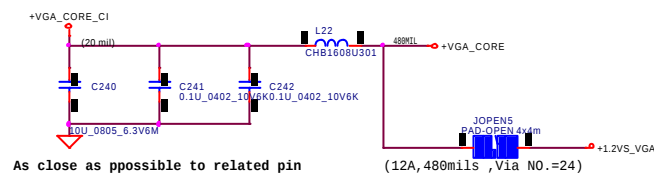
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## POWER INTERFACE



As close as possible to related pin



As close as possible to related pin

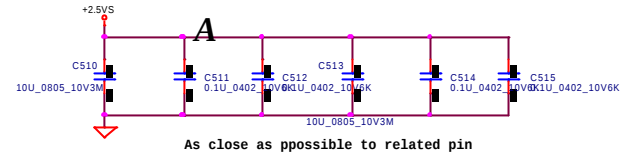
(12A, 480mils, Via NO.=24)

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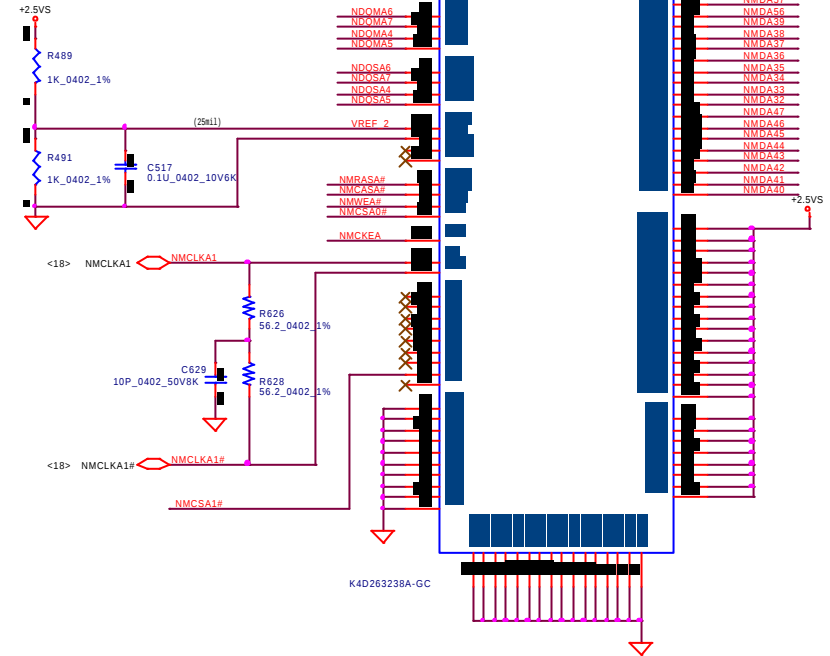
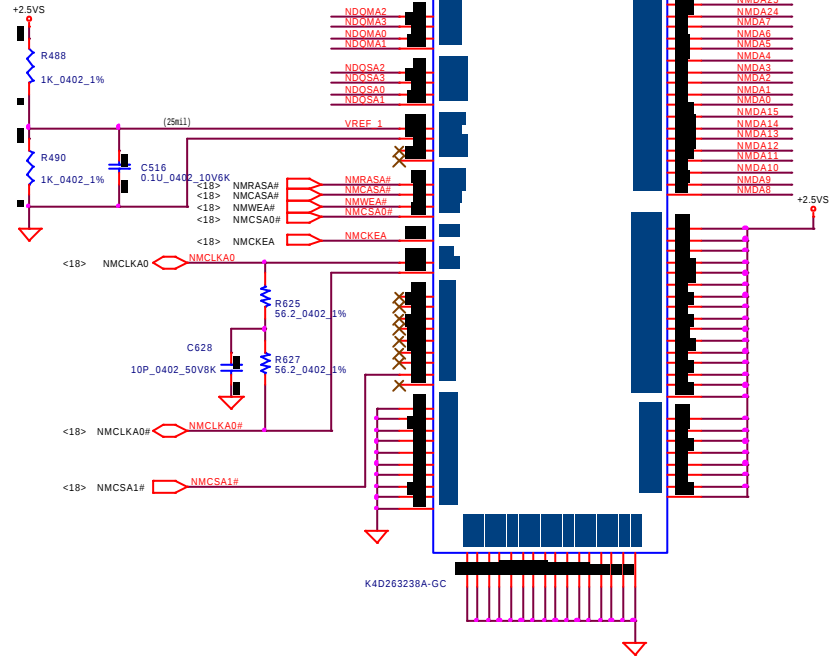
|                          |                               |                |
|--------------------------|-------------------------------|----------------|
| Compal Electronics, Inc. |                               |                |
| ATI M10-P/M9+X POWER-B   |                               |                |
| Size                     | Document Number               | Rev            |
|                          | LA-1811                       | 1.0            |
| Date                     | Wednesday, September 24, 2003 | Sheet 21 of 66 |

# VGA DDR FOR CHANNEL

A



- <18> NMAA[0..13] NMAA[0..13]
- <18> NMDA[0..63] NMDA[0..63]
- <18> NDQMA[0..7] NDQMA[0..7]
- <18> NDQSA[0..7] NDQSA[0..7]

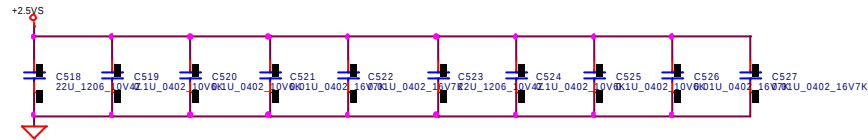


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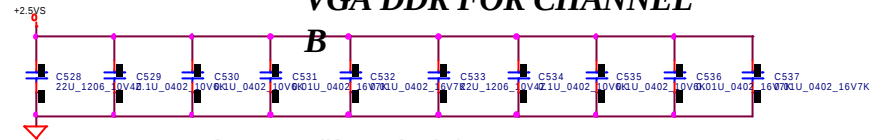
|                          |                               |                |
|--------------------------|-------------------------------|----------------|
| Compal Electronics, Inc. |                               |                |
| VGA DDR FOR CHANNEL A    |                               |                |
| Size                     | Document Number               | Rev            |
|                          | LA-1811                       | 1.0            |
| Date                     | Wednesday, September 24, 2003 | Sheet 22 of 66 |

# VGA DDR FOR CHANNEL

**B**

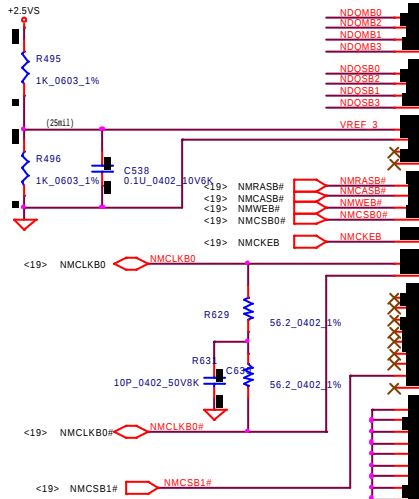


As close as possible to related pin

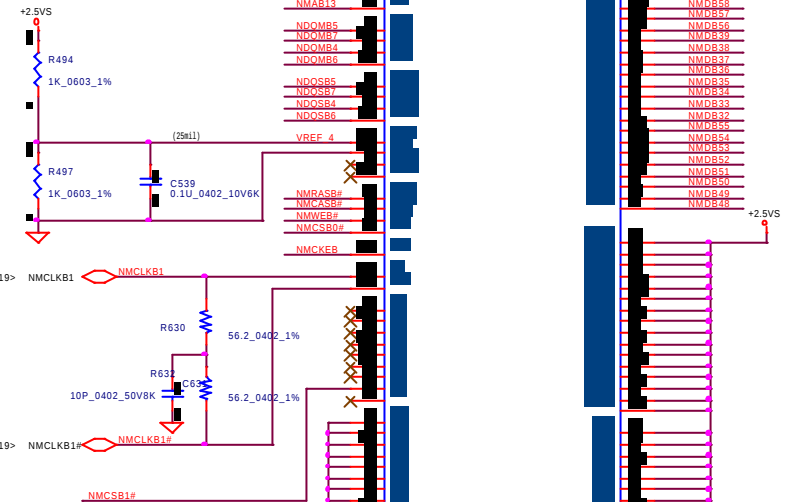


As close as possible to related pin

<19> NMAB[0..13] NMAB[0..13]  
<19> NMDB[0..63] NMDB[0..63]  
<19> NDQMB[0..7] NDQMB[0..7]  
<19> NDQSB[0..7] NDQSB[0..7]



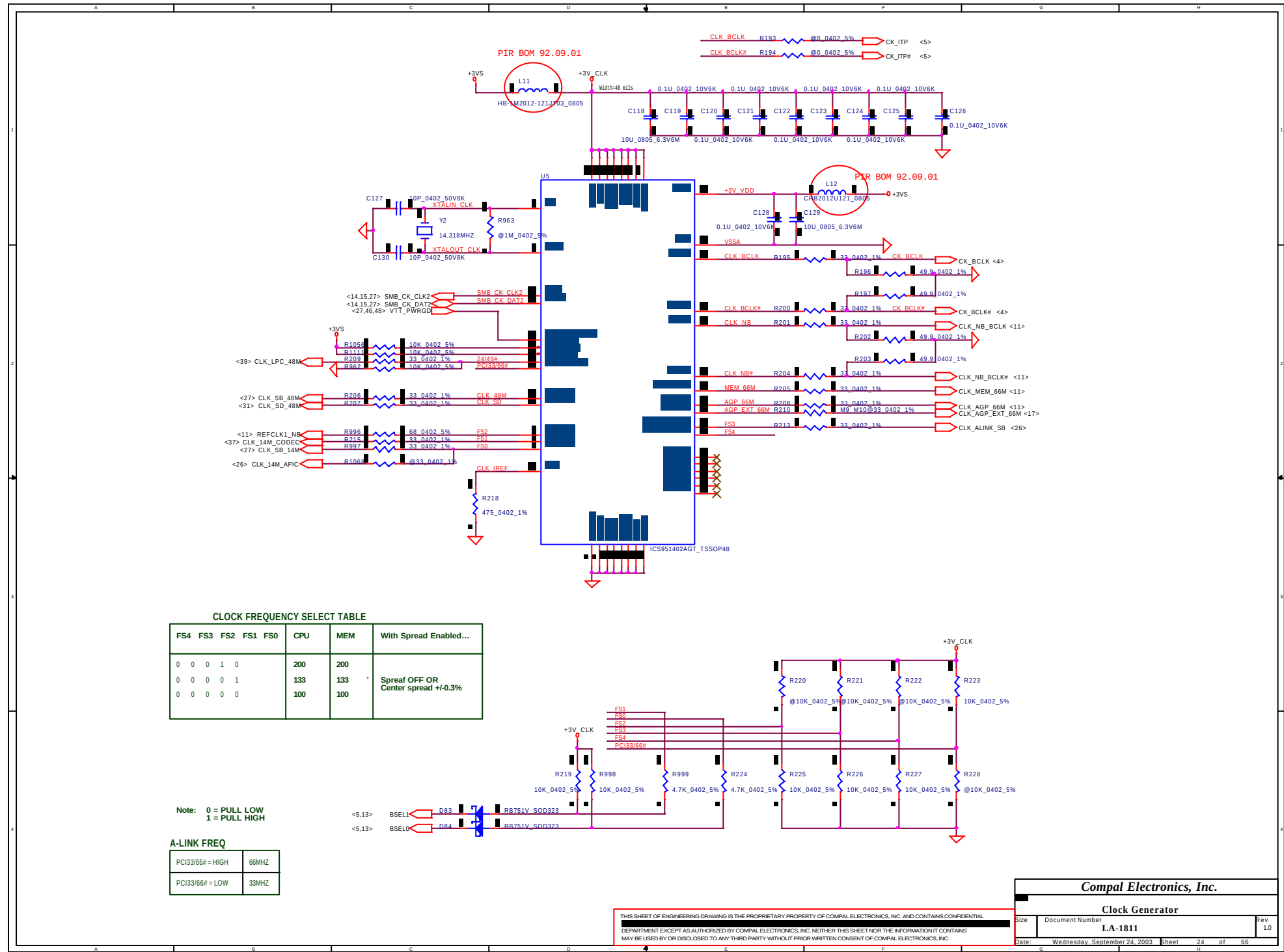
K4D263238A-GC



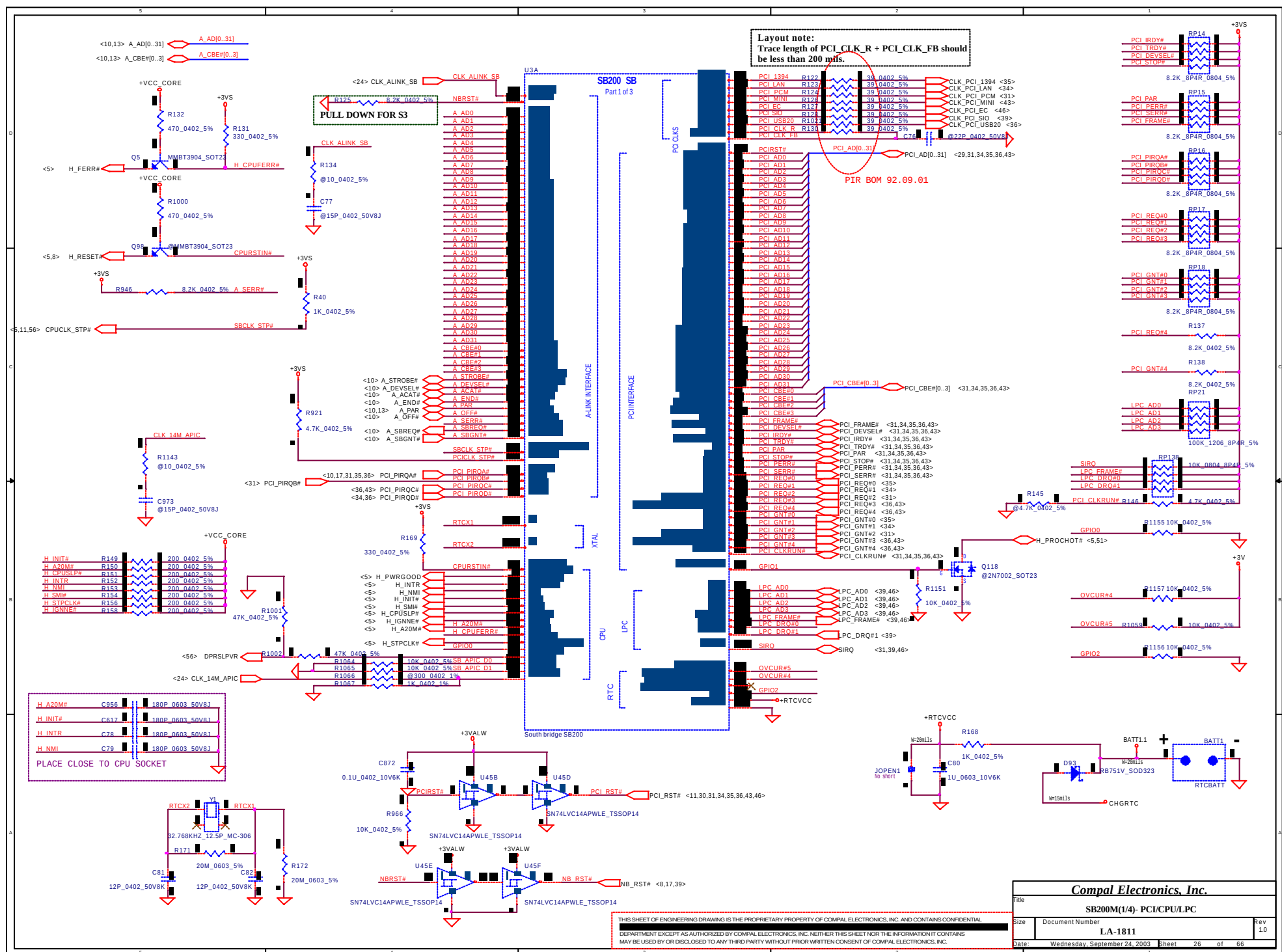
K4D263238A-GC

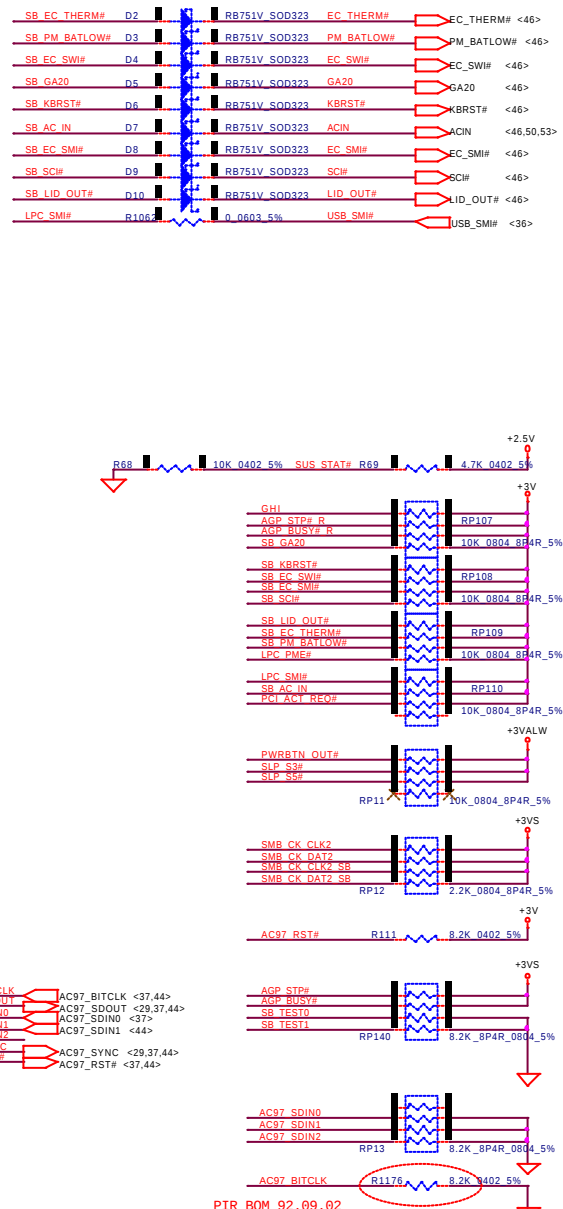
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|                          |                               |                |
|--------------------------|-------------------------------|----------------|
| Compal Electronics, Inc. |                               |                |
| VGA DDR FOR CHANNEL B    |                               |                |
| Size                     | Document Number               | Rev            |
|                          | LA-1811                       | 1.0            |
| Date                     | Wednesday, September 24, 2003 | Sheet 23 of 66 |

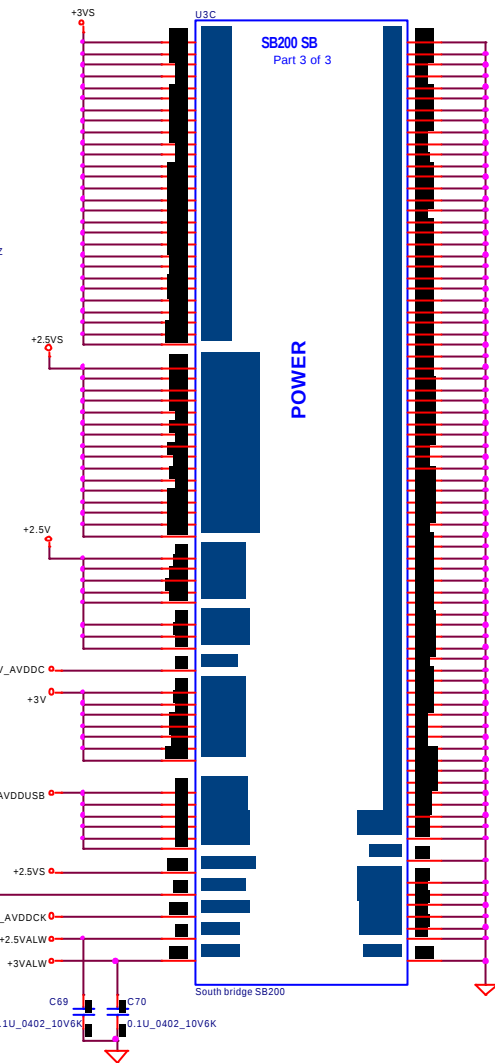
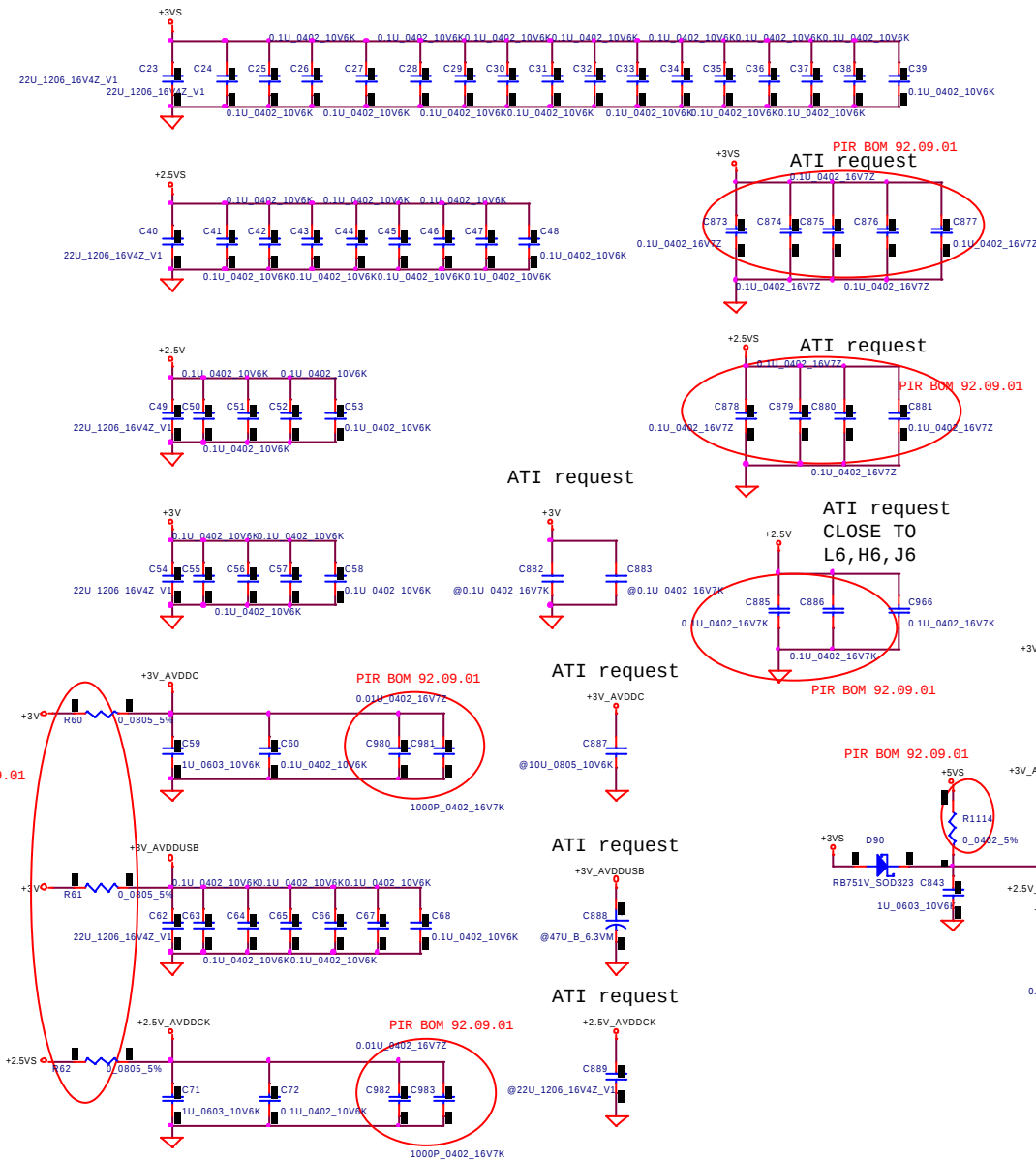






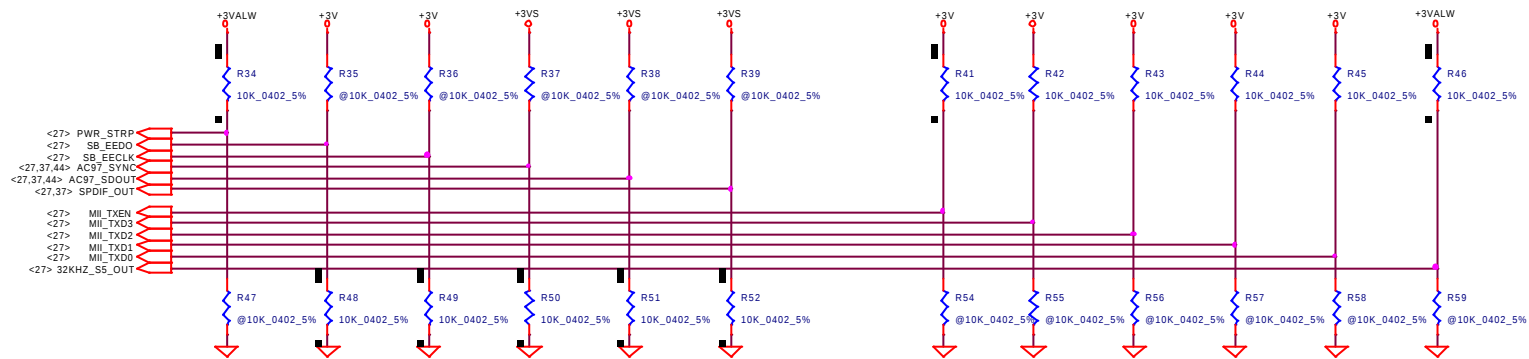


|                                 |                               |       |          |
|---------------------------------|-------------------------------|-------|----------|
| <b>Compal Electronics, Inc.</b> |                               |       |          |
| Title                           |                               |       |          |
| SB200M(2/4) - IDE/USB/MII       |                               |       |          |
| Size                            | Document Number               |       | Rev      |
|                                 | LA-1811                       |       | 1.0      |
| Date:                           | Wednesday, September 24, 2003 | Sheet | 27 of 66 |



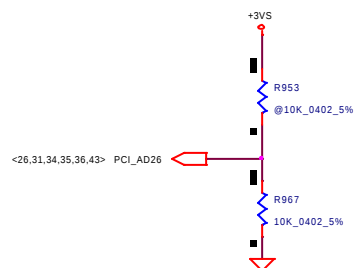
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| Compal Electronics, Inc. |                               |       |          |
|--------------------------|-------------------------------|-------|----------|
| File: SB200M(3/4) - PWR  |                               |       |          |
| Size                     | Document Number               | Rev   |          |
|                          | L.A-1811                      | 1.0   |          |
| Date:                    | Wednesday, September 24, 2003 | Sheet | 28 of 66 |



# REQUIRED SYSTEM STRAPS

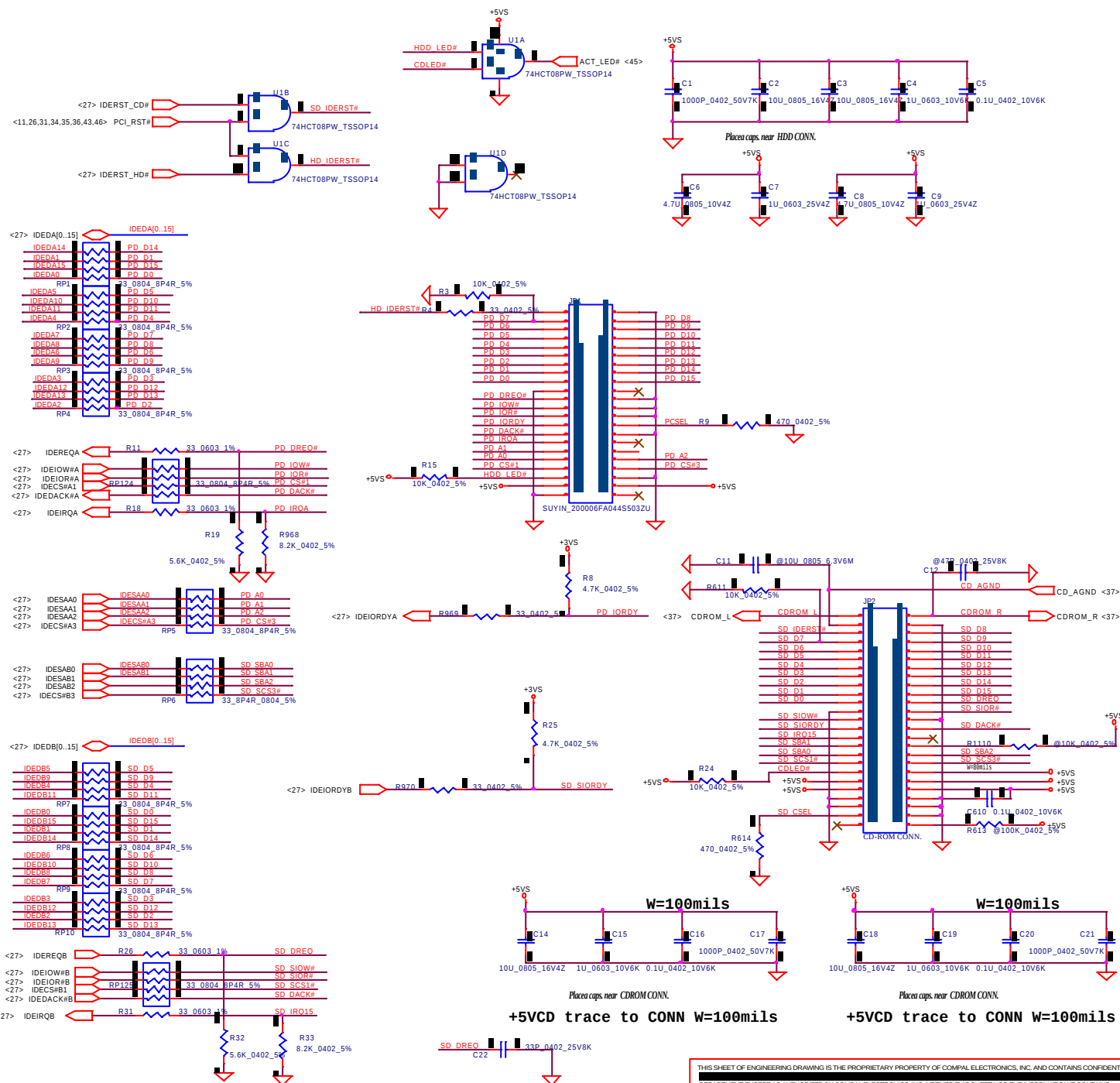
|               | PWR_STRP                        | IGN DEBUG<br>EEDO                        | EECK                                | AC_SYNC                 | AC_SDOUT                          | SPDIF_OUT                | SPEEDSTEP<br>CPU_STP#                   | FREQLYCH<br>TX_EN                             | ETHERNET TXD[3:0]         | 32KHZ_S5                                   |
|---------------|---------------------------------|------------------------------------------|-------------------------------------|-------------------------|-----------------------------------|--------------------------|-----------------------------------------|-----------------------------------------------|---------------------------|--------------------------------------------|
| STRAP<br>HIGH | MANUAL<br>PWR ON<br><br>DEFAULT | USE<br>DEBUG<br>STRAPS                   | ROM ON<br>PCI BUS                   | INIT ACTIVE<br>HIGH     | 33MHz NB<br>BUS                   | SIO 20MHz                | ENABLE<br>SPEED<br>STEP                 | DISABLE<br>CPU FREQ<br>SETTING<br><br>DEFAULT | PROCESSOR FREQ MULTIPLIER | 32KHZ<br>OUTPUT<br>FROM SB200<br>(INT RTC) |
| STRAP<br>LOW  | AUTO<br>PWR<br>ON               | IGNORE<br>DEBUG<br>STRAPS<br><br>DEFAULT | ROM ON<br>LPC<br>BUS<br><br>DEFAULT | INIT ACTIVE<br>LOW (P#) | HI SPEED<br>A-LINK<br><br>DEFAULT | SIO 40MHz<br><br>DEFAULT | DISABLE<br>SPEED<br>STEP<br><br>DEFAULT | ENABLE CPU<br>FREQ SETTING                    |                           | 32KHZ INPUT<br>TO SB200<br>(EXT RTC)       |



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|                          |                               |       |          |
|--------------------------|-------------------------------|-------|----------|
| Compal Electronics, Inc. |                               |       |          |
| SB200M(4/4) - STRAPS     |                               |       |          |
| Size                     | Document Number               | Rev   |          |
|                          | LA-1811                       | 1.0   |          |
| Date                     | Wednesday, September 24, 2003 | Sheet | 29 of 66 |

### HDD/CD-ROM Module





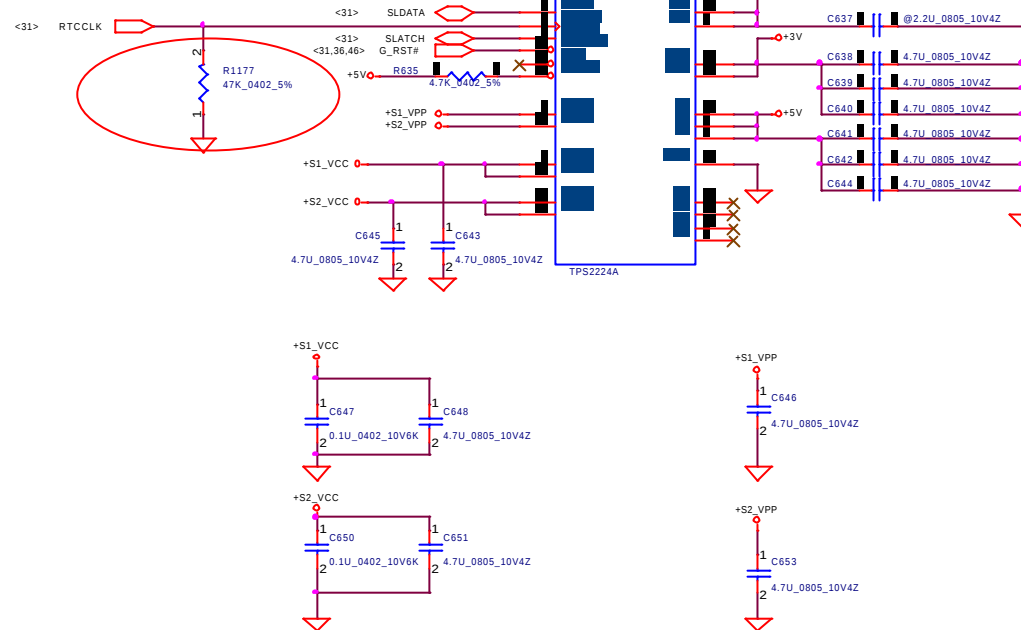
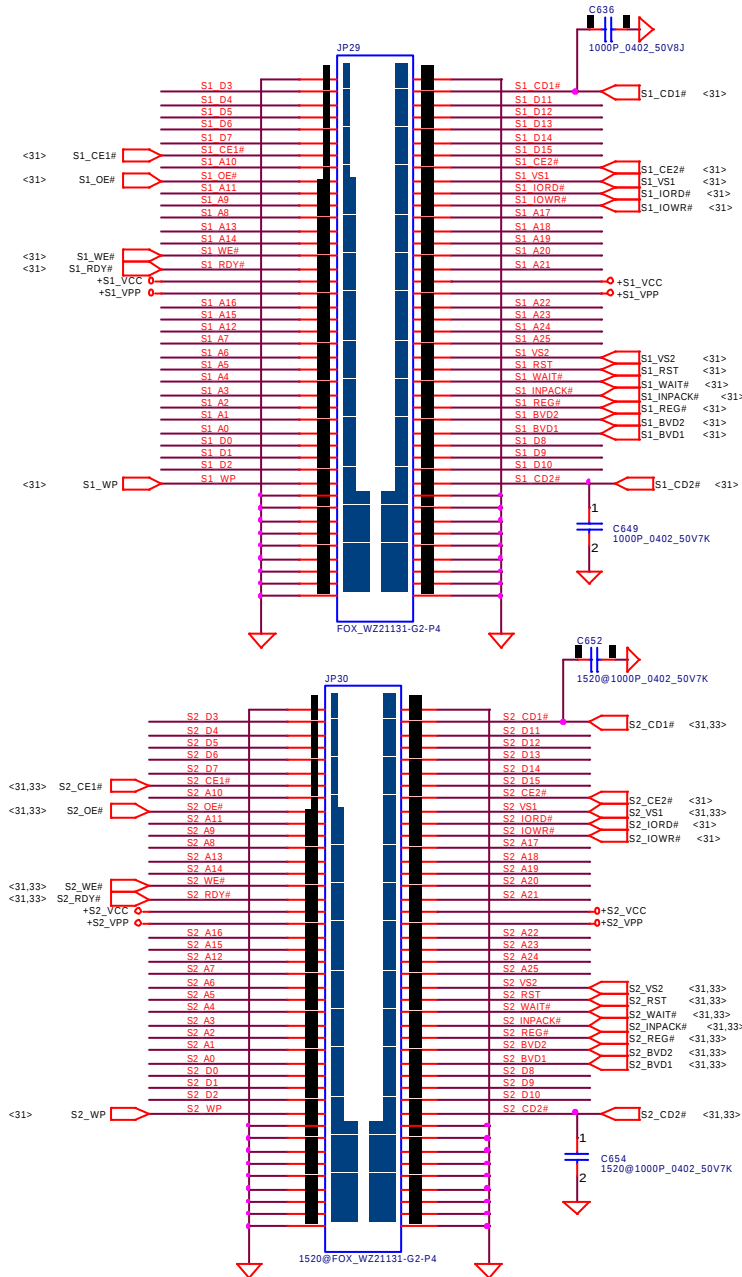
# CARDBUS

# SOCKET

<31> S1\_D[0..15] S1\_D[0..15]  
 <31> S1\_A[0..25] S1\_A[0..25]  
 <31,33> S2\_D[0..15] S2\_D[0..15]  
 <31,33> S2\_A[0..25] S2\_A[0..25]

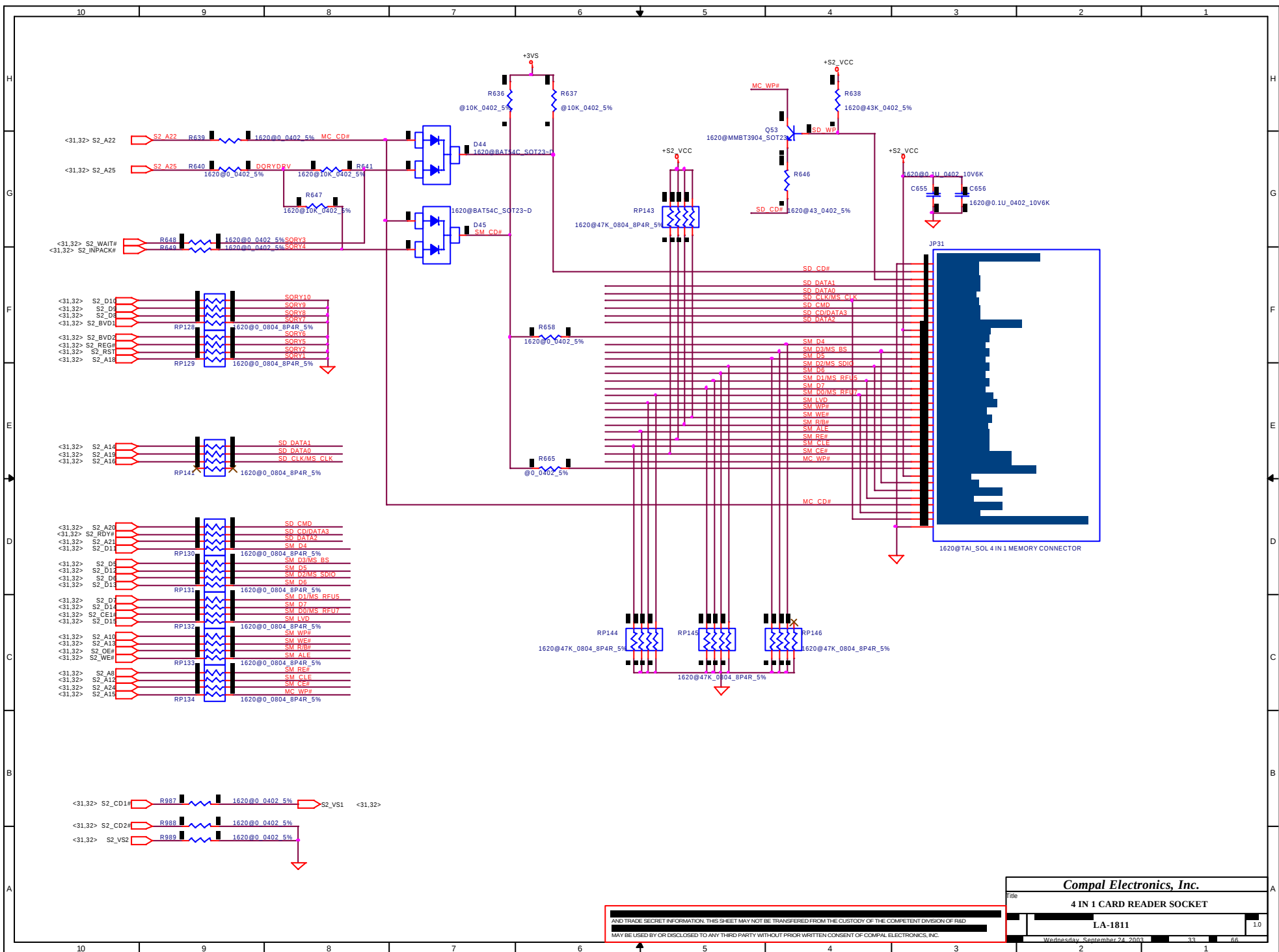
# PCMCIA POWER CTRL.

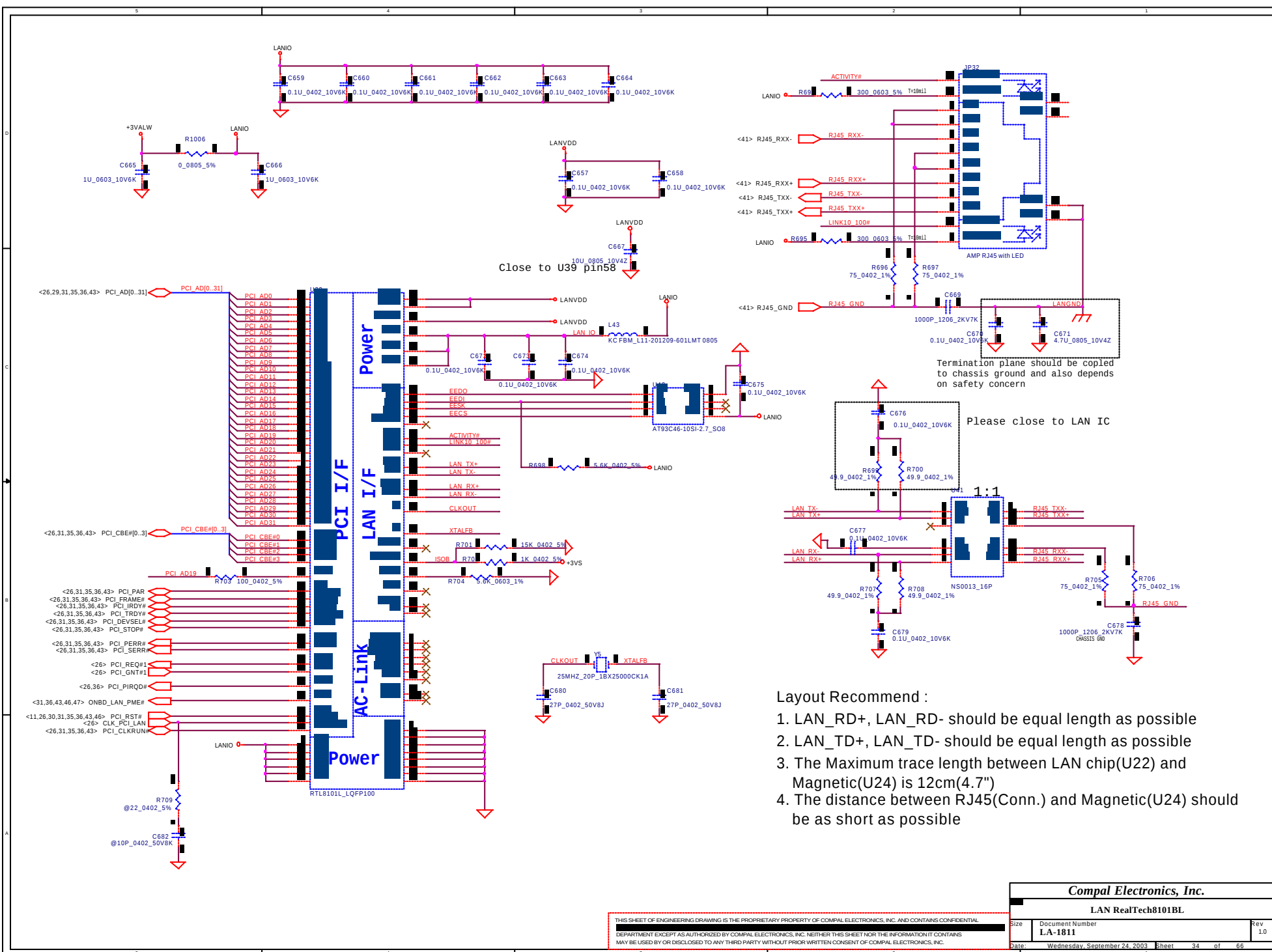
PIR BOM & LAYOUT 92.09.01

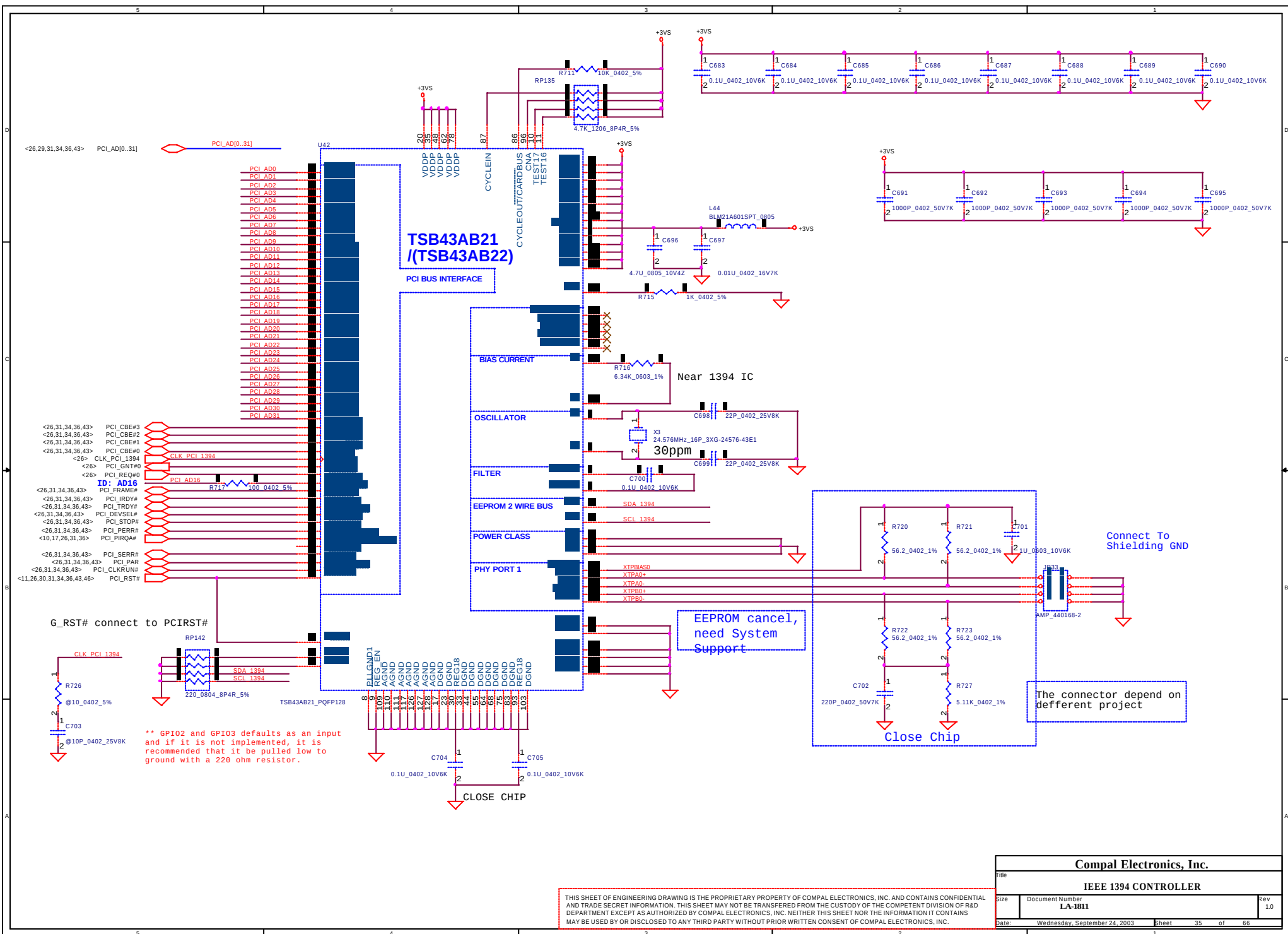


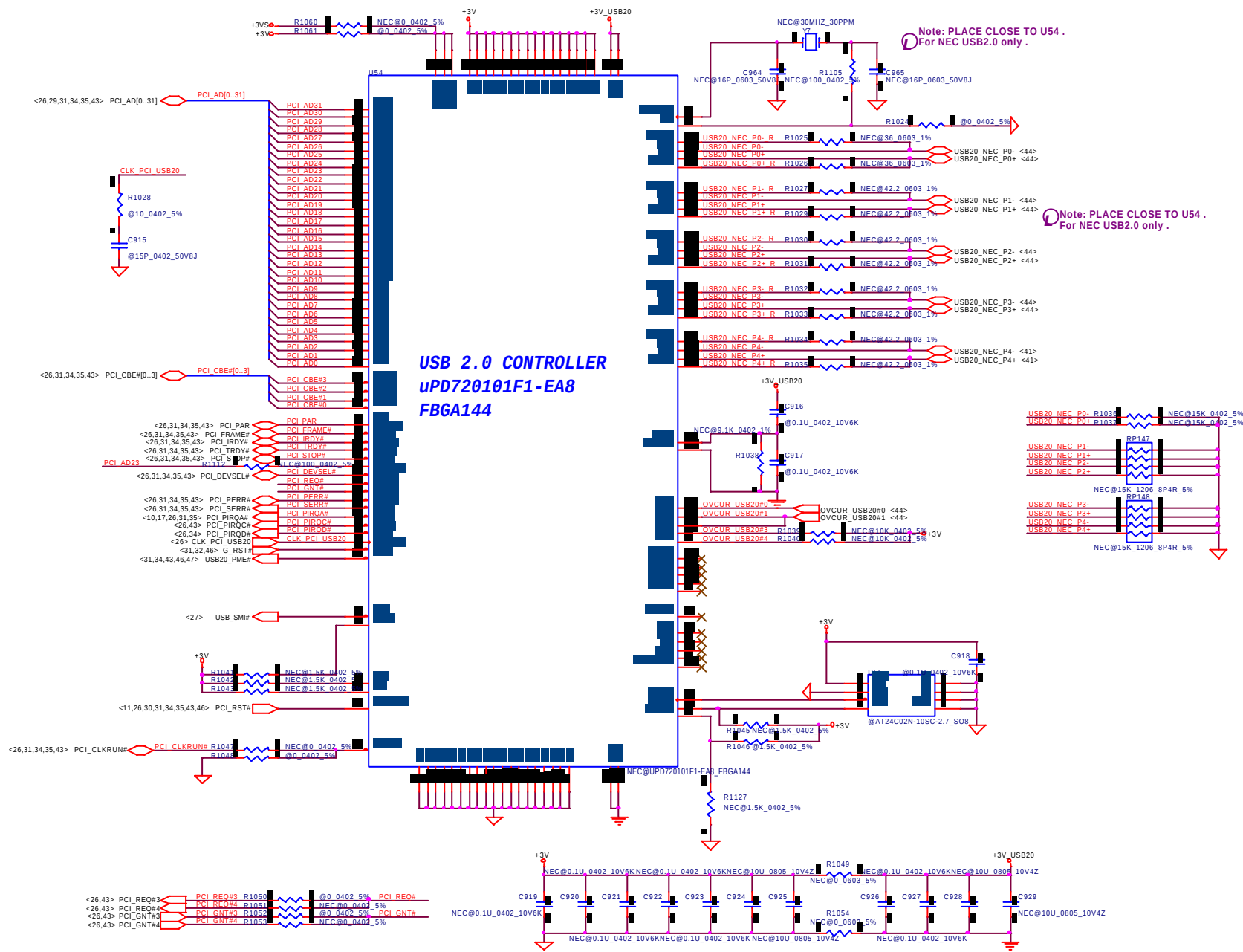
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| Compal Electronics, Inc. |                               |       |          |
|--------------------------|-------------------------------|-------|----------|
| Title                    |                               |       |          |
| CARD BUS SOCKET          |                               |       |          |
| Size                     | Document Number               | Rev   |          |
|                          | LA-1811                       | 1.0   |          |
| Date                     | Wednesday, September 24, 2003 | Sheet | 32 of 66 |









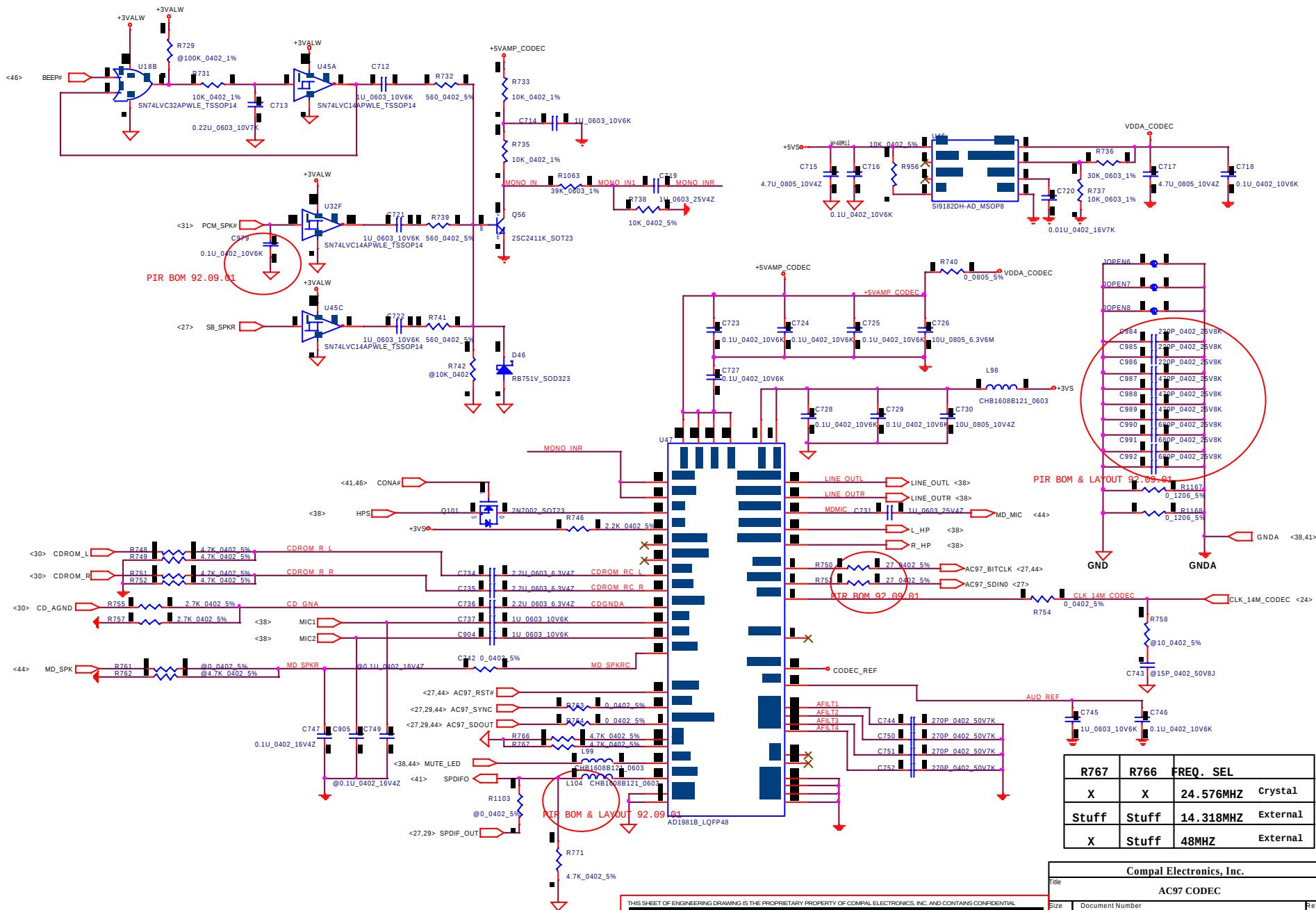
**USB 2.0 CONTROLLER**  
**uPD720101F1-EA8**  
**FBGA144**

Note: PLACE CLOSE TO U54 .  
For NEC USB2.0 only .

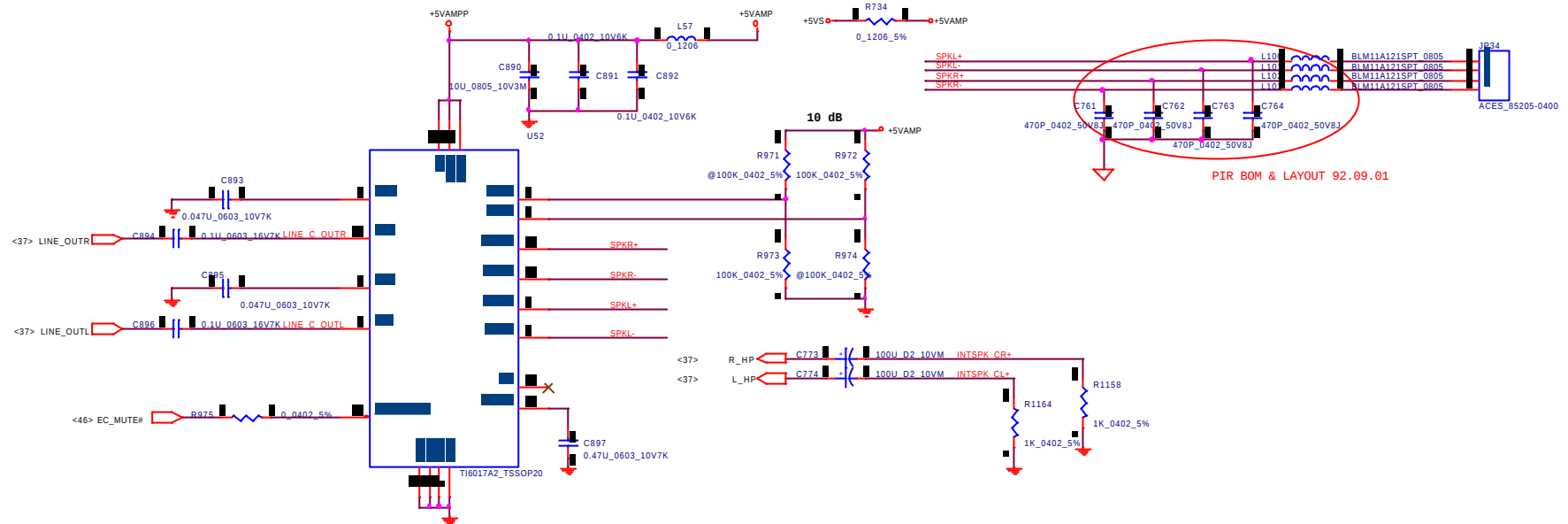
Note: PLACE CLOSE TO U54 .  
For NEC USB2.0 only .

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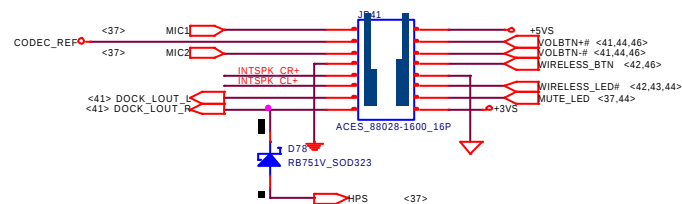
| Compal Electronics, Inc.          |                               |                |
|-----------------------------------|-------------------------------|----------------|
| NEC uPD720101 - USB2.0 Controller |                               |                |
| Size                              | Document Number               | Rev            |
|                                   | LA-1811                       | 1.0            |
| Date                              | Wednesday, September 24, 2003 | Sheet 36 of 66 |



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## AUDIO CONNECTOR

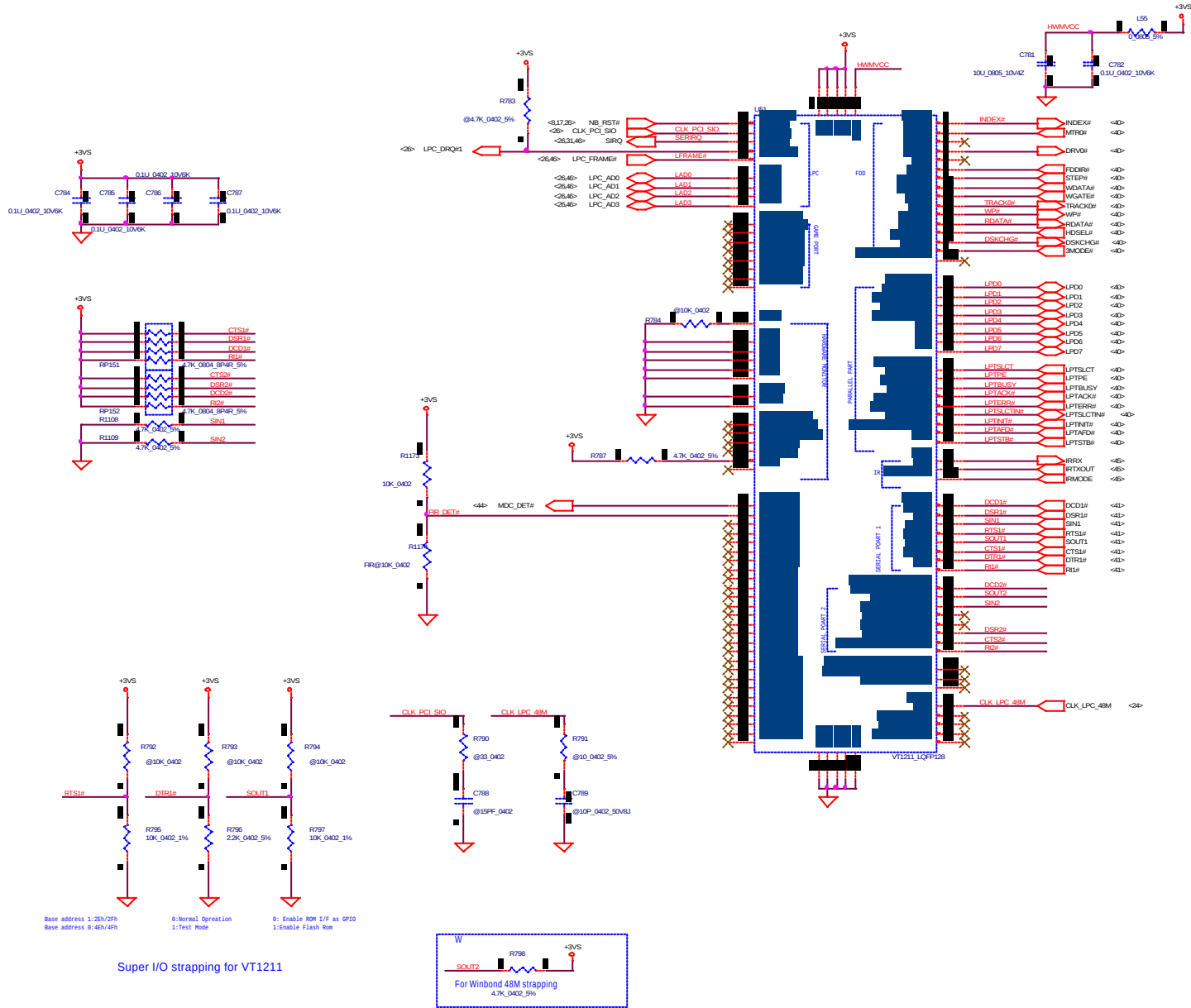


| Gain Settings |       |         |
|---------------|-------|---------|
| GAIN0         | GAIN1 | Av(inv) |
| 0             | 0     | 6 dB    |
| 0             | 1     | 10 dB   |
| 1             | 0     | 15.6 dB |
| 1             | 1     | 21.6 dB |

HEADPHONE OUT/LINE OUT

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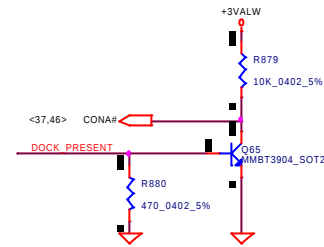
| Compal Electronics, Inc. |                               |                |
|--------------------------|-------------------------------|----------------|
| AMP & Audio Jack         |                               |                |
| Size                     | Document Number               | Rev            |
|                          | LA-1811                       | 1.0            |
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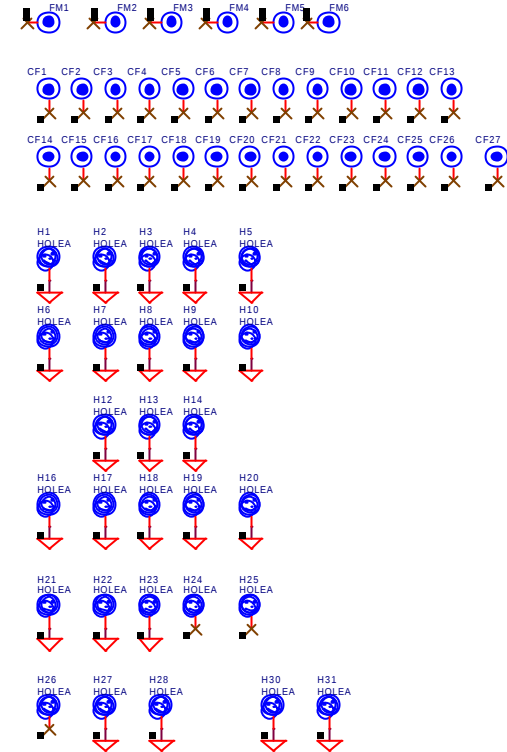


# SPR 36 PIN For X7

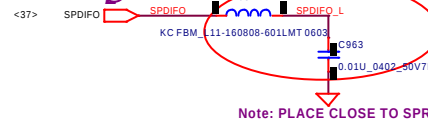


EMI Clip PAD

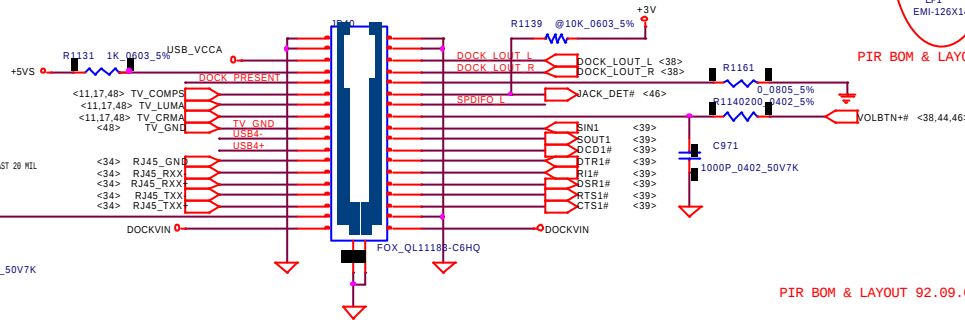
PIR BOM & LAYOUT 92.09.01



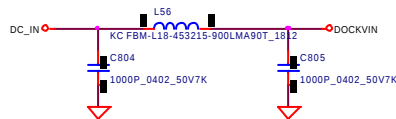
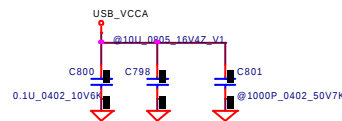
PIR BOM & LAYOUT 92.09.01



Note: PLACE CLOSE TO SPR PORT (JP40)



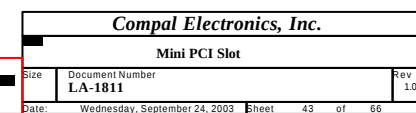
Note: PLACE CLOSE TO SPR PORT (JP40)

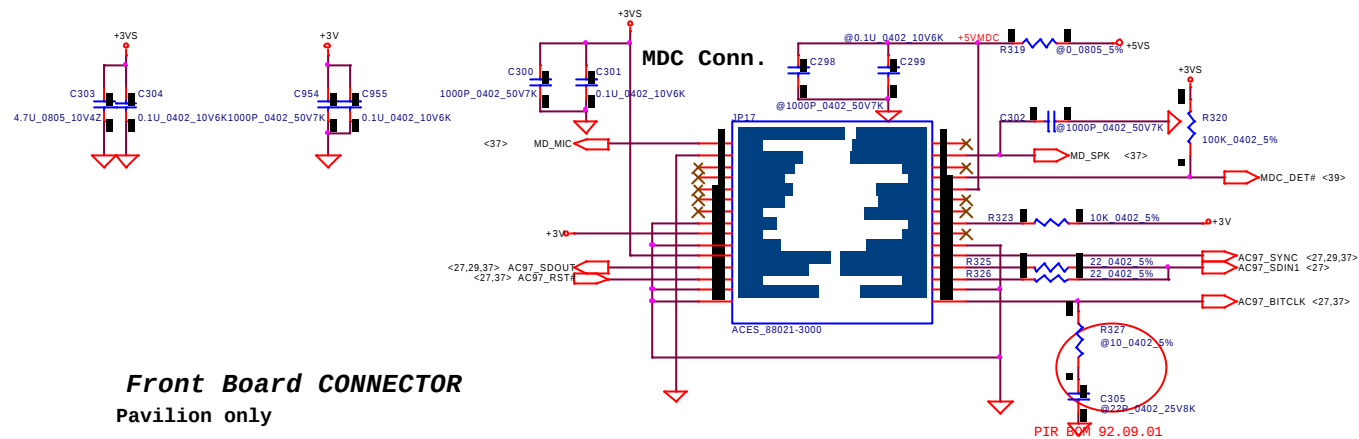


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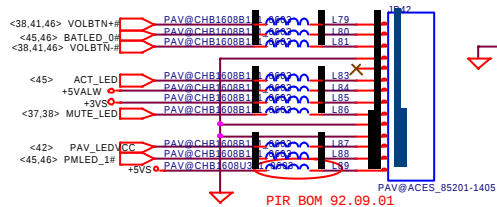
| Compal Electronics, Inc. |                               |       |          |
|--------------------------|-------------------------------|-------|----------|
| SPR Connector            |                               |       |          |
| Size                     | Document Number               | Rev   |          |
|                          | LA-1811                       | 1.0   |          |
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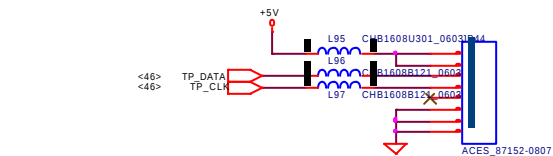
**Front Board CONNECTOR**  
Pavilion only



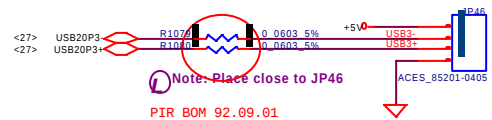
**Front Board CONNECTOR**  
PRESARIO only



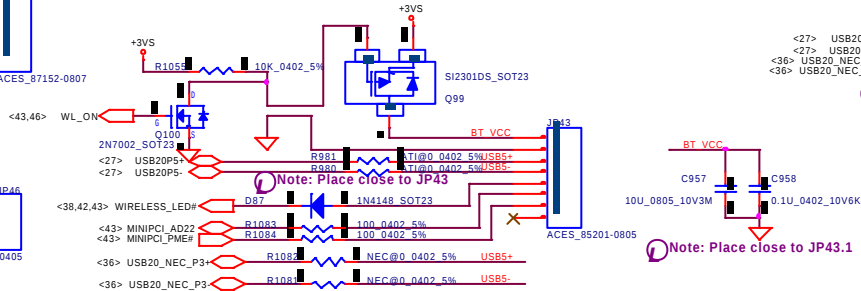
**TP CONNECTOR**



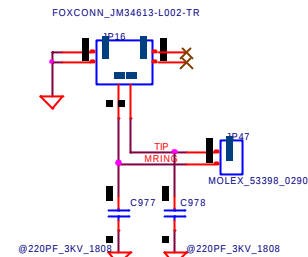
**USB KEY**



**BT CONNECTOR**



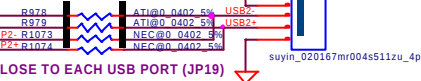
**RJ11 CONN.**



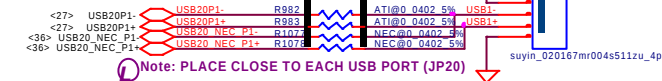
**RIGHT USB CONNECTOR 0**



**LEFT USB CONNECTOR 2**



**LEFT USB CONNECTOR 1**

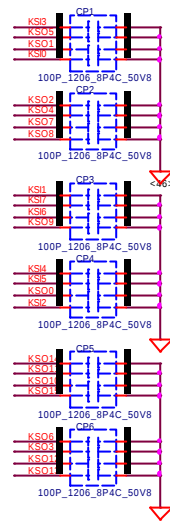
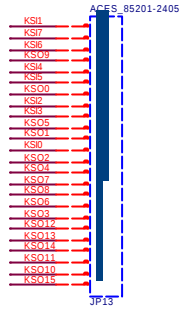


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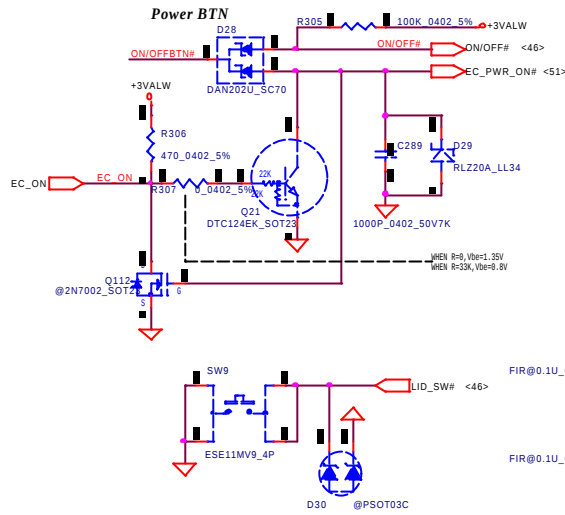
| Compal Electronics, Inc.    |                               |         |          |
|-----------------------------|-------------------------------|---------|----------|
| MDC , Bluetooth & USB CONN. |                               |         |          |
| Size                        | Document Number               | LA-1811 |          |
| Date:                       | Wednesday, September 24, 2003 | Sheet   | 44 of 66 |

# INT\_KBD CONN.

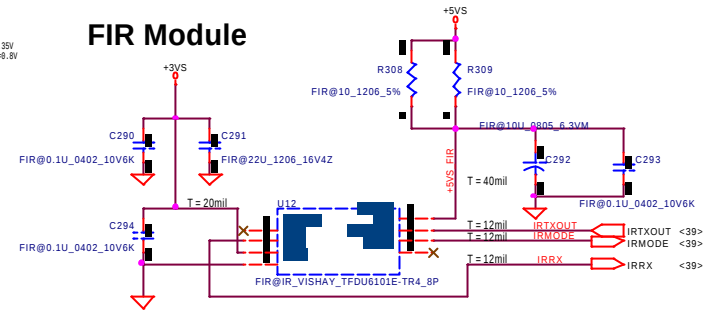
KS1[0..7] <42,46>  
KS0[0..15] <46>



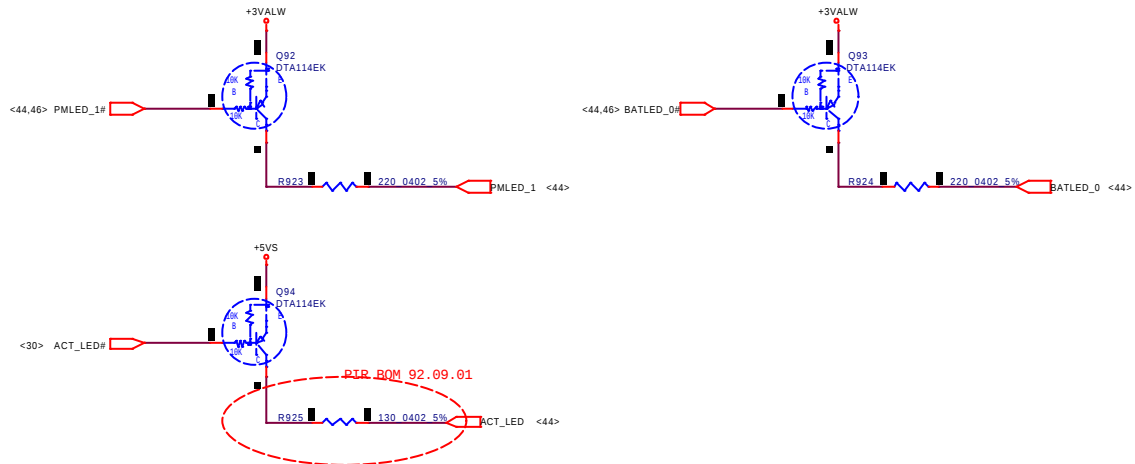
## Power BTN



## FIR Module



## Touch Pad & Status LED Conn.



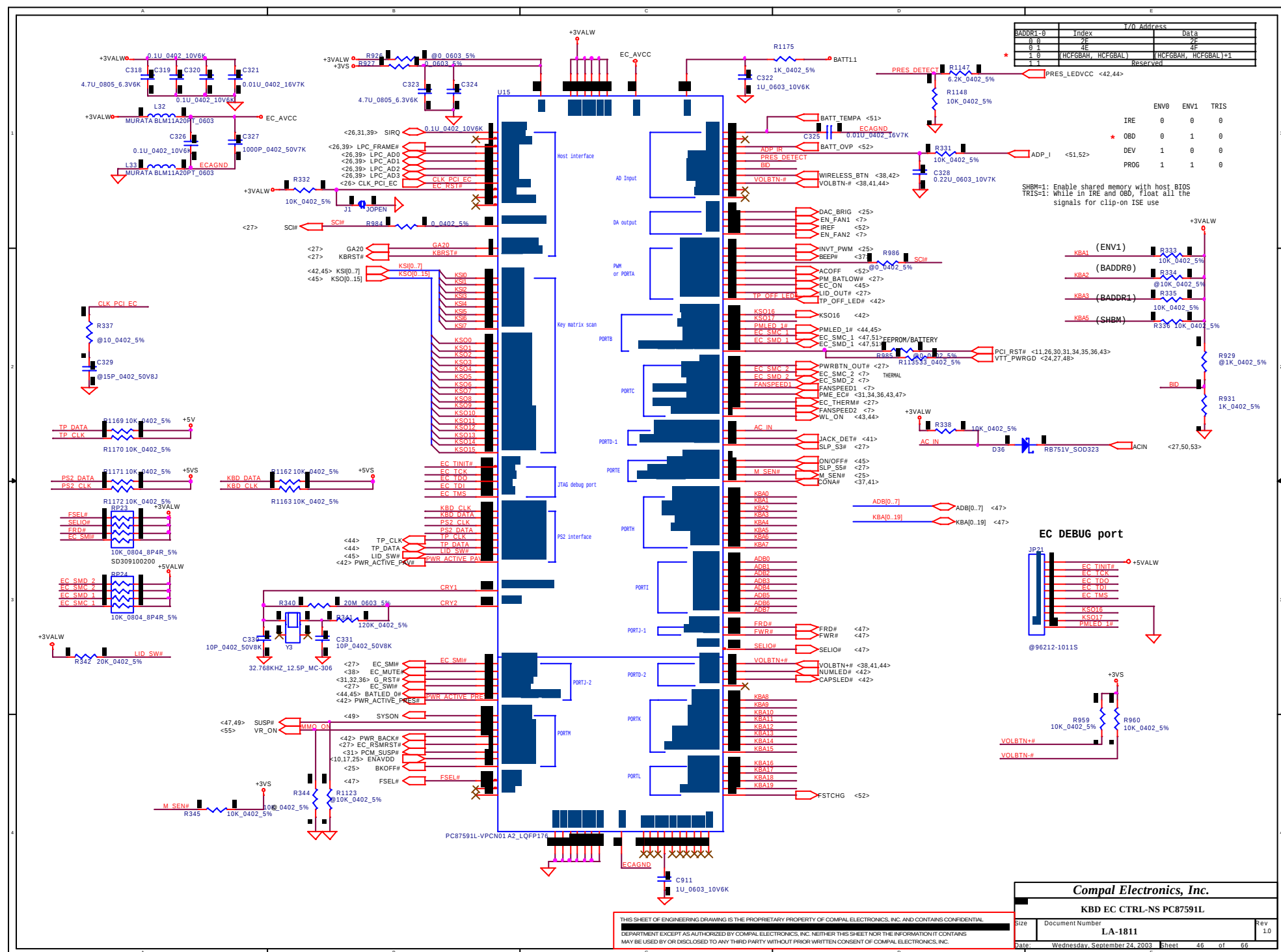
Compal Electronics, Inc.

KBD,ON/OFF,T/P,LED & FIR

LA-1811

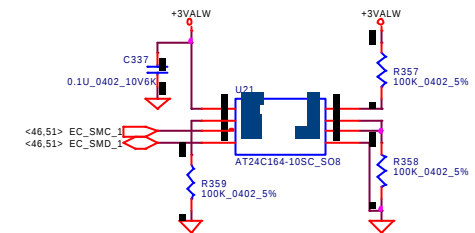
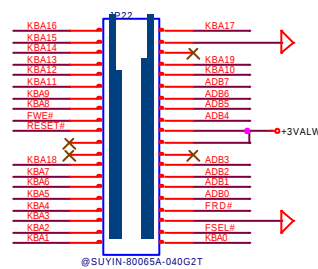
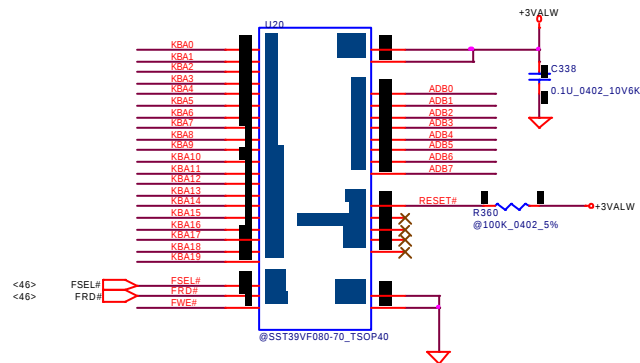
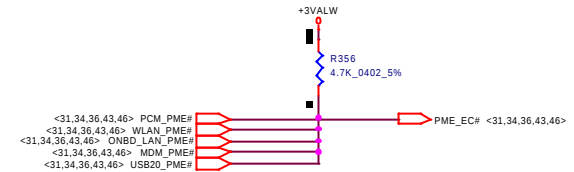
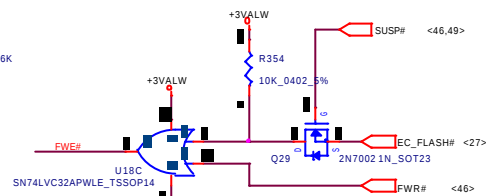
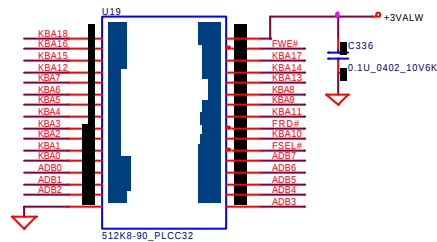
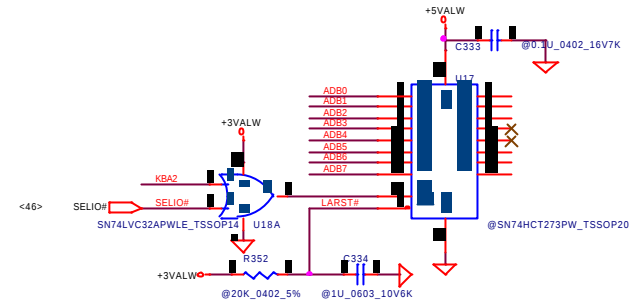
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Date Wednesday, September 24, 2003 Sheet 45 of 66

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<46> ADB[0..7] ADB[0..7]  
<46> KBA[0..19] KBA[0..19]

## OUTPUT

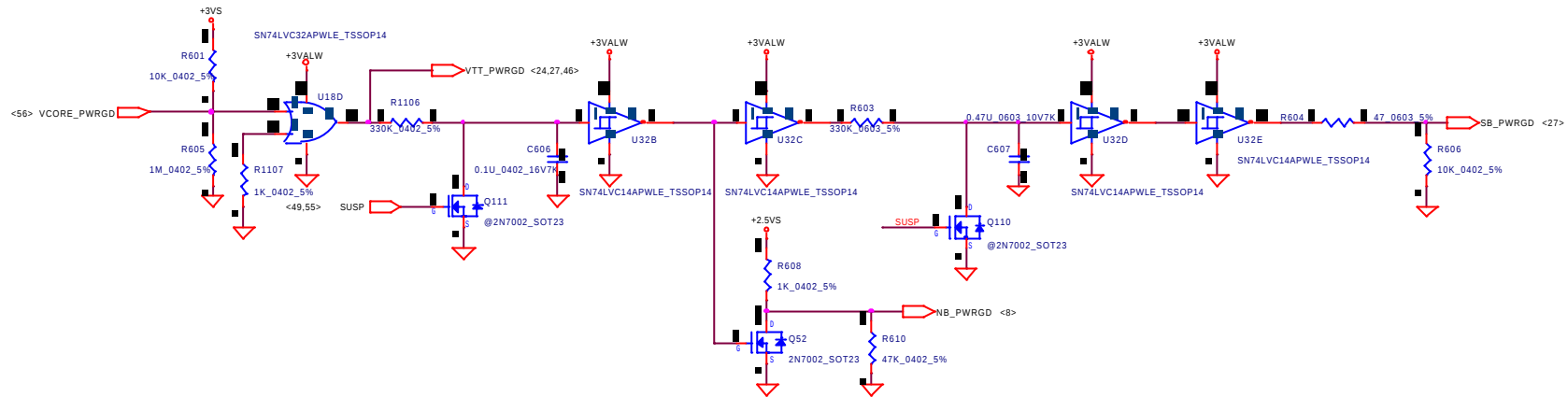


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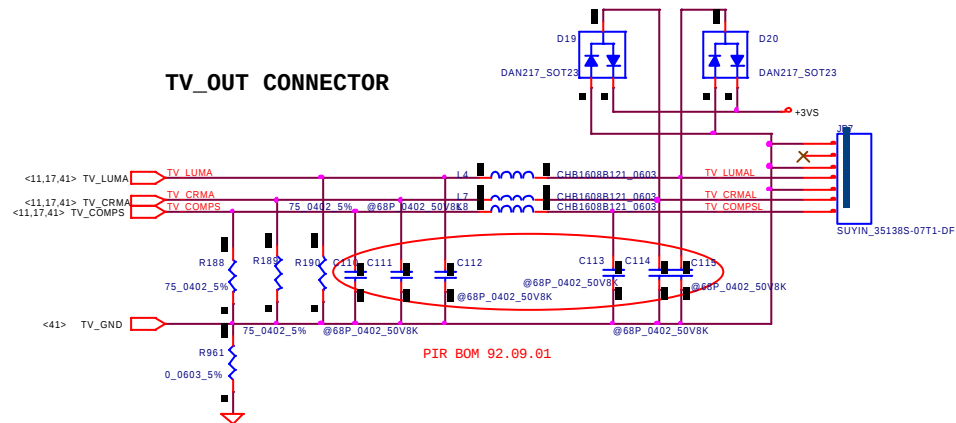
BIOS & EC I/O Port

|       |                               |                |
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|       | LA-1811                       | 1.0            |
| Date: | Wednesday, September 24, 2003 | Sheet 47 of 66 |

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## TV\_OUT CONNECTOR



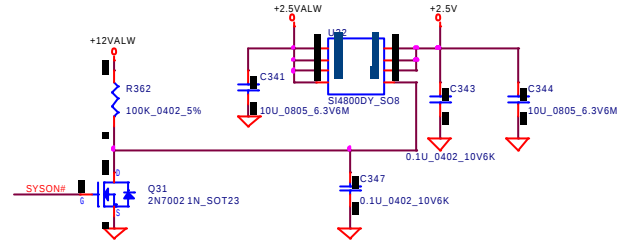
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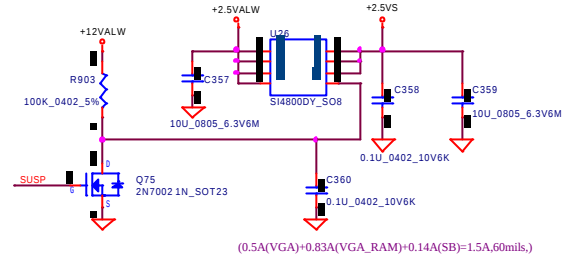
POWER GOOD & P/S2 CKT

|       |                               |                |
|-------|-------------------------------|----------------|
| Size  | Document Number               | Rev            |
|       | LA-1811                       | 1.0            |
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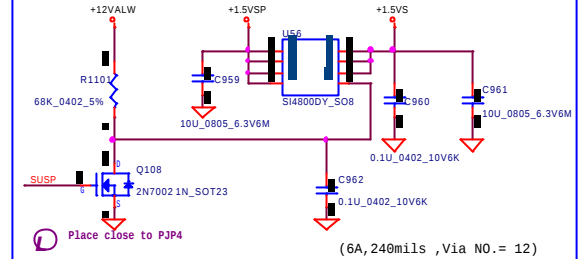
### +2.5VALW to +2.5V Transfer



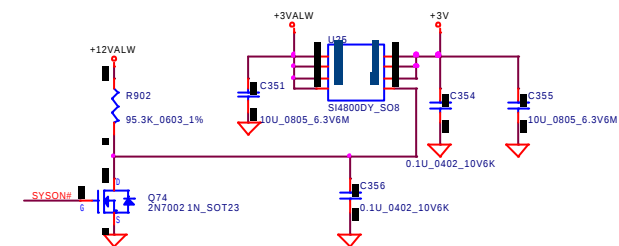
### +2.5V to +2.5VS Transfer



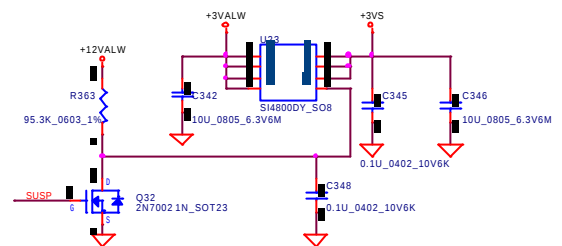
### +1.5VSP to +1.5VS Transfer



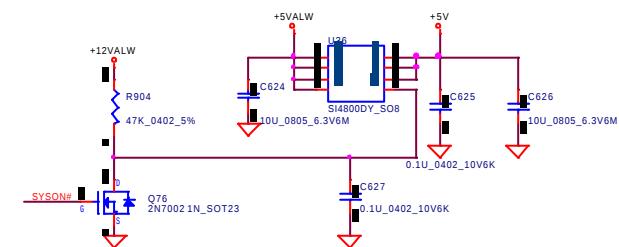
### +3VALW to +3V Transfer



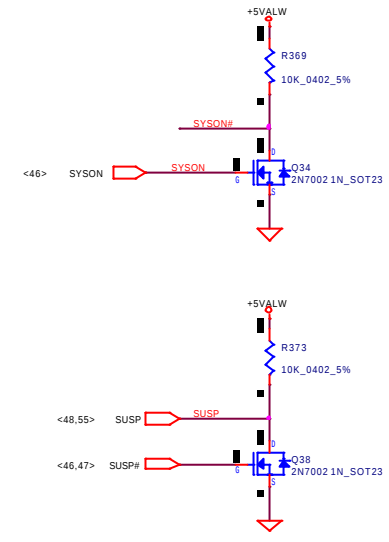
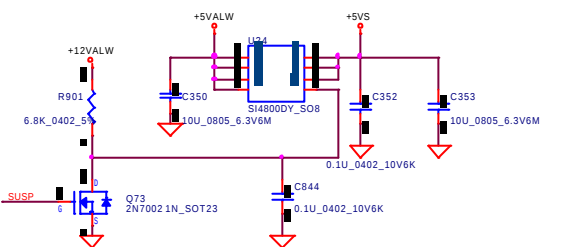
### +3VALW to +3VS Transfer



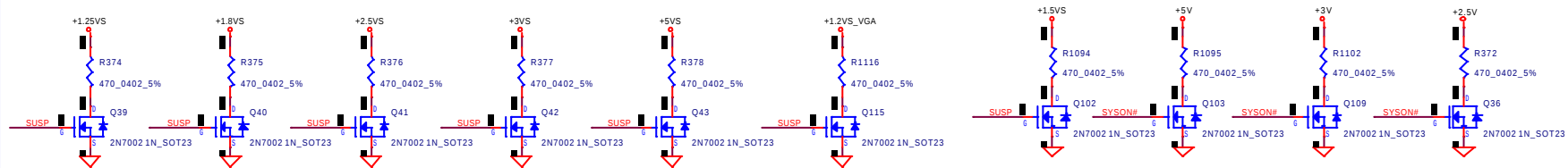
### +5VALW to +5V Transfer



### +5VALW to +5VS Transfer



### Discharge circuit

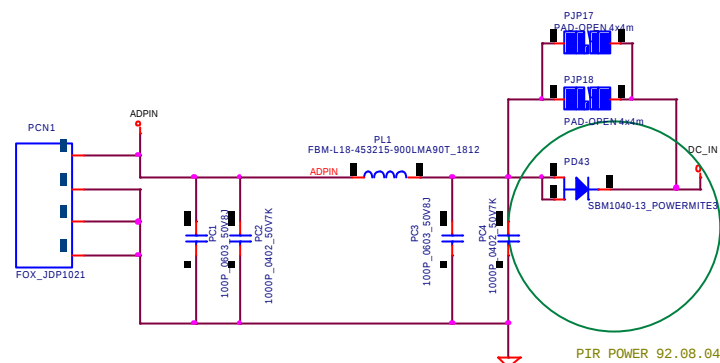


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DC/DC Circuits

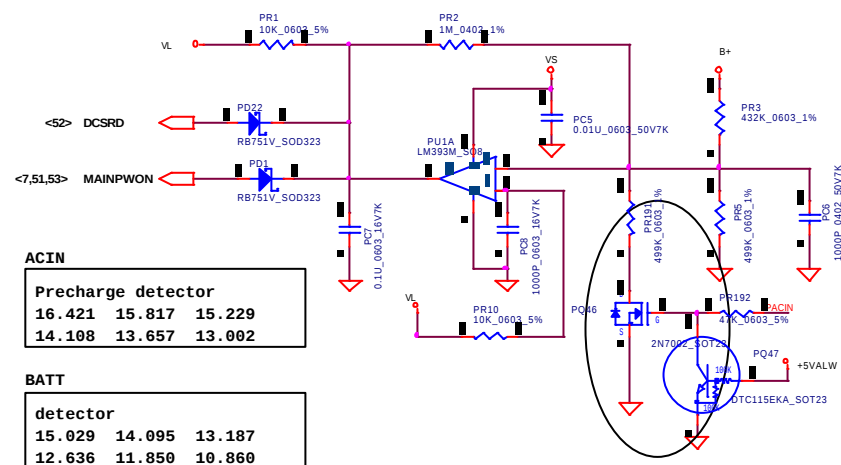
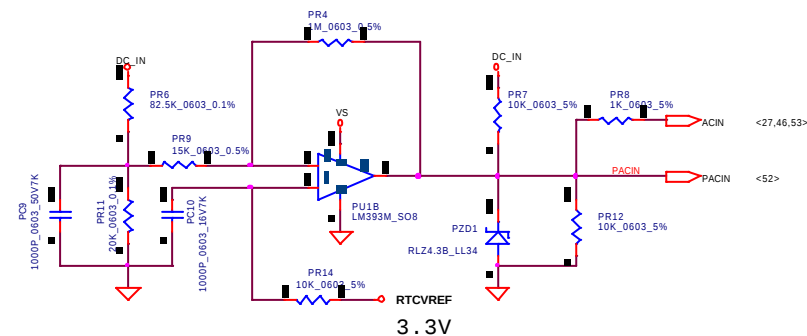
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## Vin Detector

|        |        |        |
|--------|--------|--------|
| 17.788 | 17.438 | 17.090 |
| 17.277 | 16.928 | 16.585 |

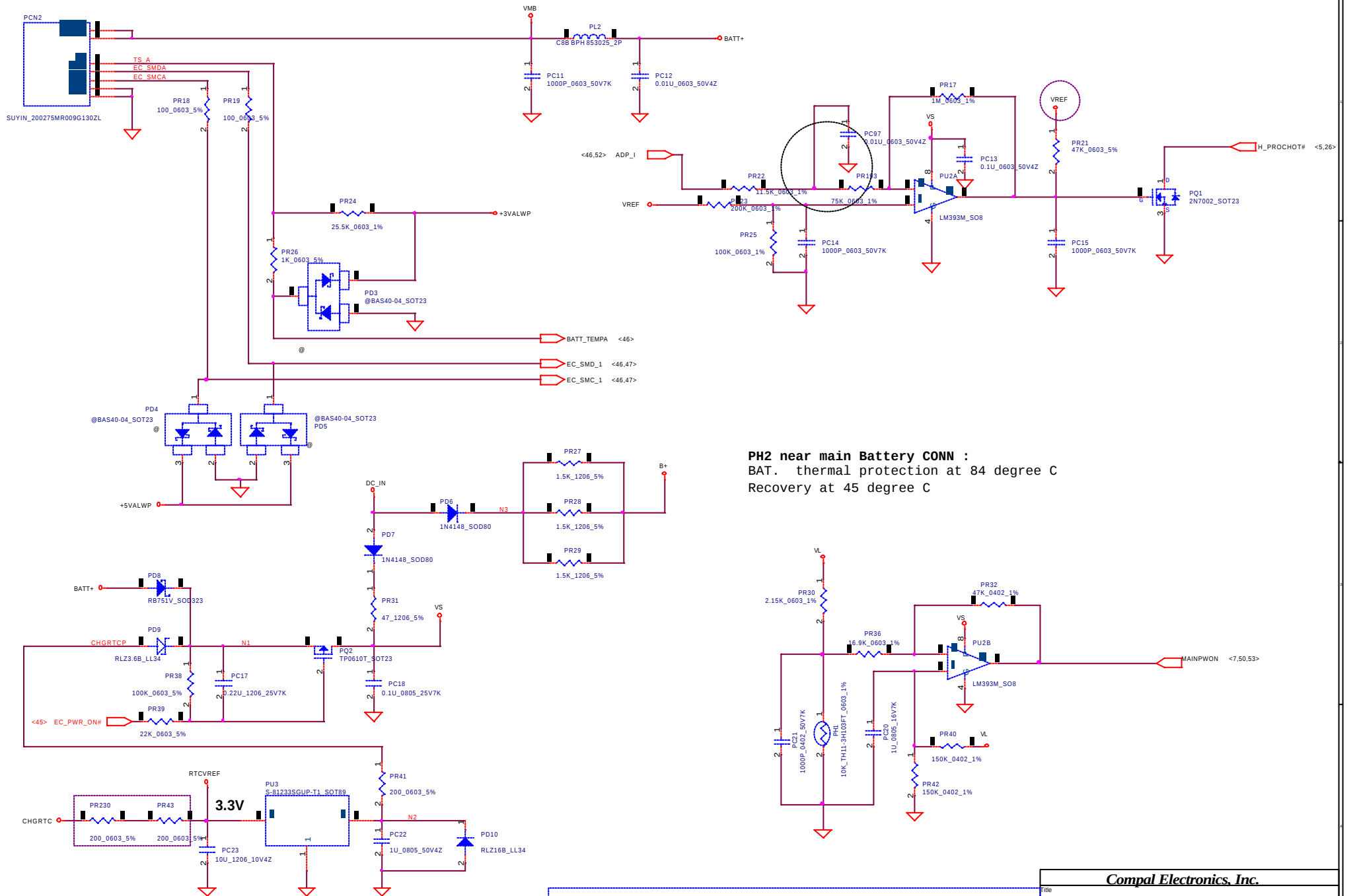


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Detector

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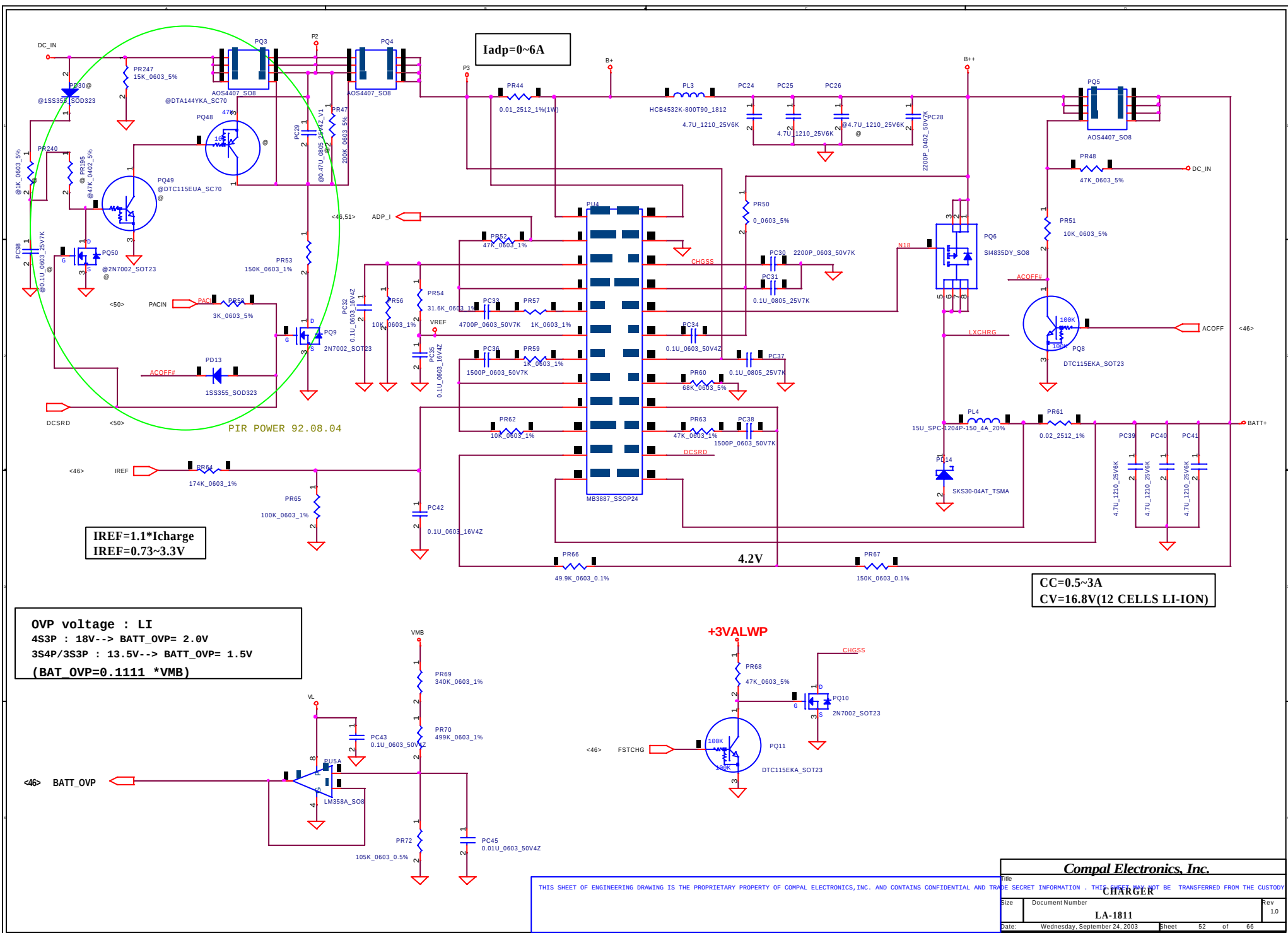
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| Size | Document Number               | Rev            |
|      |                               | 1.0            |
| Date | Wednesday, September 24, 2003 | Sheet 50 of 66 |

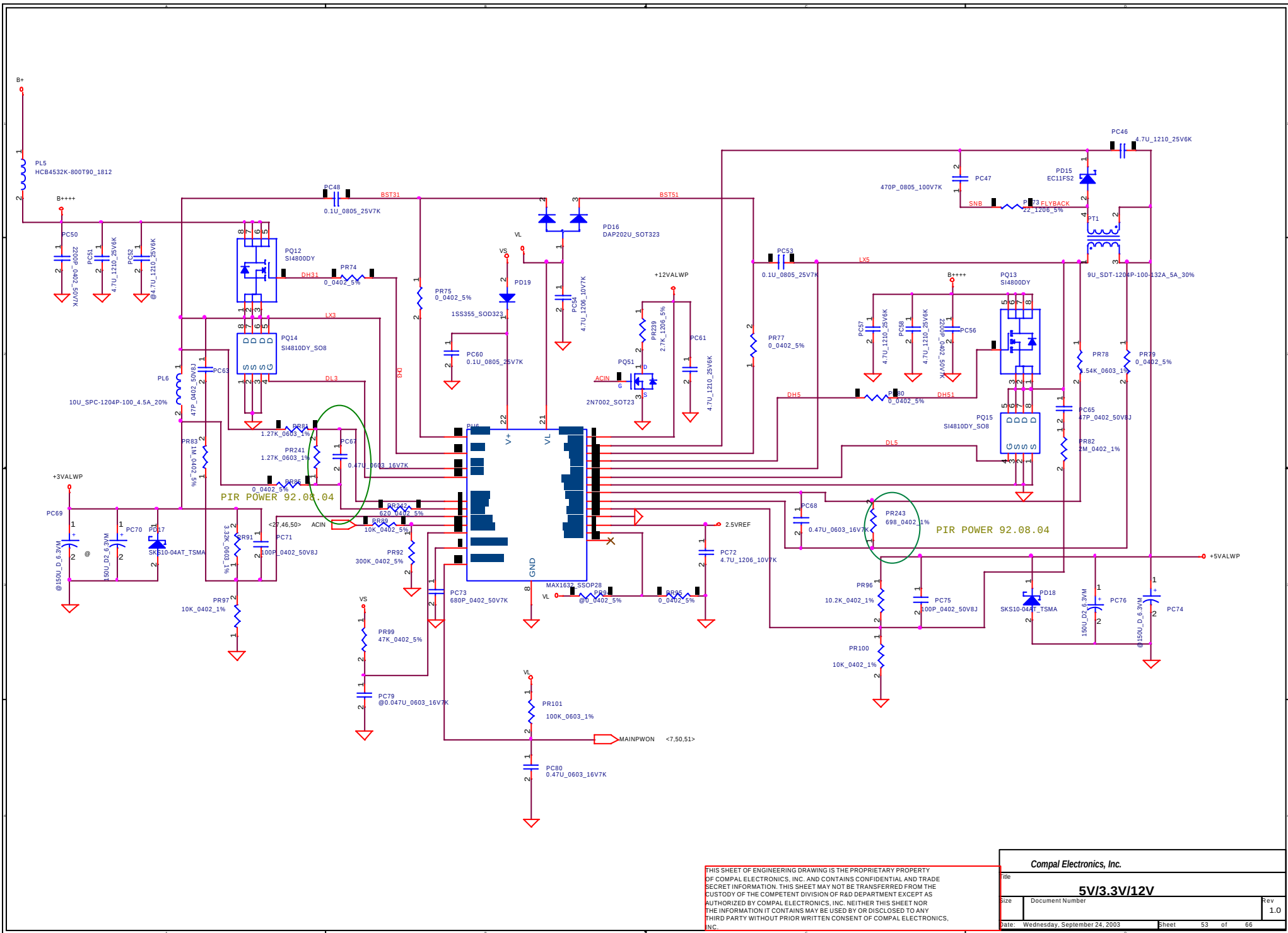


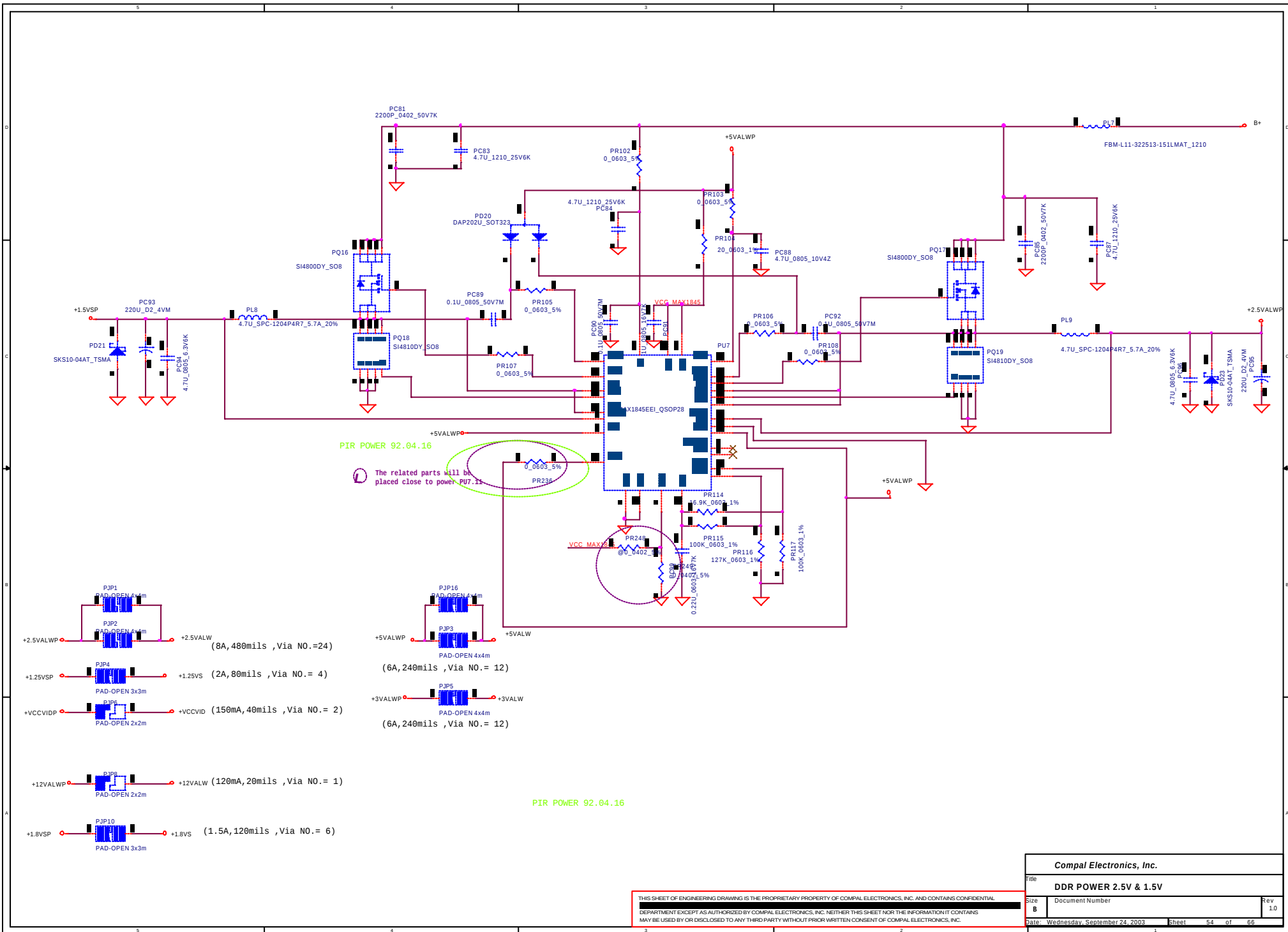
PH2 near main Battery CONN :  
BAT. thermal protection at 84 degree C  
Recovery at 45 degree C

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| Title                    |                               | BATTERY CONN / OTP |         |
| Size                     | Document Number               | LA-1811            | Rev 1.0 |
| Date                     | Wednesday, September 24, 2003 | Sheet 51           | of 66   |



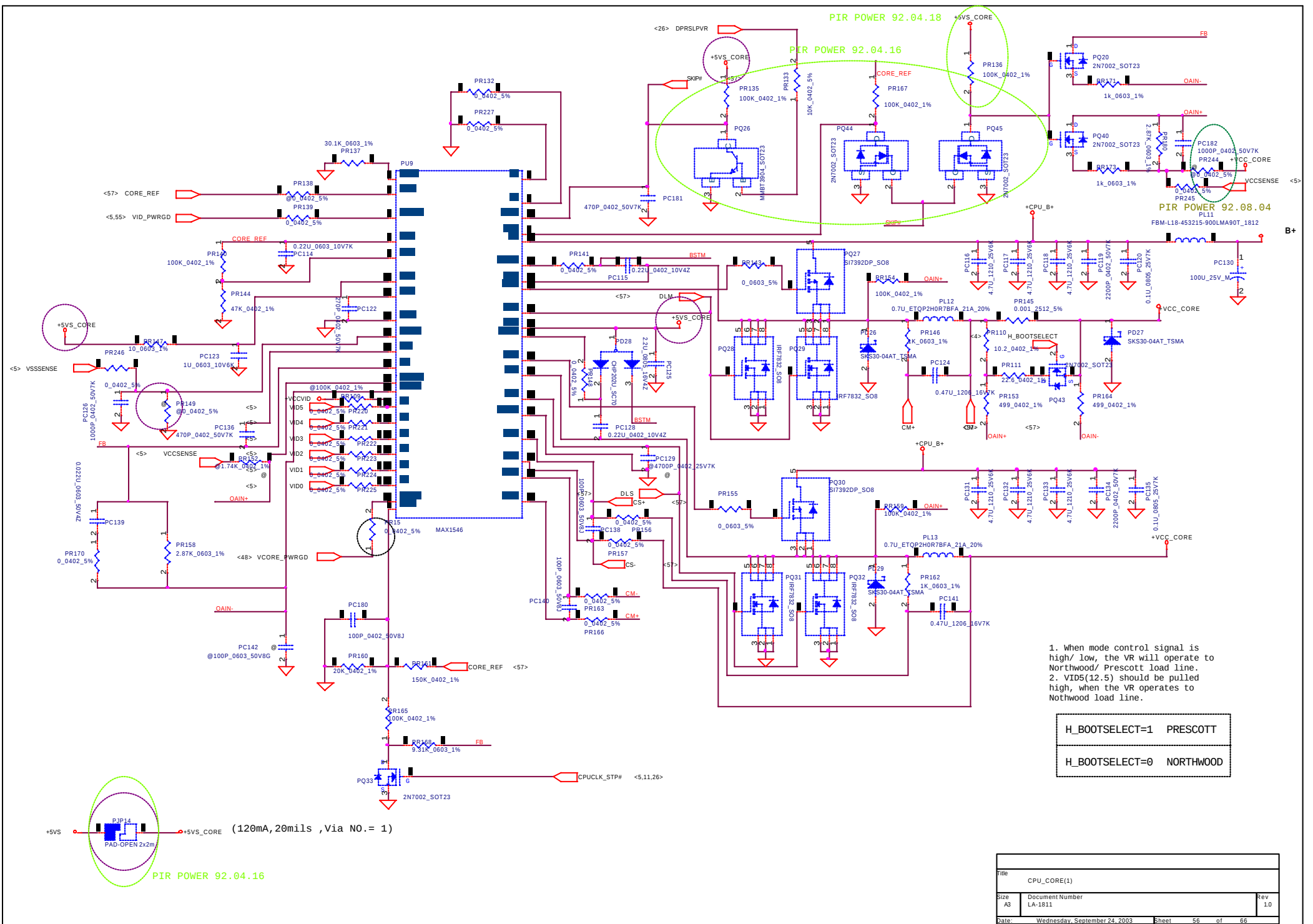


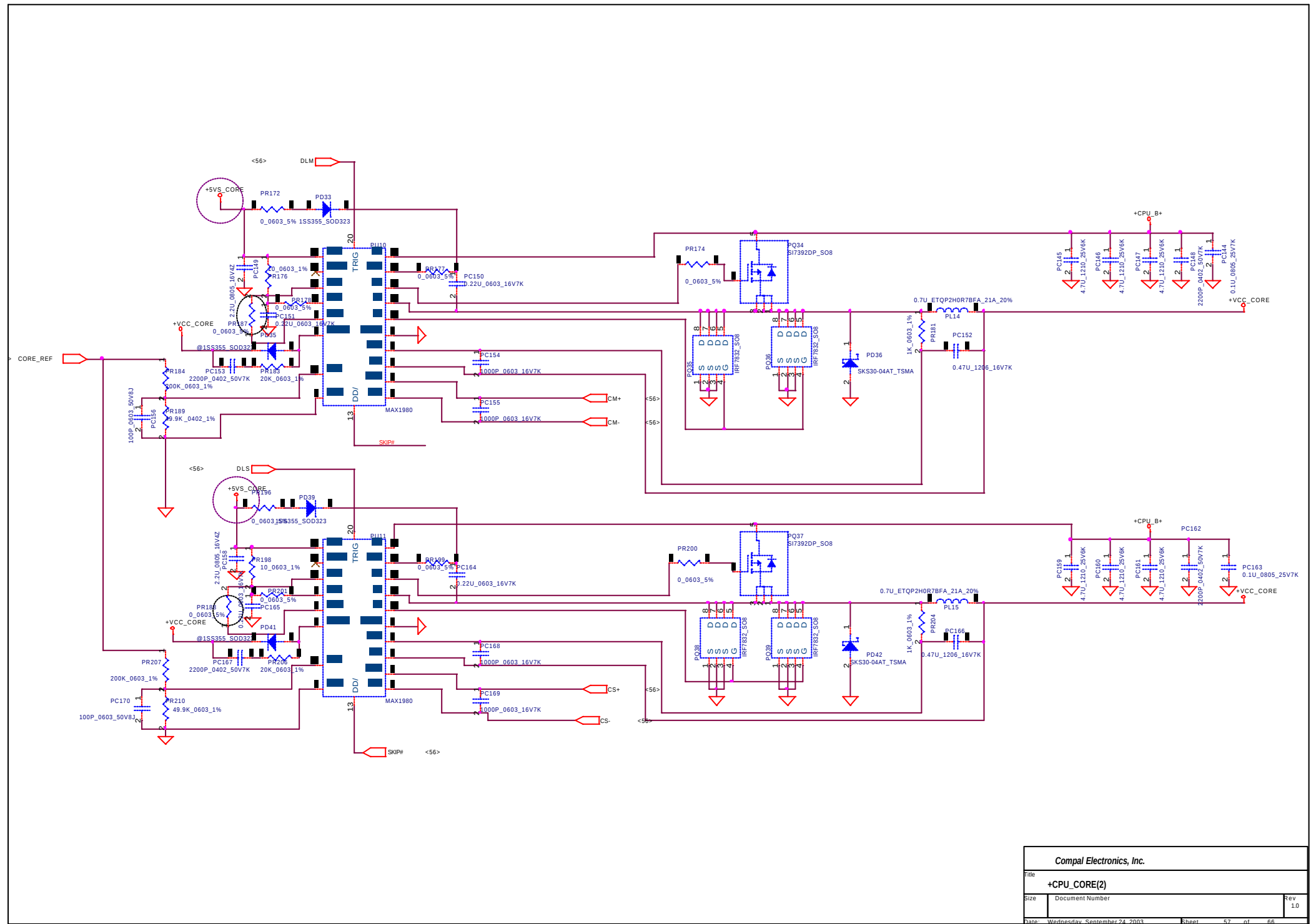


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|                               |  |  |
|-------------------------------|--|--|
| Compal Electronics, Inc.      |  |  |
| Title                         |  |  |
| DDR POWER 2.5V & 1.5V         |  |  |
| Size                          |  |  |
| B Document Number             |  |  |
| Date                          |  |  |
| Wednesday, September 24, 2003 |  |  |
| Sheet                         |  |  |
| 54 of 66                      |  |  |
| Rev                           |  |  |
| 1.0                           |  |  |







### Version Change List ( P. I. R. List ) for Power Circuit

[illegible]

**BHR60 from DB-1 to DB-2 STEP LA-1811 REV:0.1 -> 0.2 Modify <92.03.17.~92.03.24. >**

**1.Add an independent power source for VGA chip because of ATI request . <Page 12> 92.03.17.**

-Add U53(SI9185),C913,R1023,C912,C914 and related net . (Modify CKT,BOM&Layout)

**2.Modify the Audio related schematic for Customer request . <Page 37> 92.03.17.**

-Add Q101(2N7002);Del R948(2.2K\_0402\_5%);Modify R746(2.2K\_0402\_5%) . (Modify CKT,BOM&Layout)

**3.Change the USB2.0 Controller chip from ATI to NEC and modify the net for Customer request . <Page 26,27,36,44> 92.03.18.**

-Add U54(NEC\_uPD720101F1-EA8),R1024~R1047,R1049,R1051,R1053,R1054,C915~C929, U55(AT24C02),RP147,RP148,R102,R1059,R1062;Del RP127 . (Modify CKT,BOM&Layout)

-Add R1048,R1050,R1052 . (Modify CKT&Layout)

**4.Modify the Audio related schematic for Customer request . <Page 37,38> 92.03.20.**

-Add R1063(39K\_0603\_1%);Del R768(0\_1206\_5%) . (Modify CKT,BOM&Layout)

-Change C894,C896 from 1U\_0603\_10V6K to 0.1U\_0603\_16V7K . (Modify CKT&BOM)

-Change R974 from @100K\_0402\_5% to 100K\_0402\_5% . (Modify CKT&BOM)

-Change R972 from 100K\_0402\_5% to @100K\_0402\_5% . (Modify CKT&BOM)

-Change JP41.3 from GND A to +5VAMP . (Modify CKT&Layout)

**5.Modify the MiniPCI and BlueTooth conn related schematic for Customer request . <Page 43,44> 92.03.21.**

-Add R1083,R1084,R1085(@0\_0402\_5%) . (Modify CKT&Layout)

-Change R300 from 100\_0402\_5% to @100\_0402\_5% . (Modify CKT&BOM)

**6.Modify the USB2.0 related for Compal ATI/NEC Dual Layout request . <Page 27,44> 92.03.21.**

-Add R1069,R1070,R1072,R1073,R1074,R1076,R1077,R1078,R1092,R1093(NEC@0\_0402\_5%) . (Modify CKT,BOM&Layout)

-Change R976,R977,R978,R979,R982,R983 from 0\_0402\_5% to ATI@0\_0402\_5% and the net . (Modify CKT,BOM&Layout)

-Add R1071,R1075,R1090,R1091(ATI@0\_0402\_5%) . (Modify CKT&Layout)

**7.Add De-coupling capacitor for AGP power pins on RC300M and VGA chip because of ATI request . <Page 10> 92.03.21.**

-Add C937~C946,C862,C863,C865~C871(0.1U\_0402\_10V6K) . (Modify CKT,BOM&Layout)

**8. Reserve the SMBus1/2 swap Resistors for ATI request . <Page 27> 92.03.23.**

-Add RP150(0\_0404\_4P2R\_5%) . (Modify CKT,BOM&Layout)

-Add RP149(@0\_0404\_4P2R\_5%) . (Modify CKT&Layout)

**9. Add the power source +5V and +1.5VS discharge circuit for ATI request . <Page 49> 92.03.23.**

-Add R1094,R1095(470\_0402\_5%),Q102,Q103(2N7002 1N\_SOT23) . (Modify CKT,BOM&Layout)

**10. Modify the ON1 related to speed up the power sequence for ATI request . <Page 48,54> 92.03.23.**

-Add R1096,R1097(10K\_0402\_5%),Q1043(2N7002 1N\_SOT23),Q105(DTC124EK\_SC59); Del PR113(47K),PC183(0.1U) . (Modify CKT,BOM&Layout)

**11. Modify power source CAP.'s value by Brian . <Page 26,49> 92.03.24.**

-Change C347,C360 from 0.1U\_0402\_10V6K to 3900P\_0402\_50V7K;C356,C348 from 0.01U\_0402\_16V7K to 2200P\_0402\_25V7K . (Modify CKT&BOM)

-Add C956(180P\_0603\_50V8J) . (Modify CKT,BOM&Layout)

**12. Del Via Hole on schematic for ME modify . <Page 41> 92.03.24.**

-Del H15(H\_C374D295),H29(H\_C197D91) . (Modify CKT,BOM&Layout)

**13.Modify the MiniPCI and BlueTooth conn related for Customer request . <Page 43,44> 92.03.24.**

-Change R1083,R1084 from @0\_0402\_5% to 100\_0402\_5% . (Modify CKT&BOM)

-Add C957(10U\_0805\_10V3M),C958(0.1U\_0402\_10V6K) . (Modify CKT,BOM&Layout)

**14.Swap the USB20\*P3\* and USB20\*P5\* for Customer request . <Page 44> 92.03.24.**

-Modify R1079~R1082,JP43,R980,R981's connection . (Modify CKT&Layout)

**15.Modify the schematic after rev0.1 debug by Brian . <Page 12,17,26,29> 92.03.24.**

-Change R1010 from @0\_0603\_5% to 0\_0603\_5%;R1011 from 0\_0603\_5% to @0\_0603\_5%; Q15 from 2SC2411K\_SOT23 to @2SC2411K\_SOT23;R145 from 4.7K\_0402\_5% to @4.7K\_0402\_5%; R146 from @4.7K\_0402\_5% to 4.7K\_0402\_5%;R967 from @10K\_0402\_5% to 10K\_0402\_5%; R833 from @0\_0402\_5% to 0\_0402\_5% . (Modify CKT&BOM)

**16.Modify the schematic H\_BOOTSELECT related by Power Team . <Page 04> 92.03.25.**

-Add Q106(2SC2411K\_SC59),Q107(MMBT3904\_SOT23),R1099,R1100(47K\_0402\_5%) . (Modify CKT,BOM&Layout)

-Change R899 from 0\_0402\_5% to 22K\_0402\_5%;R900 from @0\_0402\_5% to 100K\_0402\_5% . (Modify CKT&BOM)

**17.Add a power transfer circuit to fix +1.5VS leakage issue . <Page 49> 92.03.25.**

-Add U56(SI4800DY\_SO8),Q108(2N7002 1N\_SOT23),R1101(100K\_0402\_5%),C960(0.1U\_0402\_10V6K), C961(10U\_1206\_6.3V6M),C962(3900P\_0402\_50V7K) . (Modify CKT,BOM&Layout)

**18. Modify power source Resistor and CAP.'s value for power sequence . <Page 49> 92.03.26.**

-Change C347,C360,C962 from 3900P\_0402\_50V7K to 0.1U\_0402\_10V6K;C356,C348 from 2200P\_0402\_25V7K to 0.1U\_0402\_10V6K;C627,C844 from 1000P\_0402\_50V7K to 0.1U\_0402\_10V6K . (Modify CKT&BOM)

-Change R903,R362 from 100K\_0402\_5% to 91K\_0402\_5% . (Modify CKT&BOM)

-Change R902,R363 from 100K\_0402\_5% to 95.3K\_0603\_1% . (Modify CKT,BOM&Layout)

**19. Modify the ON1 related to speed up the power sequence for ATI request by Brian/James/CT . <Page 48,54> 92.03.26.**

-Del R1096,R1097(10K\_0402\_5%),Q1043(2N7002 1N\_SOT23),Q105(DTC124EK\_SC59) . (Modify CKT,BOM&Layout)

**20. Add the power source +3VS discharge circuit by Brian . <Page 49> 92.03.26.**

-Change Q42 from @2N7002 1N\_SOT23 to 2N7002 1N\_SOT23 . (Modify CKT&BOM)

**21. Change the Resistor's value for ATI recommend . <Page 17 > 92.03.26.**

-Change R264 from 169\_0603\_1% to 2N7002 1N\_SOT23 . (Modify CKT&BOM)

**22. Correct material layout footprint and pin define . <Page 26,34 > 92.03.26.**

-Change Y1,Y3 PCB Footprint and JP32 pin define . (Modify CKT&Layout)

**23. Add the power source +3V discharge circuit for ATI request . <Page 49> 92.03.27.**

-Add R1102(470\_0402\_5%),Q109(2N7002 1N\_SOT23) . (Modify CKT,BOM&Layout)

**24. Change the power sequence related part's power source by Brian . <Page 5,37,48> 92.03.27.**

-Change U32's power source from +3VS to +3VALW . (Modify CKT&Layout)

**25. Modify the power sequence related schematic for timing by Brian . <Page 48> 92.03.27.**

-Change R605 from 1M\_0402\_5% to @1M\_0402\_5%;C606 from 1U\_0603\_10V6K to @1U\_0603\_10V6K . (Modify CKT&BOM)

-Add Q110(2N7002\_SOT23) . (Modify CKT,BOM&Layout)

**26. Modify the SPDIF related schematic for Customer request . <Page 37,41> 92.03.28.**

-Add R1103(0\_0402\_5%),C963(0.01U\_0402\_50V7K) . (Modify CKT,BOM&Layout)

**27. Modify the NEC USB2.0 Controller Chip related schematic for Customer request . <Page 36> 92.03.28.**

-Add Y7(30MHZ\_30PPM),R1105(100\_0402\_5%),C964(12P\_0402\_50V8J),C965(10P\_0402\_50V8K) . (Modify CKT,BOM&Layout)

-Add R1104(@0\_0402\_5%) . (Modify CKT&Layout)

-Change R1024 from 0\_0402\_5% to @0\_0402\_5% . (Modify CKT&BOM)

**28. Update the material's Layout Footprint for error correction . <Page 36> 92.03.28.**

-Update JP29,JP14,SW1,SW3~SW8,JP40,Q65 . (Modify CKT&Layout)

**29. Modify the related schematic after Brian Review <Page 7,24,26,29,30,39,43,45> 92.03.31.**

-Del R288(56\_0402\_5%) . (Modify CKT,BOM&Layout)

**30. Modify the related schematic after Layout check <Page 44> 92.03.31.**

-Modify JP16(RJ11 Conn.),5 and JP16.6 from GND to NC . (Modify CKT&Layout)

**31. Update the material's Layout Footprint for error correction . <Page 41> 92.04.02.**

-Update JP40 . (Modify CKT&Layout)

**32. Modify the schematic for cost down . <Page 10,12,26,37> 92.04.04.**

-Change to @(R1005,D79~D82,U53,C912,C913,R1023,Q98,R769,R771.) . (Modify CKT&BOM)

---PLEASE SEE NEXT PAGE

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H/W2 EE Dept. PIR SHEET(1)

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**BHR60 from DB-2 to SI-1 STEP LA-1811 REV:0.3 -> 0.4 EE Modify**

<92.04.08.~92.04.18.>

**1. J33 Connector JP33 Pin define sequence error. <Page 35> 92.04.08.**

-Change JP33 sequence JP33.4->JP33.1, JP33.3->JP33.2, JP33.2->JP33.3, JP33.1->JP33.4. (Modify EE Circuit)

**2.LED Circuit to Power Button(PRES)modify . <Page 42, Page 46> 92.04.09.**

-Move Q66.1-R883-D56 -> Q62.1-R883-D56(PRES). (Modify EE Circuit)  
-Rename Q62.2 net PWR\_BACK# change to PWR\_ACTIVE# connect to EC U15.119. (Modify EE Circuit)

**3.Add +1.2VS\_VGA Discharge Circuit. <Page 49> 92.04.09.**

-Add +1.2VS\_VGA Discharge Circuit(R1116 , Q115 to SUSP). (Modify EE Circuit)

**4.Add 3VDDCDA & 3VDDCCL pull hing CRT\_VCC circuit. <Page 25> 92.04.09.**

-Add Q13.1-R1117 to +CRT\_VCC & Q14.1-R1118 to CRT\_VCC. (Modify EE Circuit)

**5.PCMCIA U37 NET S1\_CE2# & S1\_CE1# Sweep. <Page 31> 92.04.09.**

**6. MDC(JP17) Net AC97\_SData\_In1/AC97\_SData\_In2 to AC97\_Data\_In. <Page 44> 92.04.10.**

-Update BOM add R326. (Modify EE Circuit)

**7. Change NB DDR Bus Net for basic on AT1 NB DDR Bus Layout rule. <Page 9, 14, 15, 16> 92.04.11.**

-Add R1122(DDRA\_CKE\_R3), R1121(DDRA\_CKE\_R2). (Modify EE Circuit)  
-Del R399(DDRA\_CS#0), R400(DDRA\_CS#2). (Modify EE Circuit)

**8. Check BOM USB OUVUR R893&R895 470K change to 330K. <Page 44> 92.04.12.**

**9. Add SUSP# pull Down. <Page 46> 92.04.14.**

-Add EC U15.115 to SUSP# pull Down @R1123 to GND. (Modify EE Circuit)

**10. Add CPUCLK\_STP# pull High Circuit. <Page 26, 5> 92.04.14.**

-BOM Q113 -> @ , Add R1124 to Q113.1 & Q113.3. (Modify EE Circuit)  
-Add CPUCLK\_STP# pull High @R1126 to +3VS . (Modify EE Circuit)  
-Add CPUCLK\_STP# serial resistor R1125 to Q96.2. (Modify EE Circuit)

**11. Change BOM R585 75 -> 0 & R996 33 -> 68(REFCLK1\_NB). <Page 11, 24> 92.04.15.**

**12. SIO Circuit All Power Plan +3V -> +3VS. <Page 39> 92.04.15.**

**13. Add NEC USB Corstralor U54.P19(SRMOD) pull Low. <Page 36> 92.04.16.**

-Add USB Constralor U54.P19(SRMOD) pull Low R1127 to GND. (Modify EE Circuit)  
-Update BOM R1046 -> @. (Modify EE Circuit)

**14. Add @R1132 pull High +3V(RTS1#) & @RP153 pull High +3V(CTS1#/DSR1#/DCD1#/RI1#). <Page 39> 92.04.16.**

**15. Change BOM C364, C23, C24, C40, C798 47U -> 22U. <Page 8,28,41> 92.04.17.**

**16. Change BOM R380 430 -> 412(U27.A9/CPU\_RSET#). <Page 8> 92.04.17.**

**17. Change BOM D57 HSMG-C170 -> 12-21SYGC/S530-E1, R1014 @ -> Del @. <Page 42> 92.04.17.**

**18. Change BOM C191 4.7U -> 2.2U. <Page 17> 92.04.17.**

**19. Change BOM C202,C931 10U -> 2.2U. <Page 20> 92.04.17.**

**20. Change BOM R636 100K-> @10K, R637 100K-> @10K, R665 -> @. <Page 33> 92.04.17.**

**21. Change MC\_CD# - D44.3(SA\_A25) -> D45.2, D44.2(SA\_A22). <Page 33> 92.04.17.**

**22. Add R1135 -> VTT\_PWRGD(U15.165). <Page 46> 92.04.18.**

**23. Add R1136, Q116, R1137, R1138 for pull High +3VS(CARD\_LED#). <Page 42> 92.04.18.**

**24. Change BOM Q67 -> @, R884 -> @(CARD\_LED#). <Page 42> 92.04.18.**

**25. Change BOM C966 22U -> 0.1U. <Page 18> 92.04.18.**

**26. Change BOM C916 -> @, C917 -> @. <Page 36> 92.04.18.**

**27. Change BOM R1019 -> @(U47.17 JS1) pull High. <Page 37> 92.04.18.**

**28. Change BOM R264 47 -> 137(U6.PM27 AGPTTEST). <Page 17> 92.04.18.**

**BHR60 from DB-2 to SI-1 STEP LA-1811 REV:0.3 -> 0.4 Layout Modify**

<92.04.08.~92.04.18.>

**1.FDD Connector JP38 PCB Footprint error. <Page 40> 92.04.09.**

-Check JP38 ACES\_85201-2605\_26P. (Modify Layout)

**2.Power Switch U53 PCB Footprint error. <Page 12> 92.04.09.**

-Change U53 SI9185\_MLP33-8->MSOP8. (Modify Layout)

**3.Crystal Y4 PCB Footprint error. <Page 11> 92.04.09.**

-Change Y4 Y\_TXC\_6X1430004201\_20P->KDS\_DSX840GA. (Modify Layout)

**4.USB Key Connector JP46 Part error. <Page 44> 92.04.09.**

-Change JP46 S W-CONN ACES\_85205-0400\_4P P1.25(ACES\_85205-0400\_4P)->S H-CONN ACES\_85201-0405\_4P P1.0(ACES\_85201-0405\_4P). (Modify Layout)

**5. Change BOM & Layout LED D57 Footprint . <Page 42> 92.04.15.**

-Change D57 HSMG-C170 to LED\_12-21SYGC\_S530-E1\_TR8. (Modify Layout)

**6. Change Layout Keyboard Connector JP13 Footprint. <Page 45> 92.04.15.**

-Change JP13 ACES\_85201-2402\_24P -> ACES\_85201\_2405\_24P. (Modify Layout)

**7. Change Layout FrontSideboard Connector JP42 Footprint. <Page 44> 92.04.15.**

-Change JP42 ACES\_85201-1402\_14P -> ACES\_85201\_1405\_14P. (Modify Layout)

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BHR60 from DB-2 to SI-1 STEP LA-1811 REV:0.3 -> 0.4 EE Modify

<92.04.08.~92.04.18. >

29. Change U13.P1 <-> U13.P5, U14.P1 <-> U14.P5. <Page 43> 92.04.21.

30. Change R994.1 - AGP\_DEVSEL# -> AGP\_SBA1(DDC\_DAT), R995.1 AGP\_IRDY# -> AGP\_SBA0(DDC\_CLK). <Page 10> 92.04.21.

31. Add CLK\_14M\_APIC Terminte R,C @R1143 10/@C973 15P. <Page 26> 92.04.21.

32. Change SPR JP40 33,34 DOCKVIN -> GND , JP35,36 GND -> DOCKVIN, . <Page 41> 92.04.21.

33. Change BOM Q65 DTC124EK\_SC59 -> MMBT3904\_SOT23. <Page 41> 92.04.21.

34. Del @R1104, @R1089, @C953(CLK\_SB\_48M). <Page 36> 92.04.21.

35. Add @R1142 pull High(DOCK\_LOUT\_R). <Page 38> 92.04.21.

36. Add C971 & R1140 for VOLBTN+#, R1141 & C972 for VOLBTN-#, R1131 pull High +5VS, @R1139 pull High +3V. <Page 41> 92.04.21.

37. Add R520 @ -> Del @(JP8.AE26 COMPAT#). <Page 5> 92.04.23.

38. Change BOM R539, R540 61.9 -> 51.1 (JP8.L24/P1 COMP0/COMP1). <Page 5> 92.04.23.

39. Change BOM R553 100 -> 49.9, R558 169 -> 100. <Page 5> 92.04.23.

40. Change BOM R383 100 -> 49.9, R384 169 -> 100. <Page 8> 92.04.23.

41. Add R1001 @4.7K -> Del @, 100K pull Low(DPRSLPVR). <Page 26> 92.04.23.

42. Change BOM R40 @ -> Del @, R53 -> @. <Page 29> 92.04.23.

43. Change BOM R792 -> @, R795 @ -> Del @. <Page 39> 92.04.23.

44. Change BOM R230 -> @. <Page 4> 92.04.23.

45. EMI add R1144 for SSOUT. <Page 10> 92.04.24.

46. EMI change D73, D74, D75, D76 part. <Page 38> 92.04.24.

47. Add C974 pull Low for +NB\_AGP. <Page 17> 92.04.24.

48. Change BOM R623 10K -> 0. <Page 25> 92.04.28.

49. Change BOM R622, R619 10K ->@. <Page 25> 92.04.28.

BHR60 SI STEP LA-1811 REV:0.4 EE MEN <92.04.28. >

1. Change C781 SE077106M00 -> SE054106Z10. <Page 39> 92.04.28.

2. Change C963 -> @. <Page 41> 92.04.28.

3. Change C974 -> @. <Page 17> 92.04.28.

4. Change C742 -> (SD028000000) 0 Ohm. <Page 37> 92.04.28.

5. Add R771 -> (SD028470100) 4.7K Ohm. <Page 37> 92.04.28.

6. Add C747 -> (SE070104Z00) 0.1U. <Page 37> 92.04.28.

7. DEL R761,R762 <Page 37> 92.04.28.

BHR60 from DB-2 to SI-1 STEP LA-1811 REV:0.3 -> 0.4 Layout Modify

<92.04.08.~92.04.18. >

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BHR60 from SI-1 to DB(15.4") LA-1811 REV:0.4 -> 0.5 HW PIR  
<92.05.07.~92.05.30. >

| Item | Fixed Issue | Reason for change                                           | PAGE              | Modify List                                                                                                                                                                                                                                                                                                                                                                                                              | M.B. Ver.      |
|------|-------------|-------------------------------------------------------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
| 1    |             | Prevent CPUCLK_STP# abnormal state happened                 | 5<br>26<br>29     | Change R1125 from 4.7K to 12K<br>Delete R1126<br>Change R40 from 10K to 1K                                                                                                                                                                                                                                                                                                                                               | 0.5            |
| 2    |             | Prevent power leakage                                       | 7                 | Change the power of U8 from +3VS to +3VALW                                                                                                                                                                                                                                                                                                                                                                               | 0.5            |
| 3    |             | Power saving                                                | 7                 | Change the power of Fans from +5VALW to +5VS                                                                                                                                                                                                                                                                                                                                                                             | 0.5            |
| 4    |             | ATI recommendation                                          | 8                 | Add C374                                                                                                                                                                                                                                                                                                                                                                                                                 | 0.5            |
| 5    |             | Add VGA DRAM size detect function                           | 17                | Add R1149 for 128MB VGA DRAM (un-populate for 64MB)                                                                                                                                                                                                                                                                                                                                                                      | 0.5            |
| 6    |             | Add CSI# for Hynix 8Mx32 VGA DRAM                           | 18, 19,<br>22, 23 | Add Nets: NMCSA1# and NMCSB1#                                                                                                                                                                                                                                                                                                                                                                                            | 0.5            |
| 7    |             | Change M9+X VGA_CORE from +1.5VS to individual power source | 21                | Delete JOPEN3                                                                                                                                                                                                                                                                                                                                                                                                            | 0.5            |
| 8    |             | Delete useless components                                   | 5<br>25<br>27     | Delete R538<br>Delete C96<br>Delete Q114, Add R1145                                                                                                                                                                                                                                                                                                                                                                      | 0.5            |
| 9    |             | <del>Solve power leakage from CRT</del>                     | <del>25</del>     | <del>Change R619-1 and R622-1 net from +5VS to CRT_VCC</del>                                                                                                                                                                                                                                                                                                                                                             | <del>0.5</del> |
| 10   |             | Prevent DPRSLPVR abnormal state happened                    | 26                | Change R1001 from 100K to 47K, R1002 from 0 to 47K                                                                                                                                                                                                                                                                                                                                                                       | 0.5            |
| 11   |             | Using rechargeable RTC battery for HP's request             | 26                | Delete D66, D71 and D72; Add D91 (BAS40-04, the same as LA-1761 D30); Change BATT1 from CR1220 to ML1220 (the same as LA-1761 BATT1)                                                                                                                                                                                                                                                                                     | 0.5            |
| 12   |             | Prevent +5V drop while plug SPR for HP's request            | 41                | Change JP40.3, C798.1, C800.1 and C801.1 net from +5V to USB_VCCA; Change C798 from 22u to @10u; Change C801 from 1000p to @1000p                                                                                                                                                                                                                                                                                        | 0.5            |
| 13   |             | Enhance brightness of blue LEDs                             | 42, 45<br><br>44  | Delete Q67, R883, R884, R942 and R943; Add Q117 and R1146; Change R881, R882, R885, R888, R889, R890, R925 and R1136 to 220<br><br>Change JP42.2 from BATLED_0 to BATLED_0#; Change JP42.7 from N.C. to +5VALW; Change JP42.12 from PAV_GND to PAV_LEDVCC; Change JP42.13 from PMLED_1 to PMLED_1#; Change JP42.14 from PAV_GND to +5VS; Change JP45.7 from PRES_GND to PRES_LEDVCC; Change JP45.8 from PRES_GND to +5VS | 0.5            |
| 14   |             | Solve PWR_ACTIVE LED function fail issue                    | 42<br><br>46      | Change power from +3VS to +5V for PWR_ACTIVE LED (D52 and D56)<br><br>Add R1147 and R1148; Change U15.76 net from N.C. to PWR_ACTIVE_PRES#; Change U15.87 net from N.C. to PRES_DETECT; Change U15.119 net from PWR_ACTIVE# to PWR_ACTIVE_PAV#                                                                                                                                                                           | 0.5            |
| 15   |             | Solve M10 can't power up issue                              | 49                | Change R1101 from 100K to 56K; Change R901 from 91K to 27K                                                                                                                                                                                                                                                                                                                                                               | 0.5            |
| 16   |             | Add discharge components                                    | 49                | Add R372, R1095, R1102, Q36, Q103 and Q109                                                                                                                                                                                                                                                                                                                                                                               | 0.5            |
| 17   |             | Material change for ME's request                            | 44                | Change JP47 from ACES_88231_0200 to MOLEX_53398_0290 (the same as LA-1761 JP2)                                                                                                                                                                                                                                                                                                                                           | 0.5            |
| 18   |             | Using NEC USB2.0 to support BT for HP's request             | 44                | Change R1082.2 net from USB3+ to USB5+; Change R1081.2 net from USB3- to USB5-                                                                                                                                                                                                                                                                                                                                           | 0.5            |
| 19   |             | Increase MONO_IN voltage level                              | 37                | Change R738 from 2.4K to 10K                                                                                                                                                                                                                                                                                                                                                                                             | 0.5            |
| 20   |             | Decrease Audio AMP Gain                                     | 38                | Change R971 from 100K to @100K; Change R973 from @100K to 100K                                                                                                                                                                                                                                                                                                                                                           | 0.5            |

Update with Item23

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BHR60 from SI-1 to DB(15.4") LA-1811 REV:0.4 -> 0.5  
HW PIR <92.05.07.~92.05.30. >

BHR60 from DB to SI LA-1811 REV:0.5 -> 0.6  
HW PIR <92.06.20.~92.07.03. >

| Item | Fixed Issue | Reason for change                                                                  | PAGE                                                                | Modify List                                                                                                                                                                                                                                                                                                                                                                   | M.B. Ver. |
|------|-------------|------------------------------------------------------------------------------------|---------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|
| 21   |             | RTL8101L no need transistor for 3.3V to 2.5V anymore<br><br>REALTEK recommendation | 34                                                                  | Delete Q55, R944 and C868<br><br>Change R704 from 5.6K_0402_5% to 5.6K_0402_1%                                                                                                                                                                                                                                                                                                | 0.5       |
| 22   |             | Connector Spec. change for ME's request                                            | 44                                                                  | Change PCB Footprint from SUYIN_020167MR004SX012R_4P to suyn_020167mr004s11zu_4p for JP18, JP19 and JP20                                                                                                                                                                                                                                                                      | 0.5       |
| 23   |             | Solve Tr and Tf of H-sync/V-sync over Spec issue for high resolution CRT           | 25                                                                  | Delete Q68, Q64, R619, R620, R621 and R612; Add U57, U58 and R1150                                                                                                                                                                                                                                                                                                            | 0.5       |
| 24   |             | Delete useless components with BOM                                                 | 10<br>24                                                            | Delete R574, R1066 and C952<br>Delete R210 for UMA only                                                                                                                                                                                                                                                                                                                       | 0.5       |
| 25   |             | Add SB to control H_PROCHOT# for HP's request                                      | 26                                                                  | Add Q118 and R1151                                                                                                                                                                                                                                                                                                                                                            | 0.5       |
| 26   |             | Add components for EMI                                                             | 37<br>40<br>40                                                      | Add R1152<br>Add L65 - L78<br>Add L79 - L97                                                                                                                                                                                                                                                                                                                                   | 0.5       |
| 27   |             | Solve DOS cold-boot shunt down issue                                               | 7                                                                   | Delete C256                                                                                                                                                                                                                                                                                                                                                                   | 0.5       |
| 28   |             | Decrease overshoot & undershoot                                                    | 25                                                                  | Add R1153 and R1154                                                                                                                                                                                                                                                                                                                                                           | 0.6       |
| 29   |             | Change SB GPIO0 and GPIO2 pull-down to GND                                         | 26                                                                  | Delete RP126; Add R1155- R1157                                                                                                                                                                                                                                                                                                                                                | 0.6       |
| 30   |             | Only 0603 size in SAP for 5.6K_1%                                                  | 34                                                                  | Change component size of R704 from 0402 to 0603                                                                                                                                                                                                                                                                                                                               | 0.6       |
| 31   |             | The pin-definition of FDD conn. was error on rev0.5 M/B                            | 40                                                                  | Correct the pin-definition for JP38                                                                                                                                                                                                                                                                                                                                           | 0.6       |
| 32   |             | VIA recommendation                                                                 | 40                                                                  | Change RP119 from 1K to 330; Delete RP121; Add R7 and R?                                                                                                                                                                                                                                                                                                                      | 0.6       |
| 33   |             | Enhance brightness of Docking LEDs                                                 | 41                                                                  | Change R880 from 10K to 470                                                                                                                                                                                                                                                                                                                                                   | 0.6       |
| 34   |             | To support wake-up function with TP                                                | 44                                                                  | Change TP power from +5VS to +5V                                                                                                                                                                                                                                                                                                                                              | 0.6       |
| 35   |             | Delete useless components                                                          | 5<br>12<br>17<br>20<br>24<br>25<br>26<br>27<br>29<br>37<br>38<br>39 | Delete RS35, RS36, R991 and R992<br>Delete U53, C912-C914, D79-D82, R954, R1010-R1012 and R1023<br>Delete Q15 and R251<br>Delete R1022<br>Delete R211 and R216<br>Delete C93-C95 and C930<br>Delete Q113, R1124 and D91; Add D93<br>Delete RP149, RP150, R1145 and Q114<br>Delete R53<br>Delete L45, R1019, Y6, R756, C740 and C741<br>Delete R1142<br>Delete RP153 and R1132 | 0.6       |
| 36   |             | To improve RTC accuracy                                                            | 26                                                                  | Change Y1 from +/-20ppm to +/-10ppm                                                                                                                                                                                                                                                                                                                                           | 0.6       |
| 37   |             | Solve Cardbus controller can't reset well issue                                    | 31                                                                  | Delete R905, R941 and C906; Connect U37.C11 to G_RST#                                                                                                                                                                                                                                                                                                                         | 0.6       |
| 38   |             | Add components for EMI                                                             | 37<br>40                                                            | Add L98 and L99<br>Add C975, C976, CP15-CP17                                                                                                                                                                                                                                                                                                                                  | 0.6       |
| 39   |             | Improve Audio quality                                                              | 37<br>38<br>41                                                      | Delete C753-C756; Add R1165-R1168 and C979<br>Add R1158 and R1164; Exchange the nets of JP41.2 and JP41.3<br>Add R1161                                                                                                                                                                                                                                                        | 0.6       |
| 40   |             | Add components for ID & ME                                                         | 42                                                                  | Add D92                                                                                                                                                                                                                                                                                                                                                                       |           |
| 41   |             | Modify +5V power-up timing to lead +3V                                             | 49                                                                  | Change R904 from 91K to 47K                                                                                                                                                                                                                                                                                                                                                   |           |

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BHR60 from SI-1 to PV LA-1811 REV:0.6 -> 0.7  
HW PIR <92.07.03.~92.08.08.>

| Item | Fixed Issue | Reason for change                                          | PAGE                                                    | Modify List                                                                                                                                                                                                                                                                                                                                                                                                           | M.B. Ver. |
|------|-------------|------------------------------------------------------------|---------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|
| 42   |             | Correct Y1 and Y3 pin-out                                  | 26<br>46                                                | Using pin-1 and pin-2 of these crystals                                                                                                                                                                                                                                                                                                                                                                               | 0.7       |
| 43   |             | ATI Product Advisory, refer to PA_2181XP0T1                | 44                                                      | Delete R65, R66, R67, R70, R72, R75, R79, R82, R86, R89, R94 and R95                                                                                                                                                                                                                                                                                                                                                  | 0.7       |
| 44   |             | Solve CD-ROM audio noise issue                             | 30                                                      | Delete C11                                                                                                                                                                                                                                                                                                                                                                                                            | 0.7       |
| 45   |             | Solve audio noise issue                                    | 37                                                      | Change R733.1 from +5VS to +5VAMP_CODEC                                                                                                                                                                                                                                                                                                                                                                               | 0.7       |
| 46   |             | For EM I                                                   | 38                                                      | Add L100, L101, L102 and L103                                                                                                                                                                                                                                                                                                                                                                                         | 0.7       |
| 47   |             | For FIR detect                                             | 39                                                      | Add R1173(no fir) and R1174(with FIR)                                                                                                                                                                                                                                                                                                                                                                                 | 0.7       |
| 48   |             | ATI recommendation                                         | 27<br>46                                                | Change RP12 from 10K to 2.2K<br>Add R1175                                                                                                                                                                                                                                                                                                                                                                             | 0.7       |
| 49   |             | Delete useless components                                  | 46                                                      | Delete D69 and D70                                                                                                                                                                                                                                                                                                                                                                                                    | 0.7       |
| 50   |             | To support wake-up function with TP                        | 46                                                      | Delete RP154; Add R1169, R1170, R1171 and R1172                                                                                                                                                                                                                                                                                                                                                                       | 0.7       |
| 51   |             | Solve M10 can't power up issue                             | 49                                                      | <del>---Delete C844-----</del> Charge R901 from 27K to 6.8K                                                                                                                                                                                                                                                                                                                                                           | 0.7       |
| 52   |             | Improve Tr and Tf of H-sync/V-sync for high resolution CRT | 25                                                      | Decrease the R <sub>L,C</sub> value                                                                                                                                                                                                                                                                                                                                                                                   | 0.7       |
| 53   |             | Modify brightness of LEDs                                  | 42<br>45                                                | Change Transistors from BJT to PMOS and Resistors value for Pav; Change Resistors value for Pre.                                                                                                                                                                                                                                                                                                                      | 0.7       |
| 54   |             | Fast power on for battery only                             | 45                                                      | Change R306 from 100K to 470; Delete Q112                                                                                                                                                                                                                                                                                                                                                                             | 0.7       |
| 55   |             | Improve contact                                            |                                                         | Move JP2(CD-ROM conn.) right 0.65mm                                                                                                                                                                                                                                                                                                                                                                                   | 0.7       |
| 56   |             | Correct Caps. LED and Numl. LED placement                  |                                                         | Exchange the placement of these LEDs                                                                                                                                                                                                                                                                                                                                                                                  | 0.7       |
| 57   |             | Solve audio noise issue                                    |                                                         | Cut the bridge between AGND and DGND in GND1 layer                                                                                                                                                                                                                                                                                                                                                                    | 0.7       |
| 58   |             | Reserve for EM I                                           | 37                                                      | Add JOPEN6, JOPEN7 and JOPEN8                                                                                                                                                                                                                                                                                                                                                                                         | 0.7       |
| 59   |             | Improve USB2.0 signal quality                              | 36                                                      | Change R1027, R1029, R1030, R1031, R1032, R1033, R1034 and R1035 to 42.2                                                                                                                                                                                                                                                                                                                                              | 0.7       |
| 60   |             | Reserve VRAM detect function for ATI recommendation        | 17                                                      | Connect R256/R257 to ZV_DATA0/ZV_DATA1, and pull-up to +3VS                                                                                                                                                                                                                                                                                                                                                           | 1.0       |
| 61   |             | For EM I                                                   | 38<br>48<br>36<br>7<br>24<br>25<br>28<br>37<br>41<br>25 | Change C761-C764 to 470µF and pull-down to D-GND; Change L100-L103 to MOK2012221YZT(ZA)<br>Delete C110-C115<br>Change L89, R1079 & R1080 to CHB1608U301<br>Add C855, C856, C897 and C898<br>Change L11 & L12 to MBV2012301YZT<br>Change RC1 clock dumping resistors to 39 ohm<br>Add C872-C881, C880-C883; Change R69-R82 to MBV2012301YZT<br>Delete R769 & R770; Add C884-C892 & L104<br>Add L105<br>Add C893 & C894 | 1.0       |
| 62   |             | Reduce GH1 # "LOW" voltage level                           | 5                                                       | Change R627 to 300 ohm                                                                                                                                                                                                                                                                                                                                                                                                | 1.0       |
| 63   |             | Fix "Pop" sound during boot up                             | 37                                                      | Add C979                                                                                                                                                                                                                                                                                                                                                                                                              | 1.0       |
| 64   |             | For PCBA skew reducing                                     | 42 45                                                   | Change R885, R888, R890, R1136 and R925 to 130                                                                                                                                                                                                                                                                                                                                                                        | 1.0       |
| 65   |             | T1 recommendation                                          | 32                                                      | Add R1177                                                                                                                                                                                                                                                                                                                                                                                                             | 1.0       |
| 66   |             | Solve audio L/R swap issue                                 | 37<br>44                                                | Change R750 & R753 to 27 ohm<br>Delete R327 & C305                                                                                                                                                                                                                                                                                                                                                                    | 1.0       |

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# Version Change List ( P. I. R. List ) for Power Circuit

| Item | Page#          | Title            | Date       | Request Owner | Issue Description                                                        | Solution Description                                                                                                          | Rev. |
|------|----------------|------------------|------------|---------------|--------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|------|
| 1    | 54, 55, 56, 57 | wrong layout pad | 03/25/2003 | Compal        | wrong layout pad                                                         | change to correct layout pad on PU7, PU8, PU9, PU10, PU11, PU16 and PQ24                                                      | 0.2  |
| 2    | 56             | DPRSLPVR         | 03/25/2003 | Compal        | Reserve two resistors for voltage of Deep-sleeper mode                   | Reserver PR231, PR232, PR233, PR234 for deeper-sleeper mode voltage setting                                                   | 0.3  |
| 3    | 56             | CPU VR-Cont.     | 03/25/2003 | Compal        | Reserve a jumper for power consumption measurement                       | Add PJP14                                                                                                                     | 0.3  |
| 4    | 57             | CPU VR-Cont.     | 03/25/2003 | Compal        | Change the netname +5VS_CORE for power consumption measurement           | Change Netname of +5VS_CORE                                                                                                   | 0.3  |
| 5    | 51             | RTC charger      | 03/25/2003 | Compal        | use two resistors for RTC charger protection                             | Add PR230                                                                                                                     | 0.3  |
| 6    | 55             | 1.2VS_VGA        | 03/25/2003 | Compal        | re-layout 1.2V_VGA requested by ME                                       | re-located both PL10 and PQ21, PQ23 as well as 1.2VS_VGA related power circitry                                               | 0.3  |
| 7    | 55             | 1.2VS_VGA        | 03/26/2003 | Compal        | Reserve a jumper for power consumption measurement                       | Add PJP15                                                                                                                     | 0.3  |
| 8    | 55             | +1.25VSP         | 03/26/2003 | Compal        | Change power time-sequence of 1.25VSP input power                        | Change VD, and VDD of PU16 from +2.5VALWP to +2.5VS; Connect PR235.2 to +2.5VS add a resistor PR235 for Stand/By pin for test | 0.3  |
| 9    | 54             | +1.5VALWP        | 03/27/2003 | Compal        | Reserve Force PWM function of 1.5V/2.5V and add a PR236 for SUSP# signal | Add PR237, PR238 for force PWM function control, and add PR236 for SUSP# signal                                               | 0.3  |
| 10   | 54             | +1.5VALWP        | 04/16/2003 | Compal        | change 1.5V time sequence                                                | Change power time-sequence of 1.5VSP input power                                                                              | 0.4  |
| 11   | 56             | CPU DPRSLPVR     | 04/16/2003 | Compal        | Change DPRSLPVR design                                                   | Add two transistor PQ44, PQ45 for voltage of Deep-sleeper mode                                                                | 0.4  |
| 12   | 54 55 56       | PWR JUMP         | 04/16/2003 | Compal        | For DFX issue                                                            | Change power JUMP SIZE to follow new jump role                                                                                | 0.4  |
| 13   | 56             | CPU DPRSLPVR     | 04/18/2003 | Compal        | Change DPRSLPVR design                                                   | Reserve DPRSLPVR function and add a PR136 for +5VS_CORE signal                                                                | 0.4  |
| 14   | 50             | Vin DETECTOR     | 04/30/2003 | Compal        | to make ACIN to enable to pull low                                       | Change PR8 form 10k_0603 to 0K_0603                                                                                           | 0.4  |
| 15   | 50             | Precharge        | 04/30/2003 | Compal        | BOM error                                                                | Change PR1 from 10k_0603 to 100k_0603                                                                                         | 0.4  |
| 16   | 51             | Battery OTP      | 04/30/2003 | Compal        | To change feekbeck time                                                  | Change PC20 from .22u to 1u ;PR40&PR42 from 100k to 150k; PC80 from 1u to .47u                                                | 0.4  |
| 17   | 51             |                  | 04/30/2003 | Compal        | change component                                                         | Change PU3 from S-81233SGUP-T1 to S-812C33AUA-C2N                                                                             | 0.4  |
| 18   | 52             | Battery_OVP      | 04/30/2003 | Compal        | To avoide the BATT_OVP output to oscillate                               | Delet PC44&PR71                                                                                                               | 0.4  |
| 19   | 53             | 5V/3.3V/12V      | 04/30/2003 | Compal        | BOM error                                                                | Change PD16 from EC31Q04 to EC11FS2                                                                                           | 0.4  |
| 20   | 53             | 5V/3.3V/12V      | 04/30/2003 | Compal        | To improve the 3V output ripple Voltage                                  | Delet PC77                                                                                                                    | 0.4  |

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| Item | Page# | Title              | Date       | Request Owner | Issue Description                                                                | Solution Description                                                                                                                         | Rev. |
|------|-------|--------------------|------------|---------------|----------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|------|
| 21   | 55    | 1.2VS_VGA          | 04/30/2003 | Compal        | BOM errors                                                                       | Change PR121 from 511k to 180k;PR122 form 9.09k to 4.64k                                                                                     | 0.4  |
| 22   | 50    | Precharge detector | 05/16/2003 | Compal        | System can't power on by battery                                                 | Add PR191(909K_0603),PR192(47k_0603),PRPQ46(2N7002)&PQ47(DTC115EUA_SC70)<br>Change PR5 from 150k to 180k                                     | 0.5  |
| 23   | 51    | Colok THROTTLING   | 05/16/2003 | Compal        | To modify the circuit                                                            | Add PR193(73.2k) ,PC97(0.01U_0603); change PR22 form 84.5K to 11.5K                                                                          | 0.5  |
| 24   | 56,57 | CPU_CORE(1&2)      | 05/16/2003 | Compal        | Change the frequece 300k to 200k                                                 | delet PR138 ; add PR187(0_0603)&PR188(0_0603)                                                                                                | 0.5  |
| 25   | 52    | Charger            | 05/16/2003 | Compal        | To modify the charger circuit                                                    | Add PR194(1K) ,PC98(0.1U_0603),PR195(47K),PQ48(DTA144EUA),PQ49(DTC115EUA),PQ50(2N7002),PD30(1SS355)                                          | 0.5  |
| 26   | 55    | 1.2VS_VGA          | 05/16/2003 | Compal        | To modify the circuit for 1.2VS_VGA &1.5VS_VGA                                   | add PR124(11.5k_0603)                                                                                                                        | 0.5  |
| 27   | 53    | 3V/5V/12V          | 07/4/2003  | Compal        | To modify the DCR sense                                                          | Add PR81(3.4k) ,PR78(3.4K),PR79(0_0402) ,PR85(0_0402),PC67(0.1U_0603) ,PC68(0.1U_0603);delet PR86,PR88,PR90,PR93                             | 0.6  |
| 28   | 56    | CPU_CORE           | 07/4/2003  | Compal        | To modify THE CPU Load line form -1.5mV/A to -2.2mV/A                            | Change PR158,PR180 from 2k to 3.4k                                                                                                           | 0.6  |
| 29   | 56,57 | CPU_CORE(1&2)      | 07/4/2003  | Compal        | To improve the CPU_CORE effecient                                                | Change PL12,PL13,PL14,PL15 from TOHO to PANASONIC                                                                                            | 0.6  |
| 30   | 50    | DC_in              | 08/4/2003  | Compal        | For Gibson issue ,add two schottky diodes                                        | add PD43(SBM1040-13_powermite3) ,PD44(SBM1040-13_powermite3)                                                                                 | 0.7  |
| 31   | 52    | Charger            | 08/4/2003  | Compal        | To modify the Precharge circuit                                                  | Add PD30(1SS355_S0D323) ,PC98 (0.1U_0603),PR195(47K_0402),PQ49(DTC115EUA_SC70),PQ50(2N7002)                                                  | 0.7  |
| 32   | 53    | 3V/5V/12V          | 08/4/2003  | Compal        | To solve the DCR sense for 5V OCP issue                                          | change PR81(1.27k) ,PR78(1.54K),PR79(0_0402) ,PR85(0_0402),PC67(0.47U_0603) ,PC68(0.47U_0603);add PR241(1.24k),PR242(620 ohm),PR243(698 ohm) | 0.7  |
| 33   | 56    | CPU_CORE           | 08/4/2003  | Compal        | To modify THE CPU Load line form -2.2mV/A to -1.5mV/A, and senes CPU VCC and VSS | Change PR158,PR180 from 3.4k to 2.2k and add PR244 (0 ohm) and PR245(0 ohm)                                                                  | 0.7  |
| 34   | 52    | Charger            | 08/4/2003  | Compal        | To improve the charger feedback loop for charger noise issue                     | Change PR52 (47k_0603),PR57(1K_0603),PC36(1500P_0603)                                                                                        | 0.7  |
|      |       |                    |            |               |                                                                                  |                                                                                                                                              |      |
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